

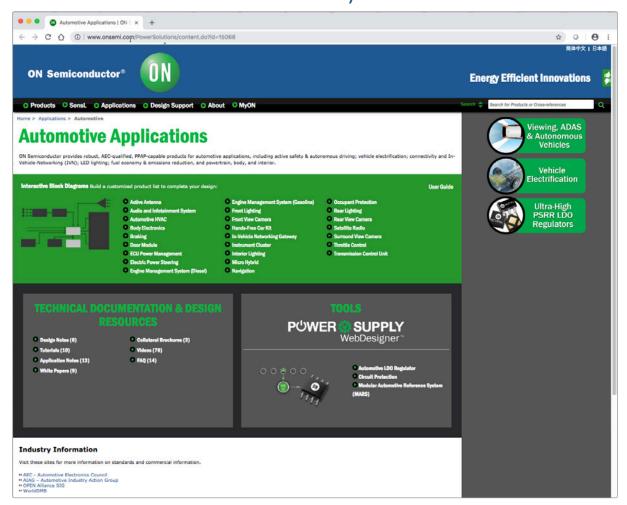


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LIGHTING	
IN-VEHICLE NETWORKING (IVN)	
BODY35	
POWERTRAIN	
POWER MANAGEMENT	
AUDIO	
PROTECTION	
COMPONENTS	

For More Information, Visit the Automotive Applications Page at www.onsemi.com/automotive



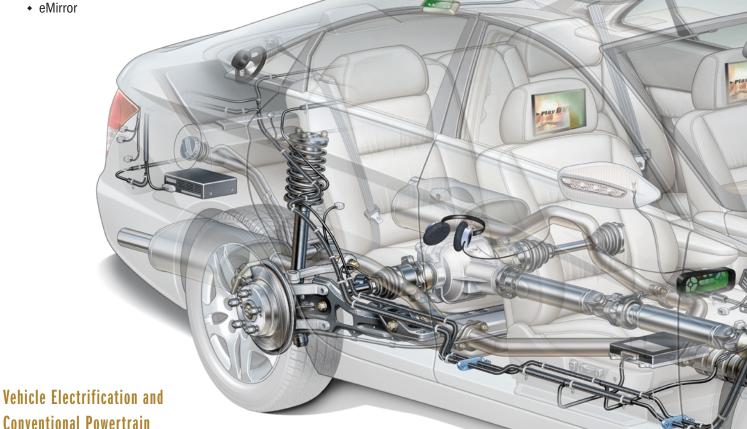
Energy Efficient Innovations

Viewing, ADAS, and Autonomous Driving

- Viewing Forward & Surround
- ADAS & Autonomous Driving
 - Adaptive Cruise Control
 - · Blind Spot Monitoring
 - Auto-Braking
 - Lane Departure Warning
 - Pedestrian, Vehicle, and Sign Detection

- Gesture Control
- Driver/Passenger Monitoring
- Ultra-Sonic Park Assist
- Power Supplies
- Electronic Parking Brake
- Smart Passive Sensing





- onventional Powertra
- HEV/PHEV/EV
- Fuel Cell
- 48 V Boardnet
- Engine Control (Gas/Diesel)
- Throttle Control
- Ignition Control
- Transmission Control
- Sensor Interface

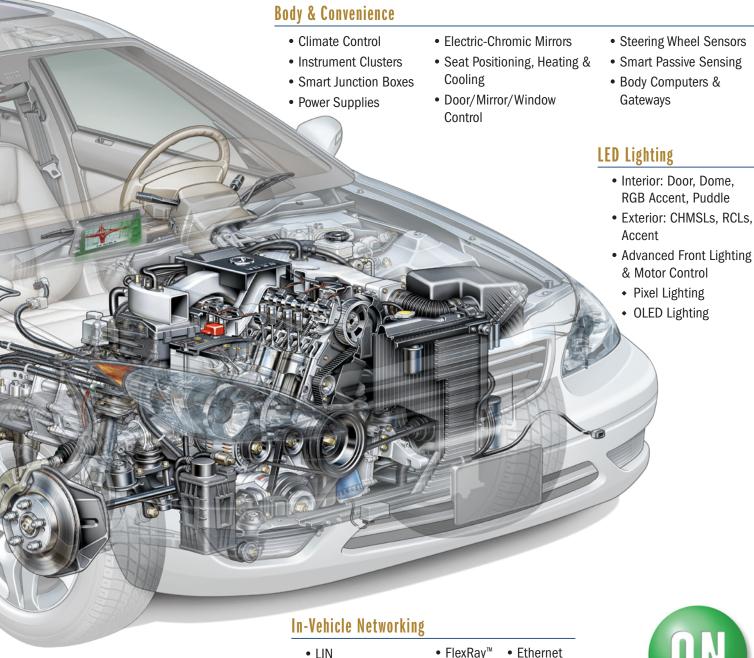
- Power Supplies
- Fuel Injection Control
- Position Sensing
- Start-Stop Alternator
- Electric Pump & Fan Control
- Turbo and Compressor Control

Audio & Infotainment

- Navigation Systems
- Satellite/Digital Radio
- Power Supplies
- Connectivity MP3, iPOD, HDMI, USB, Wireless

Page 2 Automotive Solutions

ON Semiconductor enables energy efficient automotive solutions that reduce emissions, improve fuel economy, and enhance lighting, safety, connectivity, and infotainment power delivery systems. The company provides a broad array of image sensors, power discretes, power management, protection, processing, signal conditioning and control products that deliver solutions focused on areas such as; powertrain, viewing, ADAS, led lighting, climate control, door zone, park assist, IVN, body control and infotainment applications.



- PSI5 • USB
- System Basis Chips SENT

• CAN

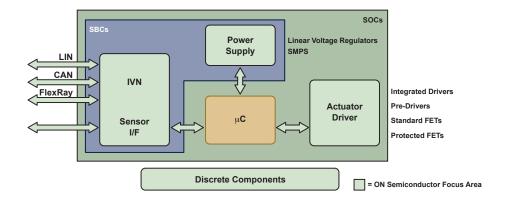


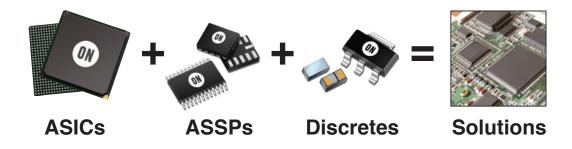
Automotive Solutions

Automotive powertrain and body electronics solutions from ON Semiconductor provide an optimized architecture, matched to customer requirements. The company provides multiple options, based on technology and application:

- Application Specific Integrated Circuits (ASIC)
- Application Specific Standard Products (ASSP)
- Image sensors and co-processors
- In-vehicle networking
- · Standard integrated circuits

- Discrete components
- Analog
- Mixed-signal
- SBCs and SoCs
- Sensor interfaces





Page 4 Automotive Solutions

Automotive Excellence

Automotive Expertise

ON Semiconductor provides energy efficient silicon solutions to the global automotive industry. The company has developed a wide range of automotive components, by applying advanced technology and extensive R&D expertise, in the fields of high-voltage interfacing, smart power management, in-vehicle networking, system level integration, and sensor interfaces.

In-house expertise includes:

- · ASIC, ASSP, standard IC, and discrete capability
- Mixed-signal technologies
- High-voltage processes
- Directly owned and operated fabrication facilities
- Class A clean rooms
- · High temperature wafer testing
- · Burn-in capability
- · Wafers and die

Solutions Engineering Centers

ON Semiconductor operates Solution Engineering Centers in Munich, Germany; Shanghai, China; and Tokyo, Japan. These SECs, located in automotive industry centers, provide local customer support, including application knowledge and system integration skills. Together with local technical field teams and product specialists, the automotive SECs provide the following services:

- Local technical support (system and device)
- Reference designs and demonstration boards
- Global application architecture consultation
- Optimization of system costs and performances
- Design integration support (ON Semiconductor devices into customer applications)
- Component specification and customer/application test specifications

Global Supply Chain Operations

Advanced Capability

ON Semiconductor invests in EDI, VMI, and other logistics agreements.

Global Locations

Worldwide, ON Semiconductor employs ~34,000 people. Headquartered in Phoenix, Arizona, U.S.A., the company owns and operates multiple development centers and manufacturing facilities located in the U.S.A., Europe, and Asia.

Global Supply Chain

ON Semiconductor operates a flexible, reliable, responsive supply chain that supports complex manufacturing networks and dynamic global market conditions. This includes multiple manufacturing and logistics sites located near our customers to ensure supply continuity.

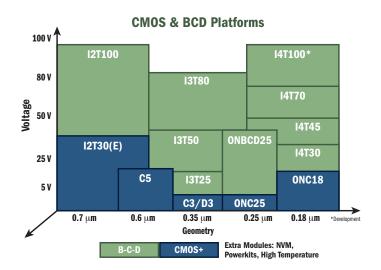
Automotive Long-Term Availability Statement

ON Semiconductor is 100% committed to the long-term supply of products in concert with the automotive industry's supply benchmark requirement. The company works with customers to meet their specific supply requirements. ON Semiconductor will make all commercially reasonable efforts to provide automotive customers with advance notice of phase-outs and provide compatible product renewals, when technically feasible and within certain cost constraints, to help ensure long-term supply considerations and requirements are fully achieved.

Automotive Technology

Proven Automotive Technical Capabilities

ON Semiconductor has developed a set of dedicated, high-voltage automotive power technologies. With parasitic signals running through automobiles, 80 V spikes can occur and must be accounted for by the design team. Modules and components need to be able to sustain such peaks and remain functional. ON Semiconductor technology enables complex, high-voltage system-on-chip (SoC) solutions that meet requirements for maximum voltage and digital gate integration.



Electro Magnetic Compatibility

In-Vehicle-Networking (IVN) applications require extended immunity against ESD pulses and EMI. Growing vehicle electronic content makes this even more important, and automobile

manufacturers set performance standards accordingly. ON Semiconductor offers best-in-class devices using I3T50/80 and I4T30/45/70 technologies, that provide advanced capabilities. Robust designs are achieved, for example, by deep trench isolation, which reduces the interference between the voltage domains on the chip.

ON Semiconductor offers a range of technologies that allow up to $100\,\mathrm{V}$ supply, and enables component integration — including embedded microprocessor cores.

ON Semiconductor technologies serve as the basis for automotive ASIC and application specific standard product (ASSP) solutions for powertrain (including high temperature applications with ambient temperatures ≥150°C), safety, body, dashboard, in-vehicle-networking (IVN), sensors, and actuator applications.

High Temperature Capability

ON Semiconductor offers a broad portfolio of products that operate in extended temperature ranges, up to 150°C. The company has also launched an initiative to extend high temperature capabilities to 200°C. This initiative includes enhancements to:

- · Packaging and Bonding
- High Temperature Testing
- Component Test Vehicles
- · Product Test Vehicles
- CAD Tools
- Libraries
- Spice Device Models

Extended high temperature capabilities may be applied to ASICs and ASSPs.

Page 6 Automotive Solutions

Automotive Quality

Automotive Grade Quality and Control Processes

For over 40 years, ON Semiconductor has been developing and delivering robust, high-performance solutions that allow designers to meet the demanding environmental and performance requirements of automotive applications.

Quality Policy: "We will exceed Customer Expectations with our Superior Products and Services."

Quality Statement: "Every ON employee is personally responsible for ensuring the highest Quality in the products and services delivered to internal and external customers. Continuous improvement in the Quality of our processes, products and service is fundamental to the achievement of customer satisfaction."

For certification documents, visit the Quality page on our Web site.

ON Semiconductor Quality Processes

- Registered to ISO 9001
- Registered to IATF 16949
- Quality System and Business Operating System are synonymous and are documented to meet the requirements of the Automotive Standards
- Corrective action systems use various methodologies to ensure we identify and correct the root cause of nonconformance. Preventive action is also used to ensure we eliminate potential non-conformances
- Quality System/Business Processes are documented and controlled

Production Part Approval Process (PPAP)

Our documented process provides the methods, procedures, and forms to initiate PPAP submission; prepare the documents required for submission; and document customer approval when required. This process ensures that ON Semiconductor components comply with design specifications, and that customer designs will maintain desired quality levels.

Zero-Defect Program

Focused Parts "Non-Zero" devices (bottoms-up approach)

- · Problem solving methodology
- Adequate Failure Analysis facilities
- Incident ownership

Prevent Recurrence Systemic Improvement (top-down approach)

- Process characterization, control plan, and Failure Mode Effect Analysis
- · Maverick lot initiative
- · Quarterly detailed Horizon Reports

ON Semiconductor's commitment to the automotive market extends beyond the delivery of great products, to ensuring that our manufacturing and quality processes meet the industry's need for reliability and robustness. The demanding standards of the automotive industry drive the company's design, manufacturing, and delivery processes. ON Semiconductor delivered over 73 billion parts in 2017, with average defect rates of less than 160 parts-per-billion.

Change Management Processes

ON Semiconductor proactively manages product changes to ensure Safe Customer Passage and Flawless Execution.

- ON Semiconductor follows the JEDEC 46D and JEDEC48C for all markets except automotive. For the automotive market we follow ZVEI – Guideline for Customer Notifications of Product and/or Process Changes (PCN) of Electronic Components for Automotive Market for our change management process.
- Automotive Reliability Testing performed per Automotive Electronic Council (AEC) Q100/Q101
- Use of detailed Process/Parameter Matching Checklist
- Use of detailed changes process flow, with various checkpoints during and after the change implementation
- · Use of program management methodology
- Customers notified through Product Change Notifications

Functional Safety Management: Development According to ISO 26262

Functional Safety at ON Semiconductor

ON Semiconductor has a long and successful history of mixed signal integrated circuit developments targeting safety critical applications. Following the release of the ISO 26262 standard in November 2011, ON Semiconductor created a dedicated Functional Safety team and implemented a dedicated design flow to support the development of devices targeting safety critical applications according to this new standard. This initiative has proven to be successful, as today the company has experience with the development of mixed-signal integrated circuits targeting applications with safety goals up to ASIL D.

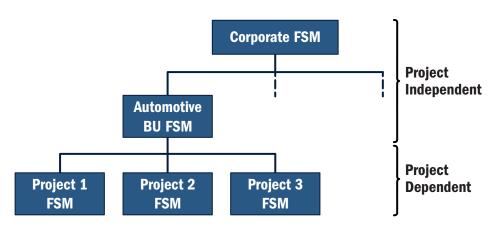
ON Semiconductor is highly involved in the Functional Safety community, especially in ISO 26262. The company is a member of the ISO 26262 work group (TC22/SC3/WG16), as well as part of the new ISO 26262 related semiconductor sub-work group that is clarifying the standard for semiconductor developments.

Creation of Dedicated and Independent Team

The purpose of the project independent team is to create a safety culture in the company and to guarantee an independent and critical look on the way functional safety will be guaranteed during the development of the devices. This independent team, driven partly by the quality department and partly by product development, has responsibility to guide the project Functional Safety Managers as well as the development teams assigned to the different developments, and provide the tools needed to follow the flow as described by the ISO 26262 standard.

Enhancing Experience

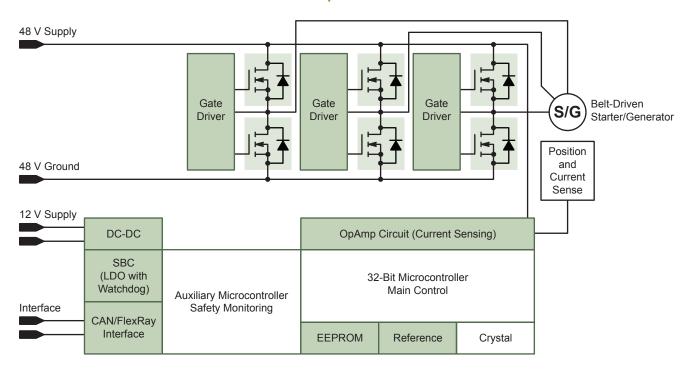
Through the ongoing developments and the dedicated Functional Safety Structure, ON Semiconductor is attaining even more significant experience, and is ready to support customers for automotive Functional Safety related projects.



Dedicated and Independent Team

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48 V Starter/Generator



Key Products & Features

Current Sense Amplifiers: NCV2007x, NCV21x

- · High-side and low-side current sensing
- Low offset zero-drift architecture
- Flexible system supply voltage
- Low value current sense resistors for better power efficiency
- Temperature sensitive applications
- AEC-Q100 Qualified

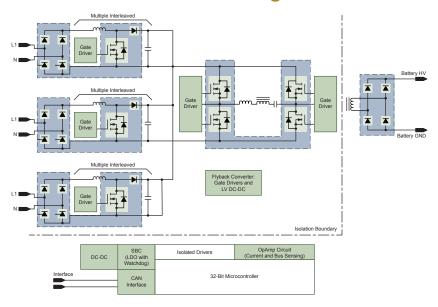
High/Low Side MOSFET Drivers: *NCV51511, FAN7191-F085, NCV5183*

- · High current capabilities
- Down to 30 ns Propagation delay
- Pin-to-pin compatible with industry standards
- AEC-Q100 Qualified

MV MOSFETs: FDBL863xx-F085, FDBL860xx-F085 & NVMFS6H8xx

- Flat-lead performance packages (SO-8 FL & TOLL)
- Very low RDS(ON)
- Small footprint, high current
- Superior reliability/robustness
- AEC-Q101 Qualified

On-Board Charger



Key Products & Features

HV MOSFETs (SuperFET®): FCHxxN60F-F085, FCHxxxN65F-F085

- Low on-resistance and low gate charge performance
- · Low conduction loss
- Fast Switching speeds
- Withstand extreme dv/dt rate and higher avalanche energy
- AEC-0101 Qualified

Discrete IGBTs: AFGB30/40T65SQDN, FGB/H40T65SPD-F085, FGH40/60N60SMD-F085, FGH40/60N60SFDTU F085

- Fast switching
- Low cost
- AEC-Q101 Qualified

High Voltage Gate Drivers: NCV570x, NCV51xx and FAN71xx-F085

- Family of rail-to-rail high current drivers for lower system losses
- External (opto/silicon) or built-in galvanic isolation in multiple packages for design flexibility
- Short propagation delays for faster switching
- Suitable for single ended, half bridge, and full bridge topologies
- AEC-Q100 Qualified

MOSFET Modules: FAM65CRxxDZ1*, FAM65CRxxADNZ1*, FAM65HRxxDS1*

- High thermal performance
- · Enhanced EMI, isolation, and current capabilities
- System level cost reduction
- Enable compact system solution with proven reliability

HV Rectifiers: *RURxxxx-F085*, *RHRGxxxx-F085*, *ISL9Rxx60x2-F085*, *FFH50US60S-F085*

- Both low VCE(sat) and high speed version available for rectification and fast switching
- Avalanche energy rated
- AEC-Q101 Qualified

SiC Rectifiers: FFSHxxxxB-F085*, FFSPxxxxB-F085*, FFSDxxxB-F085*

- Superior switching performance in comparison to silicon
- Excellent thermal performance
- Fast operating frequency
- Increase power density and reduced EMI

670 V Flyback Converters: NCV106x, NCV107x

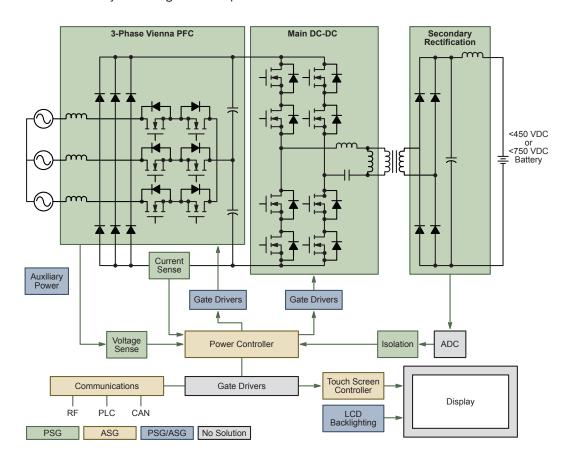
- Enables compact designs for isolated and non-isolated systems
- Output power from 2 W to 15 W
- · AEC-Q100 Qualified

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^{*} Pending 4Q18

EV Charging Stations

ON Semiconductor has a wide portfolio of products and solutions to cover the different topologies, approaches, and architectures that come with this emerging market. SiC Diodes & MOSFETs complement traditional Super-Junction and IGBT solutions, and modules can bring further benefits in terms of system integration and performance.



650 V SuperFET® III MOSFETs

- FCH023N65S3 23 m Ω , T0-247
- FCH040N65S3 40 m Ω , T0-247
- FCP067N65S3 67 m Ω , T0-220

High Voltage Rectifiers

- FFP30S60S 600 V, 30 A, STEALTH II
- FFPF10UP60S 600 V, 10 A, Ultrafast II
- RHRG75120 1200 V, 75 A, Hyperfast

High Voltage Gate Drivers

- \bullet FOD8342 3 A Optocoupler Gate Driver
- NCD5700 High Current Gate Driver
- NCP51705 6 A SiC MOSFET Driver

Silicon Carbide Diodes

- FFSH40120ADN 1200 V, 40 A, TO-247
- FFSH20120A 1200 V, 20 A, TO-247
- FFS2065A 650 V, 20 A, TO-220

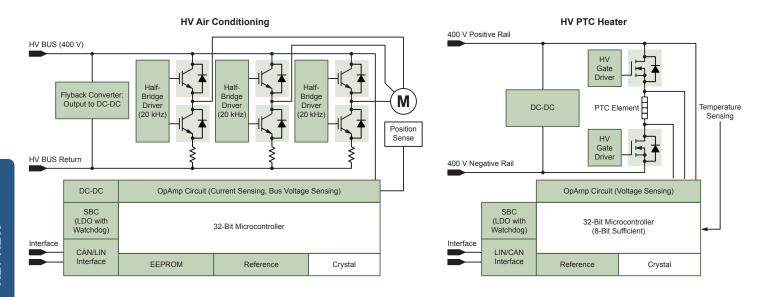
650 & 1200 V IGBTs

- FGH75T65SQD 650 V, 75 A, TO-247
- FGH50T65SQD 650 V, 50 A, TO-274
- NGTB40N120FL3 1200 V, 40 A

Current Sense Amplifiers

- \bullet NCS210R 26 V, 1% Gain Error, Amplifier
- NCS20074 3 MHz, Low Noise Op Amp

HV Auxiliary



Key Products & Features

Discrete IGBTs: *AFGHL40T65SPD, FGB/H40T65SPD-F085, FGH20/60N60UFDTU-F085, FGH40N65UFDTU-F085*

- Low saturation voltage
- Fast switching
- · Tight parameter distribution
- AEC-Q101 Qualified

High Voltage Gate Drivers: NCV570x, NCV51xx and FAN71xx-F085

- · High drive current
- Short propagation delays
- · Fault detection and reporting
- · Designed for reliability
- AEC-Q100 Qualified

670 V Flyback Converters: NCV106x, NCV107x

- Enables compact designs for isolated and non-isolated systems
- Output power from 2 W to 15 W
- AEC-Q100 Qualified

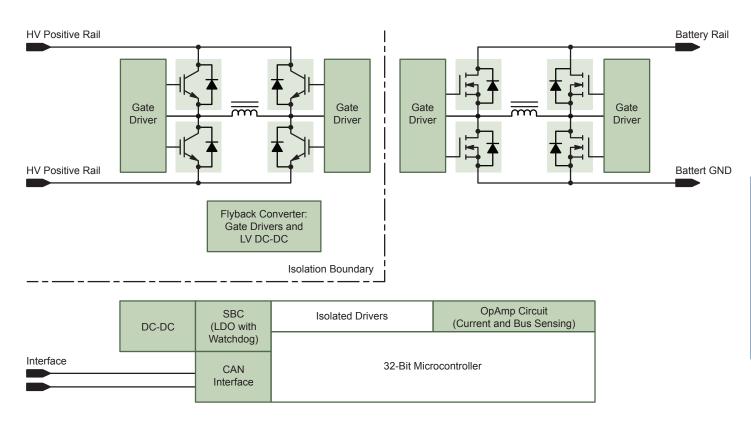
HV IPM (ASPM): NFVA35065L32 (650 V/50 A); lineup 40 A / 30 A NFVA23512NP* (1200 V/35 A); Line up 50 A/10 A

- AEC-Q100/101 qualified module & support AQG324
- 3-phase IGBT IPM with low loss IGBTs and soft recovery diodes optimized for auxiliary inverter in hybrid & electric vehicle applications
- Electrically isolated DBC substrate (AIN/Al²O³) with low thermal resistance (0.34°C/W & 650 V/50 A) and high isolation voltage (2.5 kVac)
- Adopted rugged Short Circuit Withstand Time FS Trench IGBT; over 5 µs & 400 V/175°C/15 V
- Integrated gate drivers with internal VS connection, undervoltage lockout, over-current shutdown, temperature sensing unit, and fault out

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^{*} Pending 4Q18.

HV-LV DC-DC Conversion



Key Products & Features

HV MOSFETs (SuperFET®): FCHxxN60F-F085, FCHxxxN65F-F085

- Low on-resistance and low gate charge performance
- · Low conduction loss
- Fast switching speeds
- Withstand extreme dv/dt rate and higher avalanche energy
- AEC-Q101 Qualified

High Voltage Gate Drivers: NCV570x, NCV51xx and FAN71xx-F085

- Family of rail-to-rail high current drivers for lower switching losses
- External (opto/silicon) or built-in galvanic isolation in multiple packages for design flexibility
- Short propagation delays for faster switching
- Signal conditioning and noise immunity for reliable operation
- AEC-Q100 Qualified

Discrete IGBTs: *FGB/H40T65SPD-F085*, *FGH40/60N60SMD-F085*, *FGH40/60N60SFDTU-F085*

- Fast switching
- AEC-Q101 Qualified

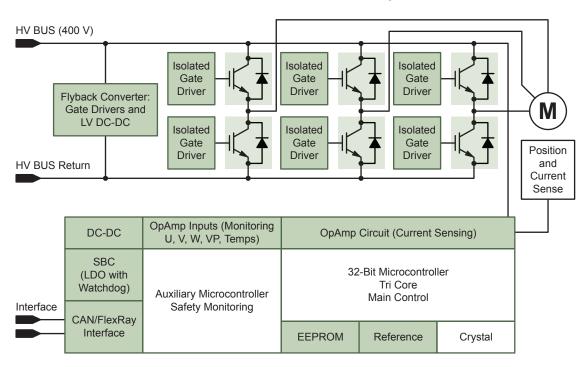
MV MOSFETs: FDBL863xx-F085, FDBL860xx-F085, NVMFS6H8xx

- Flat-lead performance packages (SO-8 FL & TOLL)
- Very low RDS(ON)
- Small footprint, high current
- Superior reliability/robustness
- AEC-Q101 Qualified

670 V Flyback Converters: *NCV106x, NCV107x*

- Enables compact designs for isolated and non-isolated systems
- Output power from 2 W to 15 W
- AEC-Q100 Qualified

Traction Inverter for HEV/EV



Key Products & Features

Discrete IGBTs: FGY160T65SPD-F085, FGY120T65SPD-F085

- Very low saturation voltage
- Tight parameter distribution
- 100% transient immunity tested
- Short circuit ruggedness > 6 µs
- AEC-Q101 Qualified

High Voltage Gate Drivers: NCV570x, NCV51705

- Family of rail to rail high current drivers for lower system losses
- External (opto/silicon) or built-in galvanic isolation in multiple packages for design flexibility
- DESAT, Miller Clamp, TSD and fault reporting to prevent catastrophic failures
- Input signal conditioning and high noise immunity for reliable operation
- AEC-Q100 Qualified

IGBT Modules: AHPM-DSC

- Dual-side cooling for best in class power density & thermal performance
- Ultra low stray inductance (7 nH)
- On die temperature and current sense
- Best in class Trench Fieldstop IGBT with low recovery diodes

Bare Die IGBT and FRD: *PCGA300T65DF8(M1), PCGA200T65NF8(M1), PCGA160T65NF8 PCRKA30065F8(M1), PCRKA20065F8(M1), PCRKA16065F8*

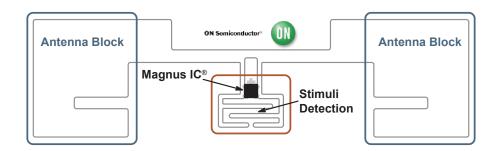
- Very low saturation voltage
- Ease of paralleling
- Monolithic Temperature Sensor and Current Sensor
- Solderable top metal available
- AEC-Q101 Qualified

670 V Flyback Converters: NCV106x, NCV107x

- Enables compact designs for isolated and non-isolated systems
- Output power from 2 W to 15 W
- · AEC-Q100 Qualified

Page 14 Automotive Solutions

Smart Passive Sensors



Features

- Smart Magnus® sensor IC with adaptable RF front end
- Passive UHF energy harvesting antenna blocks
- Sensor Stimuli detection for temperature, moisture, pressure, & proximity

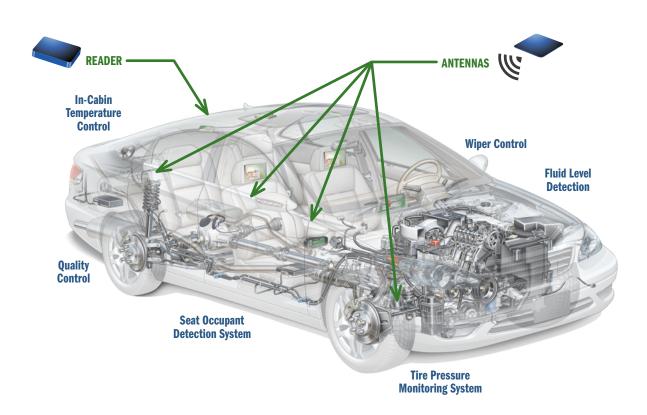
Automotive Benefits

Safety

- Wire & weight reduction
- Comfort
- Improved fuel economy
- Convenience
- Highly scalable

Devices

- SPS1M001/M002 for moisture
- SPSXT001 for temperature
- SPSDEVR1-8 for sensor reader hub



Capacitive Touch Sensors

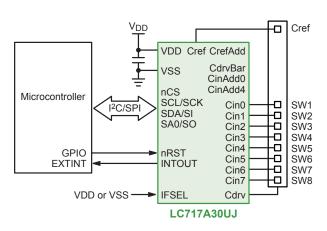
LC717A capacitive touch sensors are high performance, cost-effective, highly usable capacitance converters for use in touch switch applications and replacing mechanical switches.

The LC717A30UJ has superior sensitivity performance, so it can detect hands with wearing multiple layers of gloves, and hands within 15 cm of distance. It can also perform gesture recognition.

Features

- Differential capacitive detection using mutual capacitance, to femto-Farad level
- High sensibility performance even wearing multiple layers of gloves, air gap, or thick material
- High adaptability calibration function, noise reduction, wide range temperature operation
- Design friendly adhesive free, various circuit board (PCB/FPC) design, minimal external components
- 8 sensing inputs
- SPI/I2C interface control
- Voltage ranges of 2.6 5.5 V





LC717A30UJ Application Diagram

LC717A30UJ Evaluation Kit







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NIR-Enhanced Silicon Photomultipliers

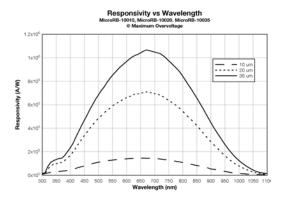
for Long Range Automotive LiDAR Applications

Features

- \bullet High responsivity of >100 kA/W @ 905 nm due to combination of high gain and detection efficiency
- PDE of >10 % at 905 nm
- Ultra-fast rise times and pulse widths from unique 'fast output' terminal
- Single photon sensitivity



MicroRB sensors – 1 mm sensor in a robust molded leadframe package



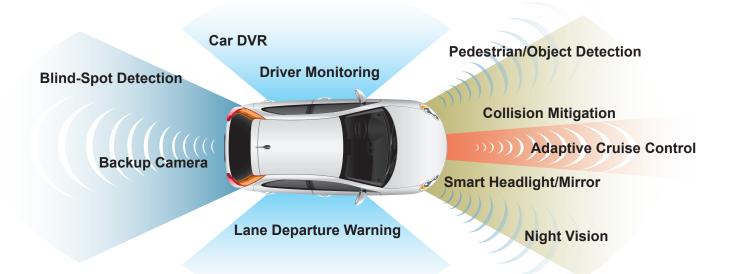


ArrayRA - 1 x 16 monolithic array in a DFN package

Description	Pixel Size (mm x mm)	Microcell (μm)	Package
		10	
NIR-enhanced SiPM in a molded leadframe package	1 x 1	20	MLP
		35	
Monolithic array of 1 x 16 NIR-enhanced SiPM pixels in a DFN package	0.49 x 0.17	20	DFN
	NIR-enhanced SiPM in a molded leadframe package	Description (mm x mm) NIR-enhanced SiPM in a molded leadframe package 1 x 1	Description (mm x mm) (μm) NIR-enhanced SiPM in a molded leadframe package 1 x 1 20 35

Imaging Products for Automotive Applications

ON Semiconductor image sensors and co-processors enhance driver experience and safety. Since 2004, we have been the leading supplier of imaging solutions for human viewing (backup, surround view and night vision) and machine vision applications (ADAS – advanced driver assistance systems including lane departure warning, adaptive cruise control, pedestrian detection and more.) Recent innovations targeted at the automotive market optimize our products for these, and other emerging applications include smart headlights and driver monitoring.



CMOS Image Sensors

		Resolution	Optical		Pixel Size			Operating Temp
Device	SOC1	(MP)	Format	Frame Rate	(μm)	Shutter Type	CFA	(°C)
AR0140AT	Sensor	1	1/4"	60 fps	3	Electronic Rolling Shutter	Color	-40 to +105
AR0132AT	Sensor	1.2	1/3"	1.2 45 fps, 720p 60 fps	3.8	Electronic Rolling Shutter	Color, Mono, RCCC	-40 to +105
AR0135AT	Sensor	1.2	1/3"	60 fps @ 720p, 54 fps @ full res	3.8	Global Shutter	Mono	-40 to +105
AR0138AT	Sensor	1.2	1/2.6"	69 fps @ 720p	4.2	Electronic Rolling Shutter	RGB, RCCC	-40 to +105
AR0143AT	Sensor	1.3	1/4"	30 fps	3.0	Electronic Rolling Shutter	RGB, RCCB	-40 to +105
AR0220AT	Sensor	1.7	1/1.8"	60 fps	4.2	Electronic Rolling Shutter	RGB, RCCC, RCCB	-40 to +105
AR0230AT	Sensor	2	1/3"	30 @ fps 1080p	3.0	Electronic Rolling Shutter	Mono, RGB	-40 to +105
AR0231AT	Sensor	2.3	1/2.7"	60 fps full res @ 2 exp, 40 fps full res @ 3 exp	3.0	Electronic Rolling Shutter	RGB	-40 to +125
AR0233AT	Sensor	2.6	1/2.5"	60 fps	3.0	Electronic Rolling Shutter	RGB, RCCB	-40 to +105
AR0234AT	Sensor	2.3	1/2.6"	120 fps	3.0	Global Shutter	Mono, RGB	-40 to +85
AR0237AT	Sensor	2.1	1/2.7"	60 fps	3.0	Electronic Rolling Shutter	RGB	-40 to +105
AR0820AT	Sensor	8.3	1/2"	40 fps	2.1	Electronic Rolling Shutter	RGB, RCCC, RCCB	-40 to +105
ARX550AT	Sensor	VGA	1/5"	66.37 fps @ full res	3.8	Electronic Rolling Shutter	RGB	-40 to +105
MT9V024	Sensor	WVGA	1/3"	60 fps	6.0	Global Shutter	Color, Mono, RCCC	-40 to +105
AS0140AT	SOC	1	1/4"	60 fps	3.0	Electronic Rolling Shutter	RGB	-40 to +105
ASX340AT	SOC	VGA	1/4"	60 fps digital, 30 fps analog	5.6	Electronic Rolling Shutter	Color	-40 to +105
ASX342AT	SOC	VGA	1/4"	50/60 fps	5.6	Electronic Rolling Shutter	RGB	-40 to +105
ASX344AT	SOC	VGA	1/4"	60 fps NTSC, 50 fps PAL interlaced, 60 fps progressive	5.6	Electronic Rolling Shutter	RGB	-40 to +105
ASX350AT	SOC	VGA	1/5"	60 fps digital, 30 fps analog	3.8	Electronic Rolling Shutter	Color	-40 to +105

1. See description on page 19.

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Co-Processors for Image Sensors

Available Features

- High Dynamic Range with Adaptive Local Tone Mapping
- Dewarp, up to 165 degrees
- Spatial Transform Engine Software Add-on
- Overlays
- GPIOs, up to 7
- Color Pipe
 - Demosaic
- · Noise reduction
- Gamma correction
- Auto exposure
- Auto white balance
- Flicker detection
- Defect correction

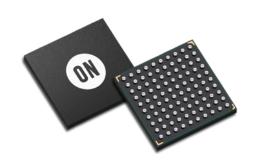


Image Co-Processors

Device	Maximum Resolution	Supported Sensors	Frame Rate	HDR with ALTM	Dewarp	Spatial Transform Engine Software Add-on	Overlays	GPIOs	Sensor Interfaces	Output Interfaces	Input Clock (MHz)	Output Clock	Operating Temp (°C)	Package
AP0100	1.2 MP	AR0132AT, AR0140AT, ARX550AT	1.2 MP 45 fps 720p60	YES	YES, Up to 165°	YES, Multiple viewing options, PTZ	YES	Up to 5	2-lane HiSPi, 12-bit parallel	NTSC/PAL, 16-bit parallel	6-30	27 MHz (NTSC/PAL) 84 MHz parallel	-30 to +70 (CS Version) -40 to +105 (AT Version)	VFBGA-100
AP0101	1.2 MP	AR0132AT, AR0140AT, ARX550AT	1.2 MP 45 fps	YES	NO	NO	NO	Up to 5	12-bit parallel	16-bit parallel	6-30	84 MHz parallel	-30 to +70 (CS Version) -40 to +105 (AT Version)	VFBGA-81
APO102AT	2.0 MP	AR0132AT, AR0140AT, AR0136AT	30 fps @ 1080p, 45 fps @ 1.2Mp, 60 fps @ 720p	YES	NO	YES	YES	Up to 7	Parallel and HiSPi	Up to 24-bit parallel	6-30 MHz	125 MHz	-40°C to +105°C	VFBGA-100
AP0200AT	2.0 MP	AR0132AT, AR0136AT, AR0140AT, AR0230AT	30 fps @ 1080p, 45 fps @ 1.2Mp, 60 fps @ 720p	YES	NO	YES	YES	Up to 7	12-bit Parallel and HiSPi	Ethernet-MII, RMII, GMII	10-29 MHz	125 MHz	-40°C to +105°C	VFBGA-100
APO201AT	2.0 MP	AR0132AT, AR0136AT, AR0140AT, AR0230AT	30 fps @ 1080p, 45 fps @ 1.2Mp, 60 fps @ 720p	YES	NO	NO	NO	Up to 7	12-bit Parallel and HiSPi	Ethernet-MII, RMII, GMII	10-29 MHz	125 MHz	-40°C to +105°C	VFBGA-100
APO2O2AT	2.0 MP	AR0132AT, AR0136AT	30 fps @ 1080p, 45 fps @ 1.2Mp, 60 fps @ 720p	YES	NO	NO		Up to 7	12-bit Parallel and HiSPi	Up to 24-bit Parallel	10-29 MHz	125 MHz	-40°C to +105°C	VFBGA-100

SOC Processing Functionality

- Optimized for use with HDR (High Dynamic Range) sensors
- Full auto-functions support (AWB and AE) and ALTM (Adaptive Local Tone Mapping) to enhance HDR images
- Next generation color pipe with improved noise filtering & reduced chromatic aliasing
- Spatial Transform Engine (STE) with dual transform support
- Picture in Picture support for advanced backup cameras
- Pre-rendered Graphical Overlays
- Multi-Camera synchronization support
- LED flicker detection and avoidance

Modular Automotive Reference System

The Modular Automotive Reference System (MARS) is a complete imaging solution for camera system developers and software developers working on automotive imaging applications. MARS gives engineers and software developers the fundamental building blocks needed to create next generation imaging systems, while reducing the design effort and resources required to develop a working solution.

Using the modular mix & match approach offered by this unique compact form factor platform, designers can bring together different combinations of image sensors, co-processors (Image Signal Processor) and communication standards. The component boards have consistent signal/power interconnect definitions to enable users to swap individual boards, creating a wide range of options for experimenting, while eliminating the need for constructing custom boards. The result is a highly flexible solution where the various modules are fully interchangeable.

For videos, tools and more information visit www.onsemi.com/MARS

Features

- · Ready to use camera solution
- · Compact form factor
- Modular and interchangeable building blocks
- Supported by comprehensive ecosystem
 - Software development platforms
 - Lens partners
 - Schematic, gerbers, BOM

Benefits

- Accelerates development cycles
- · Reduces need for technical resources
- · Reduces development costs
- · Eliminates redundant work



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Modular Automotive Reference System

- ADAS
- Autonomous driving
- Viewing systems
- Backup cameras
- Surround view systems
- · Electronic mirrors
- In-cabin cameras for
 - Gesture recognition
 - Driver eye monitoring
 - Light level inspection



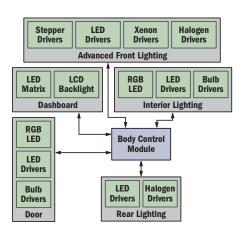
Individual MARS Board Order Descriptions

Sensor Board OPNs	Short Description	Sensor Board Description
MARS1-AR0230ATS-GEVB	2.1 MP, 1/2.7" MARS Sensor Board	MARS sensor board with 2.1 MP, 1/2.7" high-dynamic range color AR0230AT image sensor
MARS1-AR0231AT6-GEVB	2.3 MP, 1/2.7" MARS Sensor Board	MARS sensor board with 2.3 MP, 1/2.7" high-dynamic range color AR0231AT image sensor with LED Flicker Mitigation and BSI pixel technology for superior low-light performance
MARS1-AR0132AT6-GEVB	1.2 MP, 1/3" MARS Sensor Board	MARS sensor board with 1.2 MP, 1/3" high-dynamic range color AR0132AT image sensor
MARS1-AR0136AT3-GEVB	1.2 MP, 1/3" MARS Sensor Board	MARS sensor board with 1.2 MP, 1/3" high-dynamic range color ARO136AT image sensor and BSI pixel technology
MARS1-AR0140AT3-GEVB	1.0 MP, 1/4" MARS Sensor Board	MARS sensor board with 1.0 MP, 1/4" high-dynamic range color AR0140AT image sensor
MARS1-AR0135AT2-GEVB	1.2 MP, 1/3" MARS Sensor Board	MARS sensor board with 1.2 MP, 1/3" global shutter AR0135AT image sensor with high global shutter efficiency and superior NIR performance
Co-Processor Board OPNs		Image Co-Processor Description
MARS1-AP0200AT2-GEVB		MARS Image Co-Processor (ICP)APO200AT High-Dynamic Range (HDR) ICP with built-in MJPEG and H.264 encoder and Ethernet-MII, RMII, GMII output interface
MARS1-AP0202AT2-GEVB	Up to 2.0 MP MARS Image Co-processor Board	MARS Image Co-Processor (ICP) with APO202AT High-Dynamic Range (HDR) ICP with parallel ouput
MARS1-AP0100AT2-GEVB	Up to 1.2 MP MARS Image Co-processor Board	MARS Image Co-Processor (ICP) with APO100AT High-Dynamic Range (HDR) ICP with sophisticated lens distortion correction and integrated video encoder for NTSC/PAL output
MARS1-AP0101AT2-GEVB	Up to 1.2 MP MARS Image Co-processor Board	MARS Image Co-Processor (ICP) with APO101AT High-Dynamic Range (HDR) ICP and parallel output
MARS1-AP0102AT2-GEVB	Up to 1.2 MP MARS Image Co-processor Board	MARS Image Co-Processor (ICP) with APO102AT High-Dynamic Range (HDR) ICP with sophisticated lens distortion correction and parallel output
Serializer OPNs		Serializer Description
MARS1-TI913-GEVK	MARS Serializer Board	Texas Instruments DS90UB913 Parallel to LVDS FPD-Link Serializer
MARS1-MAX96705-GEVB	MARS Serializer Board	Maxim MAX96705 Parallel to LVDS GMSL Serializer
Deserializer OPNs		Desrializer Description
MARS1-TI914	MARS Deserializer Board	Texas Instruments DS90UB914 LVDS to Parallel FPD-Link Deserializer
MARS1-MAX9706	MARS Deserializer Board	Maxim MAX96706 LVDS to Parallel GMSL Deserializer
Ethernet PHY OPNs		Ethernet PHY Description
MARS1-KSZ8081MNX-GEVB	MARS Ethernet PHY Board	MARS Micrel KSZ8081MNX-GEVB Ethernet PHY Board
Demo3 Adapter Board OPNs		Demo3 Adapter Board Description
MARS1-DEMO3-ADAPTER-GEVB	MARS Parallel to Demo3 Adapter	MARS Adapter for adapting the parallel serializer boards into Demo3 Demo Kit Tool
Demo3 Board OPNs		Demo3 Board Description
AGB1N0CS-GEVK	Demo3	Demo3 Demo Kit Tool

Automotive Lighting Systems



ON Semiconductor offers standard products and custom devices for automotive lighting applications. The company plays a prominent role in the market for Xenon driver ASICs, developed the defacto standard stepper driver for headlight leveling and swiveling, and is a leader in LED exterior lighting solutions.



Headlamp Leveling (Up/Down)

Headlamp

Front Lighting

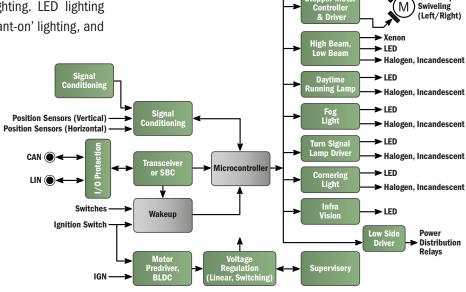
The majority of automobiles on the road today are equipped with halogen lights for the high-beam (HB) and low-beam (LB) functions - the main front lighting functions. Halogen LB typically consumes 55 W, and provides ~1,000 lumen. HID technology - introduced over ten years ago - consumes 35 W, and provides ~3,500 lumen. Because of the high intensity and risk of glare to approaching traffic, some countries require automatic leveling of the LB, plus a high pressure cleaning device. Over time, HID lights will integrate the HB function into bi-xenon solutions.

While halogen technology continues to be viable for front lighting, automotive designs increasingly use LED lighting. LED lighting offers enhanced styling options, enables 'instant-on' lighting, and allows brightness control from 0% to 100%

power.

Another important aspect for automotive front lighting is beam swiveling for Advanced Frontlighting Systems (AFS), to optimize the visibility in curves, and Adaptive Driving Beam (ADB), to adapt the beam to real-time situations. Stepper motors provide the primary controls for AFS and ADB.

ON Semiconductor offers a full range of products, from generic bulb driver solutions to stepper drivers, LED drivers, and Xenon drivers, that are specifically designed for front lighting.



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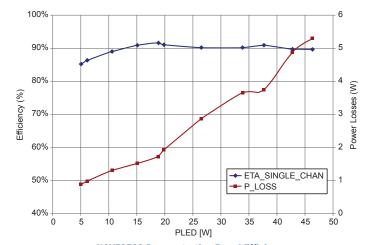
Front Lighting - Power Ballast and Dual LED Driver for Advanced LED

The NCV78763 single-chip, intelligent LED driver for front lighting enables single-module control of high beams, low beams, daytime running lights, position lights, cornering lights, turn indicators, and fog lights. With integrated digital dimming, SPI

programmable settings, and build-in diagnostics, the NCV78763 offers integrated, energy efficient solutions for comprehensive front lighting control.

Features - NCV78763

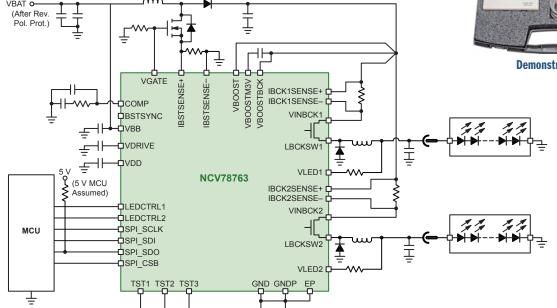
- System integrated solution with few external components.
- Buck-boost topology
- LED current regulator
 - Constant average current
 - Efficient integrated buck switches (high-side)
 - Current per output up to 1.6 A
 - Extended diagnostics: detection of open circuit or failing driver, short, over-current protection, single LED failures
 - Thermal protection
- System customization by SPI interface
 - Multiple system configurations with one device
 - · Fewer module versions for OEM
- Better EMC behavior, without extra filtering
 - Low EMC from battery
 - . Low EMC to LED string
- High overall efficiency (>90%)



NCV78763 Demonstration Board Efficiency



Demonstration Kit



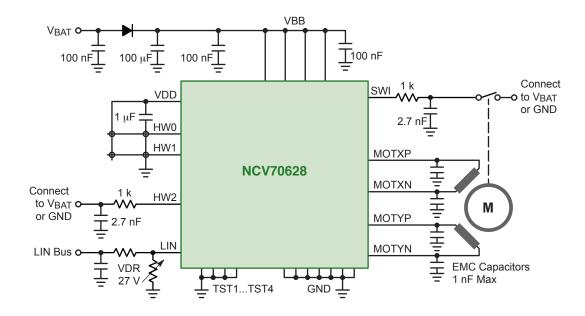


NCV78763 Application Diagram

Front Lighting - Leveling and Swiveling

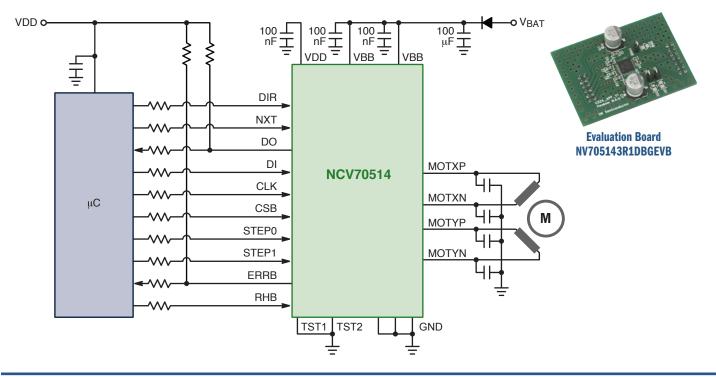
The NCV70628 is a single-chip micro-stepping motor driver with position controller and control/diagnostic interface, making it

ideal for dedicated mechatronics solutions, connected remotely through a LIN master.



The NCV70514 is a micro-stepping motor driver that is fully compatible with automotive voltage requirements, and is

especially well-suited for use in applications with fluctuating battery supplies.



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Front Lighting - Small Signal Solutions for Pixel (Matrix) Control

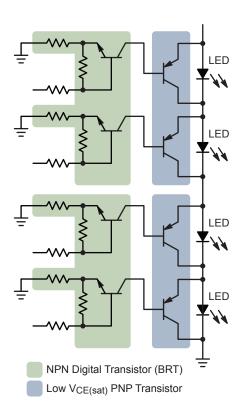
Today's adaptive front lighting systems (AFLS) utilize a combination of sensors, motors, and a LED matrix to adjust the direction and intensity of the light beam. One AFLS method involves blanking of certain LED strings within the matrix, which can be controlled by a combination of small signal components such as Low VCE(sat) bipolar transistors and digital transistors (BRT – bias resistor transistor).

The collector of the NPN digital transistor is connected to the base of the Low VCE(sat) PNP transistor, thereby forming an ultra-low saturation voltage (VCE(sat)) and high current gain capability of the combination. The high current gain allows this combination to be driven directly from an MCU or PMU's control outputs, reducing overall system complexity and cost.



Features

- AEC-Q101 discrete & Mixed Element Array (MEA) components
- Low VCE(sat) ensures shunting of LED
- Simplifies circuit design & reduces component count
- PCB space saving with 2 mm x 2 mm wettable flank DFN packaging



Device	VCEO (V)	Ic (A)	VCE(sat) (V)	Description	Package(s)	
NSV60100DMTW	-60	1.0	-0.35	60 V, 1 A Dual PNP Low V _{CE(sat)} BJT		
NSV60200DMTW	-60 -60		-0.45	60 V, 2 A Dual PNP Low V _{CE(sat)} BJT	WDFN-6 WF	
NSV20200DMTW*	-20	2.0	-0.39	20 V, 2 A Dual PNP Low VCE(sat) BJT		
NSVMUN5214D	50	0.1	0.25	Dual NPN BRT, R1 = $10k\Omega$, R2 = $47k\Omega$	SC-88 (SOT-363)	
NSVM602002214DMTW*	-60	2.0	-0.45	60 V, 2 A MEA - Dual (NPN BRT + PNP Low V _{CE(sat)} BJT)	WDEN C WE	
NSVM202002214DMTW*	-20	2.0	-0.39	20 V, 2 A MEA - Dual (NPN BRT + PNP Low VCE(sat) BJT)	WDFN-6 WF	

^{*} Pending 4Q18.

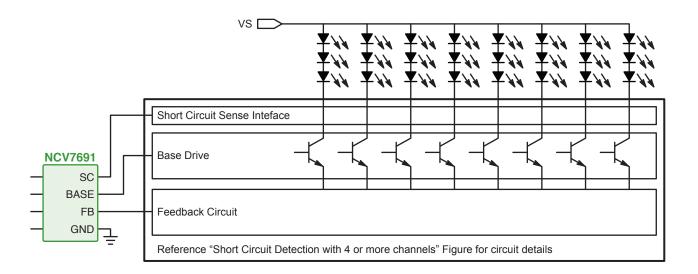
Rear Lighting - Linear LED Pre-Driver

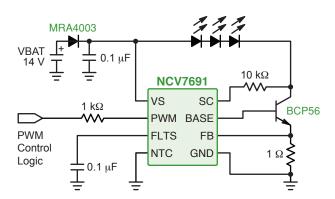
NCV7691 is a pre-driver intended for linear drive of LEDs. It can operate from the car battery and multiple LED strings can be driven by a single NCV7691 device.

Features - NCV7691

- Constant Current Output for LED String Drive External Programming Current Resistor
- Wide Current Range using External Bipolar Device
- Multiple LED String Control
- Pulse Width Modulation (PWM) Control

- Negative Temperature Coefficient (NTC) Current Control
- Open LED String & Short-Circuit LED String Diagnostic
- Overvoltage Set Back Power Limitation
- SOIC-8 Package
- AEC-Q100 Qualified and PPAP Capable





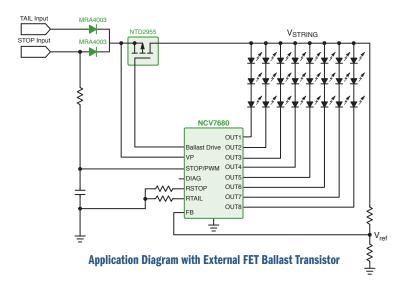
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Rear Lighting - Linear Current Regulators/Controllers

For Rear Combination Lamps, Daytime Running Lights, Fog Lights, CHMSLs, Turn Signals

The NCV7680, NCV7681, and NCV7683 are 8-channel linear programmable constant current sources, designed for the regulation and control of LED-based lighting.

- Allow for two programmed levels for Stop and Tail illumination, or optional external PWM
- Slew rate control to eliminate EMI concerns
- Sequencing functionality (NCV7683)





The NCV7684 is a 12-channel linear programmable constant current sources, designed for the regulation and control of LED-based lighting.

- Allow for 128 current levels, adjustable with I2Cprogrammable PWM
- 3.3 V voltage reference for loads up to mA
- OTP back for stand-alone operation (2 configurations)

Device	Channels	Vı Max (V)	Io Max (mA)	Max LEDs in Series	Max LEDs in Parallel	Package(s)
NCV7680	8	45	75	1	16	SOIC-16 WB EP
NCV7681	8	40	100	3	8	SOIC-16 WB EP
NCV7683	8	40	200	4	24	SSOP24 NB EP
NCV7684	12	40	60	3	12	SSOP24 NB EP

Interior Lighting - LIN RGB LED Driver

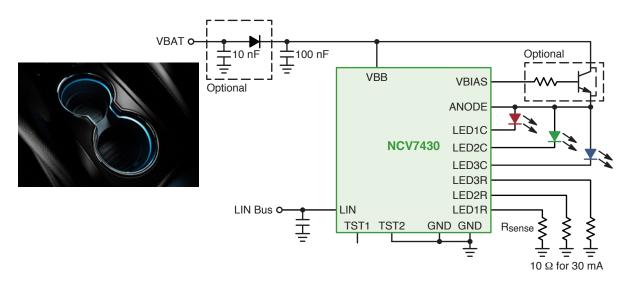
The LIN Bus (Local Interconnect Network) is an inexpensive serial communications protocol, which is used within current automotive network architectures. It is a relatively slow communication system intended to monitor sensor devices or actuators in today's cars.

The NCV7430, LIN RGB LED Driver, combines a LIN transceiver together with a RGB LED driver and memory. It is a single-chip RGB driver intended to monitor for dedicated multicolor LED applications in automotive interior lighting. It contains a LIN interface (slave) for parametric programming of LED color and

intensity. The device receives instructions through the LIN bus and subsequently drives the LEDs independently.

The NCV7430 acts as a slave on the LIN bus and the master can request specific status information (parameter values and error flags). The LIN address of the NCV7430 can be programmed in the internal memory of the device.

The NCV7430 is fully compatible with automotive requirements.



Features - NCV7430

RGB LED Driver

- 3 independent LED current regulators
- LED currents programmable with external resistors
- · Power dissipation option with external ballast transistor
- LED temperature compensation with external sense circuit
- Modulation control for 3 LEDs (with calibration)

LIN Interface

- LIN physical layer according to LIN 2.1/SAE J2602
- OTP-programmable device node number and group address
- Diagnostics and status information about LEDs
- Supports auto-addressing

Protection and Diagnostics Over-Current Detection

- · Short circuit detection to GND and VBB
- · Open LED detection
- High temperature warning and shutdown
- · Retry mode on error detection

Power Saving

- Sleep mode supply current 20 μA
- Compliant with 14 V automotive systems

EMI Compatibility

- LIN Bus integrated slope control
- FMC reduced LFD modulation mode

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Interior Lighting and Center High Mount Stop Lamp (CHMSL) - Constant Current Regulators

The two-terminal linear constant current regulators (CCRs) are simple, economical, and robust devices that provide an effective solution for regulating current in cost-sensitive LED applications. The devices require no external components, allowing them to be implemented as high or low-side regulators. These

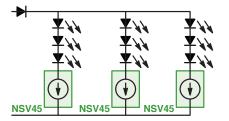
devices regulate output current over a wide range of input voltage, and are designed with a negative temperature coefficient to protect LEDs from thermal runaway at extreme voltage and operating temperature.

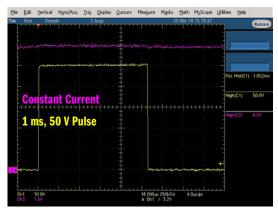
Features

- Regulated current provides constant brightness over wide voltage range
- Negative temperature coefficient protects LEDs in high ambient conditions
- Available with multiple maximum operating voltages (45 V, 50 V, and 120 V) to withstand battery load dump

Resources

• Sample Kit: CCR2KIT/S





Constant Current Supply During Vehicle Battery Load Dump

Device	Max Anode-to-Cathode Voltage (V _{AK}) (V)	Voltage Overhead (V _{in} – V _{LEDs}) (V)	Constant Current I _{reg} (@ V _{ak} = 7.5 V) (mA)	Current Tolerance Over Voltage	Max Junction Temperature (°C)	Packages
NSV45xxx	45	1.8	Fixed: 15, 20, 25, 30	±15%, ±10%	150	SOD-123, SOT-223
NSV50xxx	50	2.0	Fixed: 10, 350	±10%	175	SMC, DPAK
NSVC20xx	120	1.8	Fixed: 20, 30, 50	±15%	175	SMB
NSV45xxxJ	45	1.8	Adjustable 20 to 40 35 to 70 60 to 100 90 to 160 150 to 350	±15%	150	SOT-223, DPAK

NOTE: xxx in the device number represents the current level.



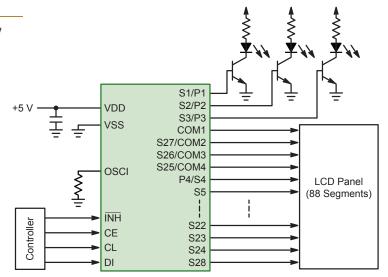




LCD Drivers for Information Display Panels

Features

- LCD driver (common drive and segment drive) controlled by external microprocessor
- Serial data input supports CCB format communication
- Many additional functions around the display application
 - Key input function
 - LED driver output port
 - General purpose output port
 - PWM output function for brightness adjustment of the backlight
 - LCD display contrast adjustment
- Wide operating temperature ($T_A = -40 \text{ to } +85/+105 \text{ °C}$)



LC75843 Application Diagram, 1/4 Duty, 3-Channel PWM

Device		Segments*				V _{LCD} (V)	Output Ports	PWM Channels	Package(s)
	Static, 1/2 Duty	1/3 Duty, 1/4 Duty					<u>'</u>		
LC75843	24 to 28, 46 to 54	66 to 78, 84 to 100		4.0 - 6.3	3.3 or 5.0	V_{DD}	4	3	TSSOP-36
	1/3 Duty	1/4 Duty							
LC75897	363 to 387	480 to 512		2.7 - 6.0	V_{DD}	2.7 - 6.0	8	3	SQFP-144
LC75879	183 to 207	240 to 272		4.5 - 6.3	3.3 or 5.0	V_{DD}	8	3	TQFP-80J
LC75829	147 to 159	192 to 208		4.5 - 6.0	3.3 or 5.0	V_{DD}	4	_	SQFP-64
LC75806	198 to 231	260 to 304		4.5 - 6.0	3.3 or 5.0	V_{DD}	9	_	TQFP-100
	1/8 Duty	1/9 Duty	1/10 Duty						
LC75818	Dot matrix (5 x 7) x 16 + 80	Dot matrix (5 x 8) x 16 + 80	Dot matrix (5 x 9) x 16 + 80	2.7 - 3.6	3.3 or 5.0	4.5 - 10.0	4	_	TQFP-120
LC75812	Dot matrix (5 x 7) x 13 + 65	Dot matrix (5 x 8) x 12 + 64	_	2.7 - 3.6	3.3 or 5.0	4.5 - 10.0	3	3	TQFP-100
	Static, 1/2 Duty	1/3 Duty, 1/4 Duty	LED Driver						
LC75805	38, 74	108, 140	48 Channels	4.5 - 5.5	V_{DD}	V_{DD}	_	7	QIP-100E

^{*} Number of segments depends on 'common v segment' configuration.







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In-Vehicle Networking Solutions

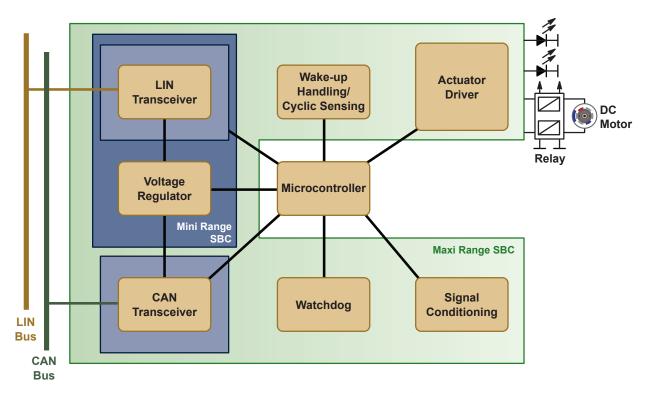








Automobile manufacturers today design decentralized, distributed systems, connected through industry interface standards. ON Semiconductor offers an innovative in-vehicle networking portfolio, including LIN, CAN, CANFD, and FlexRay™ transceivers – AEC qualified. The company also offers System Basis Chips that integrate transceivers with other circuits, including voltage regulators, drivers, and supervisory functions.



Typical System Partitioning with LIN and CAN Bus Connections

System Basis Chips

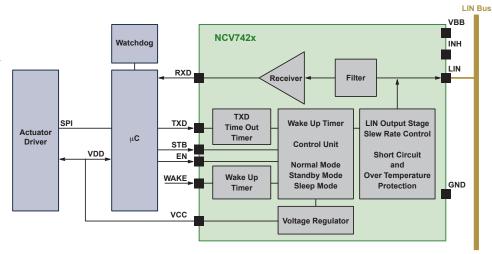
Integration of key system components, like LIN, CAN, and voltage regulators, within ECUs delivers:

- · Improved system reliability
- Reduced power consumption
- Use of less board space
- Cost-optimized solutions

ON Semiconductor's IP, combined with years of experience designing integrated custom circuits, has led to successful development of a System Basis Chip portfolio.

NCV742x Features

- Based on NCV7321
- Ideal solution for low BOM slave nodes
- 3.3 V and 5 V versions
- NCV7420 includes 50 mA voltage regulator
- NCV7425 includes 150 mA voltage regulator



NCV742x LIN-SBC: LIN +LDO (5 or 3.3 V) up to 150 mA

System Basis Chips

Device	Description	Data Transmission Standard	Io Max (mA)	Number of Drivers	Number of Transceivers	V _{CC} Min (mA)	V _{CC} Max (mA)	Package(s)
NCV7420	System Basis Chip with LIN and Voltage Regulator (WAKE, INH)	LIN	50	0	1	5	26	S0IC-14
NCV7425	System Basis Chip with LIN and Voltage Regulator (WAKE, INH, RSTN)	LIN	150	0	1	5	28	SOIC-16W EP
NCV7428	LIN (low slope, normal slope) Transceiver with Voltage Regulator (70 mA, 3.3 or 5.0 V)	LIN	70	0	1	3.234, 4.9	3.366, 5.1	SOIC-8, DFN-8
NCV7429	System Basis Chip with LIN, LS and HS Switches	LIN	150	5	1	4.9	5.1	TSSOP-20 EP
NCV7430	System Basis Chip with LIN and RGB LED Driver	LIN	100	3	1	5.5	43	S0IC-14
NCV7462	System Basis Chip with LIN, CAN, 2 Voltage Regulators, and HS/LS Drivers	LIN; CAN	250	7	2	5	28	SSOP-36 EP
NCV7471	System Basis Chip with Dual LIN, CAN, Voltage Regulator, and Buck-Boost DC-DC	LIN; CAN	500	0	3	2.5	28	SSOP-36 EP
AMIS-42700/70	Dual High Speed CAN Transceiver	CAN	NA	0	2	NA	NA	S0IC-20
NCV7440	System Basis Chip with CAN and LDO	CAN	NA	0	1	NA	NA	DIE
NCV7441	Dual High Speed, Low Power CAN Transceiver	CAN	NA	0	2	NA	NA	S0IC-14
NCV7446	Two channel High Speed, Low Power CAN, CAN FD Transceiver	CAN/CANFD	NA	0	2	NA	NA	DFN-14

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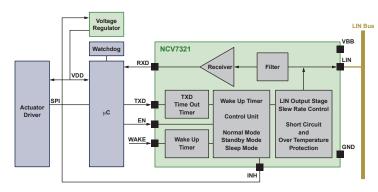
Standalone LIN Transceivers

The LIN bus communicates low rate (up to 20 kBaud) data from control devices - such as door locks, mirrors, car seats, and sunroofs - for non-time-critical functions. The LIN bus protocol uses only a single wire in each node, minimizing wiring costs. Each node includes a slave MCU state-machine that recognizes and translates the instructions specific to that function. ON Semiconductor offers products for both US (SAE J2602-2) and European (LIN Physical Layer Specification Rev. 2.x) standards.

NCV7321 Features

- Compliant to OEM requirements
- Outstanding EMC performance
- System ESD levels >12 kV
- Combines high voltage analog and digital functionality
- Transmission rate 1-20 kBaud





Standalone LIN Transceiver NCV7321

LIN Transceivers

Device	Description	Bus Speed (Baud)	ISO 9141	LIN 2.0/2.1/2.2	J2602	Sleep Mode Current (µA)	ESD Protection IEC 61000-4-2 (LIN pin)	Package(s)
AMIS-30600	LIN Transceiver	20 k	1	1	✓	55	6 kV	SOIC-8
NCV7321	LIN Transceiver	20 k	✓	1	✓	10	>12 kV	SOIC-8
NCV7424	Quad LIN Transceiver	20 k	1	1	✓	30	>12 kV	TSSOP-16
NCV7329	LIN Transceiver	20 k	✓	1	✓	10	>12 kV	SOIC-8
NCV7420	LIN Transceiver with Voltage Regulator (50 mA, 3.3 or 5.0 V)	20 k	1	✓	1	20	>12 kV	SOIC-14
NCV7422*	Dual LIN Transceiver	20 k	1	1	✓	20	>12 kV	DFN-14
NCV7425	LIN Transceiver with Voltage Regulator (150 mA, 3.3 or 5.0 V)	20 k	1	1	1	20	>12 kV	SOIC-16W EP
NCV7428	LIN (low slope, normal slope) Transceiver with Voltage Regulator (70 mA, 3.3 or 5.0 V)	20 k	1	1	1	25	>12 kV	SOIC-8
NCV7429	System Basis Chip with LIN, LS and HS Switches	20k	1	1	1	30	>6 kV	TSSOP-20 EP

^{*} Pending 4Q18.

FlexRay™ Transceivers

Features

- Compliant to FlexRay v3.0.1 physical layer
- Excellent EMC and ESD performance

FlexRay™ Transceivers

Product	Description	Bus Speed (Baud)	FlexRay Standard	Host Interface	ESD Protection IEC61000-4-2 (CAN pins)	Package(s)
NCV7381A	Clamp-30 FlexRay Transceiver	10 M	v3.0.1.	ERRN pin	>10 kV	SSOP-16
NCV7383	Clamp-15 FlexRay Transceiver	10 M	v3.0.1.	SPI	> 10 kV	TSSOP-14



Standalone CAN Transceivers

The latest generation CAN transceivers exhibit industry-leading performance on electromagnetic capabilities (ESD and EMI). These devices are designed in ON Semiconductor's proven, innovative I3T technology, that delivers highly robust, high quality components with failure rates measured in parts-per-billion.

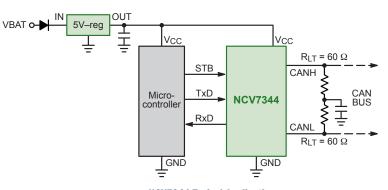






Features

- Portfolio includes transceivers specifically designed for:
 - Low Speed Fault Tolerant
 - · High Speed
 - Low Power
 - Single Wire
 - Flexible Data Rate
- Conformance tested by external test house (ISO11898)
- System ESD protection according to IEC 61000-4-2
- Highly robust against EM fields (low Electro Magnetic Susceptibility – EMS)



NCV7344 Typical Application

CAN Transceivers

Device	Description	Standard	Sleepmode Current Max (µA)	Bus Speed Max	ESD Protection IEC 61000-4-2 (CAN pins)	Package(s)
NCV7344	High Speed Low Power CAN, CANFD Transceiver	IS011898-2:2016	15	5 Mbps	>8 kV	SOIC-8, DFN-8
NCV7357***	High Speed Low Power CAN, CANFD Transceiver	IS011898-2:2016	15	5 Mbps	>8 kV	SOIC-8, DFN-8
NCV7446	Two channel High Speed, Low Power CAN, CAN FD Transceiver	IS011898-2:2016	30	5 Mbps	8 kV	DFN-14
NCV7351F	High Speed CAN, CANFD Transceiver	IS011898-2:2016	N/A*	2 Mbps	>12 kV	S0IC-8
NCV7349	High Speed, Low Power CAN Transceiver**	IS011898-5	15	1 Mbps	>12 kV	SOIC-8
NCV7342	High Speed, Low Power CAN Transceiver	IS011898-5	15	1 Mbps	>12 kV	SOIC-8, DFN-8
NCV7340	High Speed, Low Power CAN Transceiver	IS011898-5	15	1 Mbps	>12 kV	SOIC-8
AMIS-42665	High Speed, Low Power CAN Transceiver	IS011898-5	15	1 Mbps	4 kV (HBM)	S0IC-8
NCV7441	Dual High Speed, Low Power CAN Transceiver	IS011898-5	30	1 Mbps	8 kV	S0IC-14
NCV7341	High Speed, Low Power CAN Transceiver	IS011898-5	35	1 Mbps	8 kV	S0IC-14
AMIS-42700	Dual High Speed CAN Transceiver	IS011898-2	N/A*	1 Mbps	4 kV	S0IC-20
NCV7351	High Speed CAN Transceiver	IS011898-2	N/A*	1 Mbps	>12 kV	S0IC-8
AMIS-30660	High Speed CAN Transceiver	IS011898-2	N/A*	1 Mbps	4 kV	S0IC-8
AMIS-30663	High Speed CAN Transceiver	IS011898-2	N/A*	1 Mbps	4 kV	SOIC-8
AMIS-41682	Low Speed Fault Tolerant CAN Transceiver	IS011898-3	60	250 kpbs	6 kV (HBM)	SOIC-14
AMIS-41683	Low Speed Fault Tolerant CAN Transceiver	IS011898-3	60	250 kpbs	6 kV (HBM)	S0IC-14
NCV7356	Single Wire CAN Transceiver	J2411	60	40 kpbs	4 kV (HBM)	SOIC-14

 $^{^{\}ast}$ Sleepmode not featured/implemented. **SW-CAN - Not defined in ISO. *** Pending 4Q18.

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Door Electronics Systems

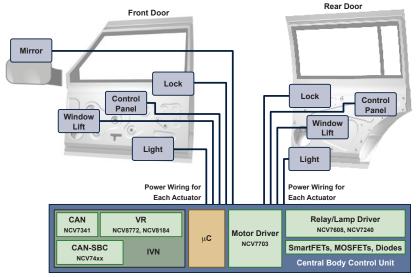
Door electronics are prevalent in modern vehicles, with most automobiles containing electronic window lifts and central locks. Additional safety features, like pinch protection and child-proof locks, increase the electronic content in door modules. Additional available features include side mirror positioning, folding, and defrosting; and for high-end models, electrochromic mirror control, that darkens the mirror depending on the brightness of the irradiated beam of oncoming traffic. Some lamp applications, like flashers in the mirror or some LEDs for interior lights, are also being adopted.

There are different door electronic topologies available:

· Centralized door electronics

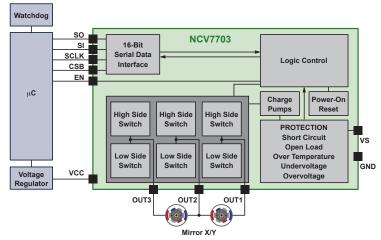
- De-centralized door electronics
- · Mixed door electronics

Centralized Door Electronics System



The most common topology is centralized electronics, where the electronics system is implemented in the Body Control Unit (BCU). ON Semiconductor offers:

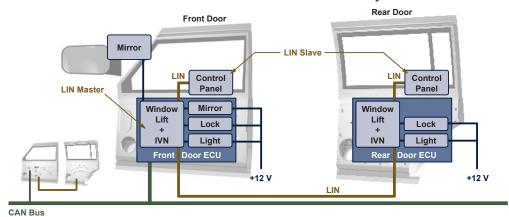
- In-Vehicle-Networking CAN transceivers, LIN transceivers, system-basis-chips
- Voltage regulators
- Load drivers for motors, lamps, and relay controls
- Logic functions
- Discrete components diodes, transistors, protection devices



For mirror positioning, two motors adjust the glass along x and y axes. The NCV7703 features three integrated half-bridge drivers. The output stages are controlled by a 16-bit SPI interface. Complete diagnostic information is provided to the microcontroller through the SPI.

Door Electronics Systems

De-Centralized Door Electronics System

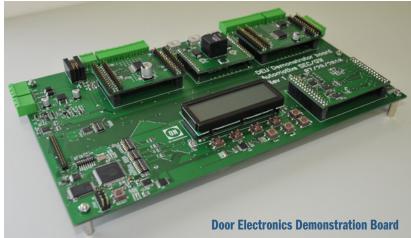


As the electronics content becomes more complex, the large amount of wires drives designs toward a de-centralized topology. The de-centralized door modules communicate over a CAN or LIN bus system.

Benefits of de-centralized door module topologies:

- Reduced use of wiring harness
- Reduced weight and power consumption positively impact fuel consumption
- Enables modular architectures through use of sub-modules

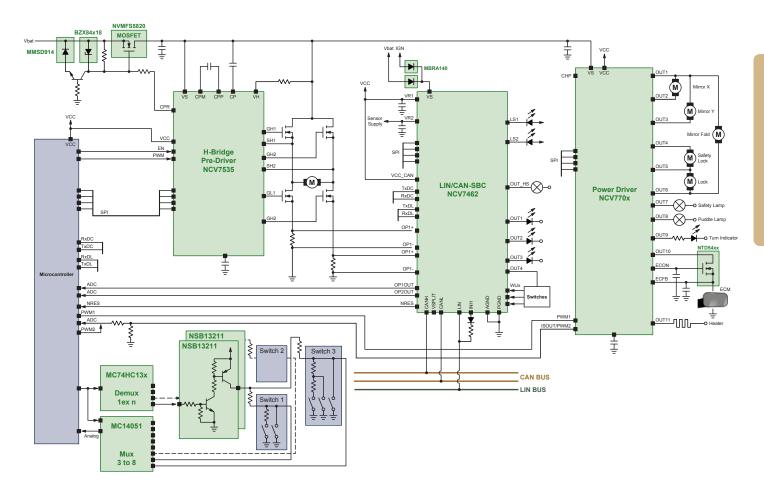




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Solution for De-Centralized Front Door Electronics Systems

ON Semiconductor supplies ASSPs for door module electronics, including CAN- and LIN-enabled SBCs designed specifically for door modules. Smart Power BCD Technology enables the integration of powerful driver stages, that may be used for door locks, mirror folding and heating, and lamp drivers. The integration of complex state machines and PWM control units creates components that are flexible enough to drive different types of lamps and motors. Standard products like multiplex devices, amplifiers, MOSFETs, bus and supply protection components, allows ON Semiconductor the opportunity to support complete customer designs.



Control, Communication, and Power for Body HVAC

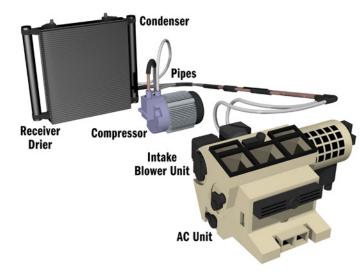
The HVAC system includes several subsystems

Vehicle heating & ventilation systems

To improve passenger comfort and safety, fresh air is drawn from outside ducts and directed to the passenger compartment. Incoming air can be heated by passing over a small heating core connected to the engine's cooling system.

Air conditioning refrigerant

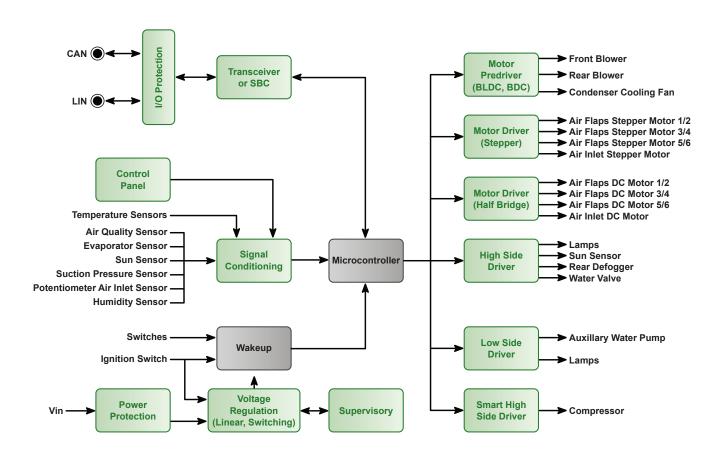
The refrigerant removes heat from the vehicle interior and transfers it to the outside air in a continuous cycle of vaporization and condensation. Reducing the temperature of the air also reduces its humidity. Cold air will not hold as much water vapor as warm air.



Interior Air Conditioning Unit

Control head

ECU (Electronic Control Unit) with user interface.



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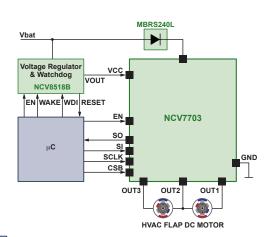
DC Motor Drivers for Body HVAC

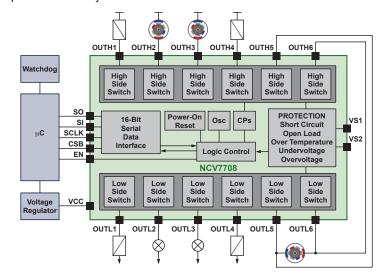
The most popular flap actuators are simple DC motors with position signal feedback to the microcontroller. To control a DC motor in forward and reverse direction, two high-side and two low-side power stages are necessary, in full-bridge configuration. Typically, these drivers integrate required features such as overvoltage, overload, and over temperature protection. In addition, the SPI interface provides diagnostics to the microcontroller.

Integrated pulse count technology combined with an extra signal conditioning block replaces the discrete position potentiometer. In pulse count applications, the circuit detects the DC motor commutation pulses and creates a pulse for every detected commutation pulse. These pulses are generally fed back to a microcontroller for position sensing and control. ON Semiconductor has custom ASICs for these types of circuits, in production today.

Dual Hex High/Low-Side Driver

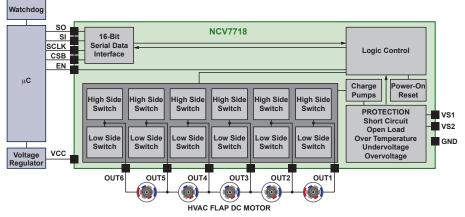
The NCV7708 is a flexible, single sided high/low-side driver. The six high and low-side channels are specifically designed for motor control configurations, like half or full bridges. NCV7708 will control five DC motors via a 16-bit SPI interface. The device can also control relays or LEDs.





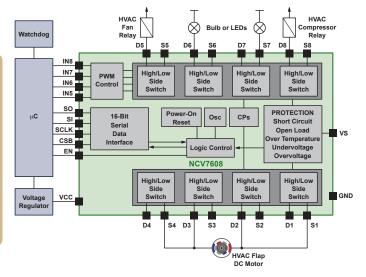
Half-Bridge Drivers

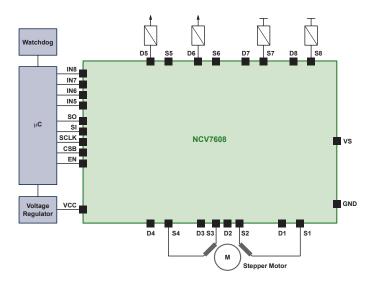
NCV7703 triple half-bridge driver controls two DC Motors. The power stages are internally connected as half-bridges, which allows a pin-count reduction to the SOIC-14 package. NCV7718 hex half-bridge driver controls up to 5 DC motors, and is offered in the SSOP-24 package. NCV7719 and NCV7720 increases the number of outputs to 8-channel and 10-channel, respectively.



Configurable Motor, Relay, and LED Driver for Body HVAC

The NCV7608 drives different types of motors and various loads, such as bulbs, LEDs, and relays. The eight integrated output drivers are configurable in any combination of high-side, low-side, or half-bridge. This enables connection to DC, unipolar, or bipolar stepper motors. In addition, four channels include external PWM control capability. NCV7608 includes a special diagnostic current disable bit to prevent LED-glowing, as well as standard diagnostic features.

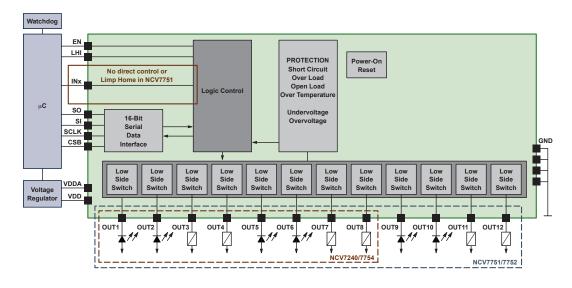




Highest Flexibility with NCV7608

NCV7608 Supports Unipolar and Bipolar Stepper Motor Control

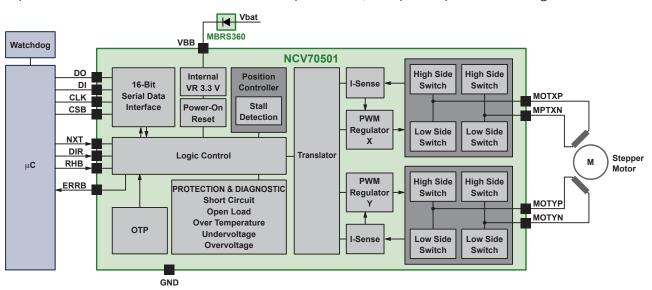
The NCV7240/54 eight channel low-side drivers and NCV7751 twelve channel low-side driver provide drive capability up to 600 mA per channel. Output control via SPI port offers convenient reporting of faults. Additionally, parallel control of the outputs is addressable (in pairs) via the INx pins. A dedicated limp-home mode pin (LHI) enables OUT1-OUT4 while disabling OUT5-OUT8. The devices are able to drive loads like LEDs, relays, or unipolar stepper motors.



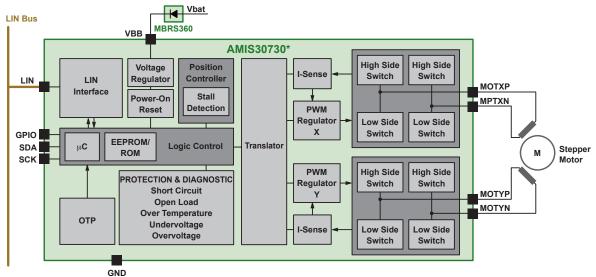
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Bipolar Stepper Motor Drivers for HVAC

In climate control systems unipolar and bipolar stepper actuators are used. For unipolar solutions the control electronic is more simple compared to bipolar ones. Instead of four low-side switches for unipolar motors, the bipolar requires two full-bridges.



Air-inlet flaps require low acoustic noise because the actuator operates in a continuous manner. Low acoustic noise can be achieved by using stepper motors, such as the NCV70501 micro-stepping stepper motor driver for bipolar stepper motors. NCV70501 controls the current through the windings of the bipolar stepper motor, contains a current-translation table and takes the next micro-step depending on the clock signal on the "NXT" input pin and the status of the "DIR" (=direction) register or input pin. An external microcontroller can work in interrupt mode, so there is no need to monitor the status registers continuously.



* Customer specific embedded software

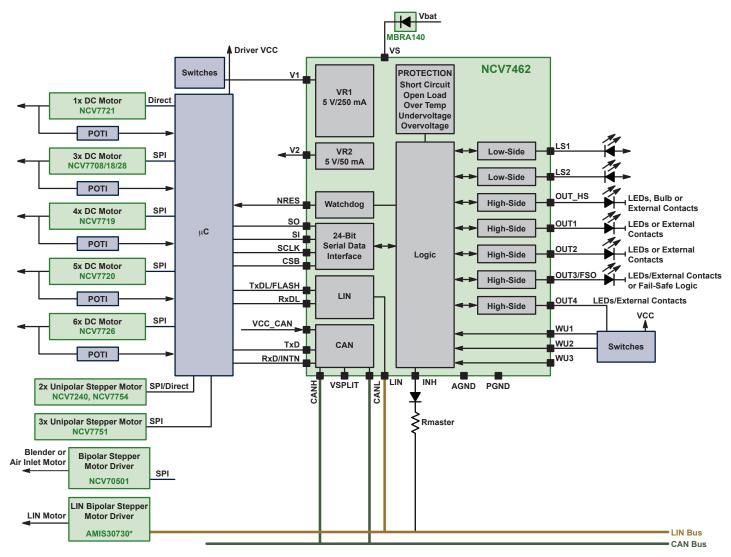
AMIS-30730 is a single-chip platform for intelligent stepper motor drivers with embedded microcontroller and LIN interfaces. The device may be customized with embedded software for dedicated mechatronic solutions connected remotely with a LIN master.

Air Flap Actuator Driver Topologies for HVAC

Climate control systems may operate with different system topologies - driven by the different regional and OEM requirements.

Actuator Types

- · Direct controlled actuators
 - DC motors (with and without position feedback)
 - · Unipolar stepper motors
 - · Bipolar stepper motors
- · Bus connected mechatronic actuators
 - LIN bipolar stepper motors

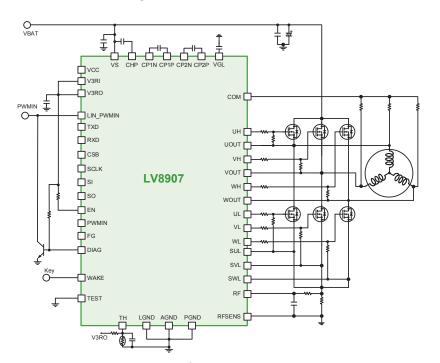


^{*} Customer specific embedded software

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BLDC Motor Driver

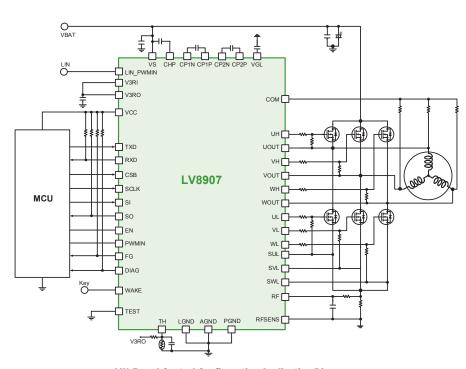
BLDC motors enable higher efficiency and torque, and are therefore increasingly being adapted into automotive applications. Designs can be optimized through the use of specialized pre-drivers, such as the LV8907UW three-phase BLDC pre-driver.



Standalone Configuration Application Diagram

LV8907UW Features

- Integrated sensor-less control
- Integrated gate drivers for external power MOSFETs
- Integrated LIN transceiver and LDO
- Integrated protection (Under-voltage, Overtemperature, Over-current, Locked Rotor, PWM Fault)
- Operation up to 175°C junction temperature
- OTP for configuration and standalone operation
- SPI for real-time control
- VIN of 5.5 20 V
- SQFP-48 package

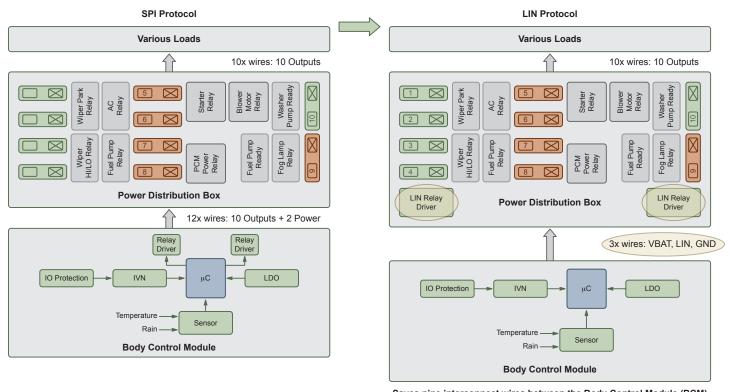


LIN-Based Control Configuration Application Diagram

LIN-Based Low-Side Relay Drivers for Automotive Power Distribution Relays

NCV7748 Features

- Reduce harness complexity for Power Distribution Boxes
- Scalable between 4 or 8 channels
- Ability to control up to 32 relays with Virtual Node concept
- Diagnostics for abnormal load conditions
- Integrated clamps for inductive loads
- Designed for both PCB mounted or socketed relays
- Reduce PCB area and weight



Saves nine interconnect wires between the Body Control Module (BCM) and the Power Distribution Box (PDB) $\,$

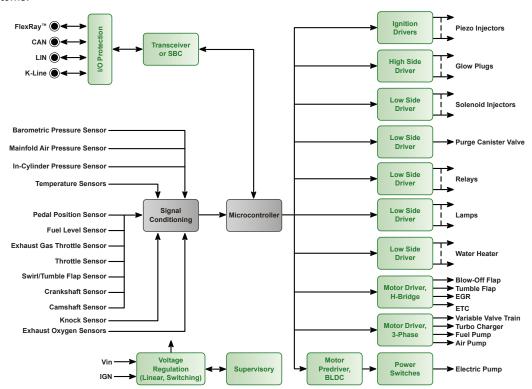
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Engine Management Systems

Approximately 80% of engines in the world are gasoline engines. Gasoline engines are starting to incorporate direct injection and turbo charging, to improve the efficiency of the simple and cost-effective engine. Gasoline engines will continue to be the predominant power source world wide; however, diesel engines have achieved ~40% penetration in Europe and have additional potential in North America.

Automotive electronics contributes to the drive for efficiency through control, sensing and actuation of the engine. Critical components, such as injectors and valves, are carefully controlled to reach the maximum efficiency. To improve control, pressure in the combustion chamber is measured and processed in real time, in order to reduce fuel consumption of the gasoline engine by 30%.

ON Semiconductor has developed numerous custom solutions and standard products for gasoline, bi/flexfuel, and diesel engines. The company's expertise covers the full spectrum of applications, ranging from air and fuel supply over ignition control, to exhaust aftertreatment subsystems.



Diesel Engine Management System

Product Portfolio

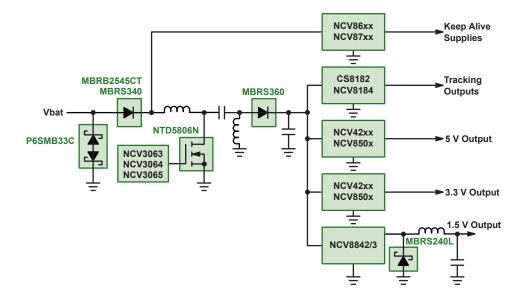
- Inductive angular sensor interfaces
- · Pressure sensor interfaces
- Knock- and wheel-speed detection circuits
- · Oil-, urea- and air-flow interfaces
- In-vehicle networking components
- Actuator drivers and pre-drivers for throttle and flaps, solenoid- and piezofuel injection systems, spark ignition, fans, pumps, and hydraulic controls



Power Management Rails for Powertrain

Increasing demand for lower emissions, higher fuel economy, higher efficiency engines, and higher performance vehicles drive the need for precise control of ignition, fuel systems, and exhaust control. In order to efficiently perform all these functions, the latest generation of engine controllers need high-end 32-bit multi-core processors. These high-end microprocessors require efficient and reliable power management subsystems.

The power management subsystem must be able to handle various battery transients, such as load dump, double battery, reverse battery, and other inductive and capacity coupled transients. The subsystem typically provides regulated 5 V, 3.3 V, 1.0-1.5 V, and other tracking outputs, to power microcontrollers, sensors, memories, and other peripheral devices in the ECU.



ON Semiconductor offers a wide selection of highly efficient power supply solutions that can handle harsh powertrain battery transients. The portfolio includes multi-topology controllers, such as NCV8871 and NCV3063, to provide regulated voltage greater than 5 V with a battery operating voltage between 4 V to 18 V; as well as buck regulators and controllers, like NCV8851 and NCV8842, to supply the high current, low voltage microcontroller cores.

To support 'keep alive' 5 V and 3.3 V voltage rails in an ECU, ON Semiconductor offers a wide selection of low Iq and standard linear voltage regulators. In addition, fully protected tracking regulators — such as NCV4250-2C, NCV8184, CS8182, and CS8361 — that can power external sensors, complete the portfolio.

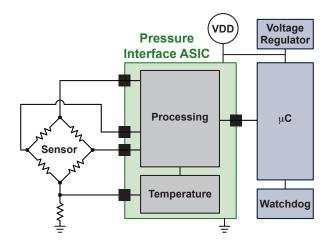
Along with the linear regulators and switch mode power supplies, ON Semiconductors also offers power MOSFETs for SEPIC and BUCK applications, as well as low Vf rectifiers and TVS diodes for reverse battery and load dump applications.

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ASICs for Powertrain

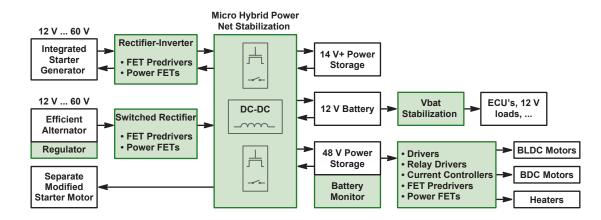
Cylinder Pressure Sensing

Monitoring and measuring pressure is an integral part of engine management. Pressure sensors keep track of conditions within the manifold (MAP and TMAP), monitor diesel particle filters, and control the high pressures involved in both diesel and gasoline direct injection. In-cylinder pressure sensing (ICPS) enables even more accurate combustion control, to allow further reduction in NOx and CO2 emissions, for cleaner diesels and other advanced internal combustion engines of the future.



Micro-Hybrid

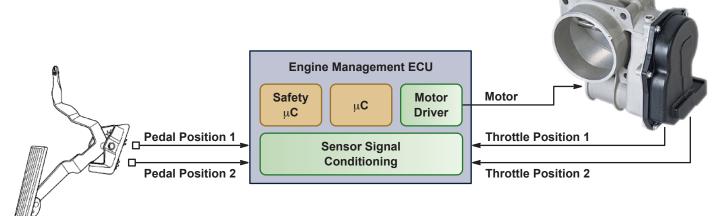
Micro-Hybrids are start-stop vehicles with additional features to reduce CO2 emissions: the internal combustion engine is switched-off while the vehicle is still moving; regenerative brake energy can be captured in a dedicated power-storage system; and electricity generation is avoided during acceleration. An efficient alternator or an Integrated Starter Generator (ISG) replaces the standard alternator while dedicated integrated circuits control the power net stability. Some of the 12 V high power loads (such as electric power steering and window defrosters) and some belt-driven ancillary loads (such as water pump, compressor, fan) can be replaced by electric drives from a 48 V battery. ON Semiconductor offers robust technologies, key intellectual property, and production proven solutions that address the harsh environments in these emerging applications.



Flap Control

To reduce fuel consumption and meet the strict requirements for the different regulations in the automotive industry - e.g., Euro-4 (2005), Euro-5 (2009), and Euro-6 (2014) - modern engine management systems must optimize the engine's efficiency, and reduce emissions of soot, NOx (Nitrogen Oxide), HC (Hydrocarbon), and CO (Carbon Monoxide). Therefore, the engine control unit needs to control the combustion process in an extremely precise manner. Flap control systems include several air and exhaust gas flaps:

- · Electronic throttle
- Exhaust recirculation flap
- Tumble flap
- Blow-off flap



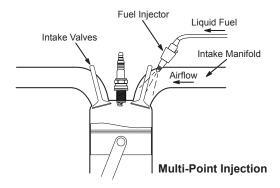
Electronic content for ETC systems

- Pedal position sensor (inductive or Hall effect)
- Throttle position sensor (potentiometer, inductive, or Hall effect)
- DC motor control

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Injection Systems

Fuel injection systems carefully meter the amount and timing of fuel to each cylinder. Fully integrated multi-point (MPI) gasoline engine management systems remain by far the most popular solution. However, the gasoline direct injection (GDI) system has the strongest growth rate.

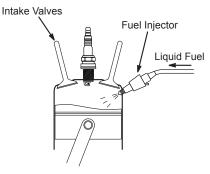


Multi-point Indirect Injection

Gasoline engines are typically equipped with indirect injection systems. They may be single point (SPI) where the fuel is injected in the throttle housing; or multi point (MPI) where each cylinder has its own injector in the inlet manifold.

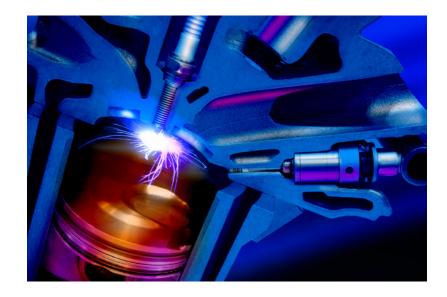
Direct Injection

Many diesel engines feature direct injection (DI) technology. The injector nozzle is placed inside the combustion chamber itself. The gasoline direct injection engine (GDI) utilizes this system as



Direct Injection

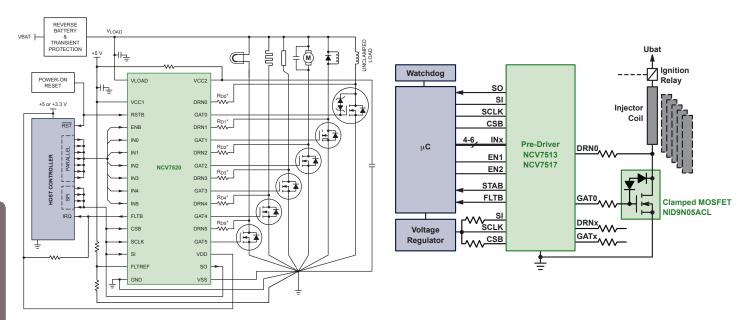
well, since it gives a better volumetric efficiency as only air is drawn in through the induction system, increasing the amount of air induced and minimizing fuel losses. The injector also features several spray modes, so the fuel is better distributed and a powerful air-fuel mixture is created. The injector actuator is implemented as a solenoid or a piezo based solution. With piezo technology, fuel can be more precisely dosed when injected into an engine's combustion chamber, considerably reducing fuel consumption and exhaust emissions.



Solutions for Injection Systems

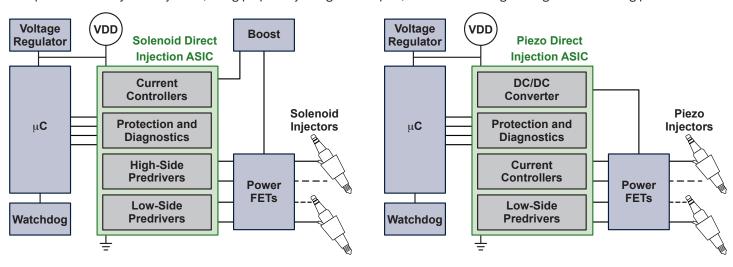
Multi-Point Indirect Injection

The FLEXMOS™ family from ON Semiconductor offers application specific scalability through the choice of external MOSFETs. These low-side pre-drivers are programmable six channel products for driving logic-level MOSFETs. The devices are controllable by a combination of serial SPI and parallel inputs. They feature programmable fault management modes and allow power-limiting PWM operation with programmable refresh time. Each channel independently monitors its external MOSFET's drain voltage for fault conditions. Shorted load fault detection thresholds are fully programmable. Fault information for each channel is encoded by fault type and is available through SPI communication.



Direct Injection

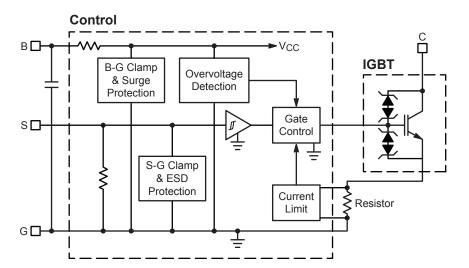
Engine management systems - in particular, injection functions - are subject to extensive qualification cycles, due to the harsh operating conditions of wide temperature and voltage ranges, and switching of inductive and capacitive loads. ON Semiconductor has developed multiple drivers for injection systems, using proprietary design techniques, combined with high-voltage manufacturing processes.



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Igniters for Ignition Systems

Provides the power electronic circuit to energize an ignition coil for creating a spark across the spark plug.



Features

- Overcurrent protection
- · Overvoltage shutdown
- B input resistor & B-G clamp
- B-G capacitor (filter)
- Clamp voltages 350 600 V
- Output current 8 20 A

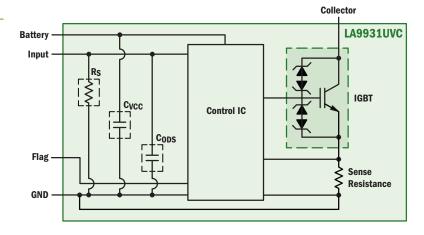
Igniter Module Requirements

- Compact space constraint in coil head
- Highly robust and reliable life time > 15 years, under hood

LA9931UVC Igniter Module

Features

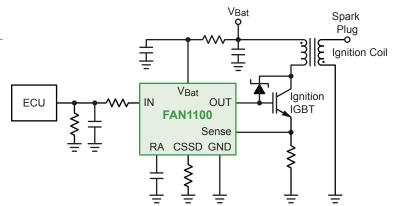
- Complete solution for coil-on-plug applications
- Integrates control circuit, IGBT, passives
- 400 V clamp voltage; 12 A IGBT collector current
- 250 mJ IGBT collector-emitter avalanche energy
- ESD, EMC, ISO pulse: ISO7637-2
- SIP-5J package



Ignition IGBTs

Features

- Stand alone Ignition IGBTs with integrated collector gate clamp and ESD protection
- Wide product portfolio including customized die/ wafer solutions
- Smart Ignition solutions including
 - Current sense IGBT
 - Integrated control IC
 - Stand alone Ignition control IC
 - Fully integrated Igniter custom solutions

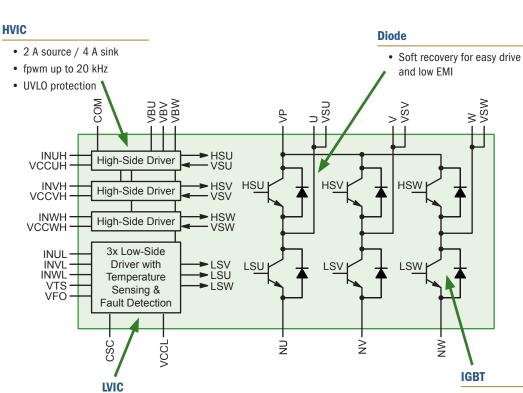


Device	Clamp Voltage (V)	SCIS Energy (mJ)	lc @ 25°C	VCE(sat) @ 25°C Max	Package
FGBS3040E1-F085*	400	300	16.5 A	1.60 V	T0-263-7
FGB3040CS**	400	300	21 A @ 4 V	1.60 V @ 6 A	T0-263-6
FGB3056-F085	560	300	29 A @ 5 V	1.60 V @ 8 A	T0-263
FGD3050G2	500	300	32 A @ 5 V	1.20 V @ 6 A	T0-252
FGB3245G2-F085	450	320	26 A @ 4 V	1.25 V @ 6 A	T0-263
FGD3245G2-F085	450	320	26 A @ 4 V	1.25 V @ 6 A	T0-263
ISL9V5045S3ST-F085	450	500	51 A @ 4 V	1.60 V @ 10 A	T0-263
FGB3440G2-F085	400	335	27 A @ 4 V	1.20 V @ 6 A	T0-263
FGD3440G2-F085	400	335	27 A @ 4 V	1.20 V @ 6 A	T0-252
FGP3440G2-F085	400	335	27 A @ 4 V	1.20 V @ 6 A	T0-220
FGB3040G2-F085	400	330	41 A @ 5 V	1.25 V @ 6 A	T0-263
FGD3040G2-F085	400	330	41 A @ 5 V	1.25 V @ 6 A	T0-252
FGI3040G2-F085	400	330	41 A @ 5 V	1.25 V @ 6 A	T0-252
FGP3040G2-F085	400	330	41 A @ 5 V	1.25 V @ 6 A	T0-220
ISL9V3040P3	400	300	21 A @ 4 V	1.60 V @ 6 A	TO-220
ISL9V3040S3ST	400	300	21 A @ 4 V	1.60 V @ 6 A	T0-263
ISL9V3040D3ST	400	300	21 A @ 4 V	1.60 V @ 6 A	T0-252
ISL9V2040S3ST	400	200	10 A @ 4 V	1.90 V @ 6 A	T0-263
ISL9V2040D3ST	400	200	10 A @ 4 V	1.90 V @ 6 A	TO-252
ISL9V2540S3ST	400	250	15 A @ 4 V	1.90 V @ 6 A	T0-263
FGD2736G3-F085	360	270	21 A @ 5 V	1.35 V @ 6 A	TO-252
FGB3236-F085	360	320	44 A @ 4 V	1.40 V @ 6 A	T0-263
FGI3236-F085	360	320	44 A @ 4 V	1.40 V @ 6 A	T0-263
ISL9V5036S3ST	360	500	46 A @ 4 V	1.60 V @ 10 A	T0-263
ISL9V5036S3	360	500	46 A @ 4 V	1.60 V @ 10 A	T0-262
ISL9V5036P3-F085	360	500	46 A @ 4 V	1.60 V @ 10 A	T0-220
ISL9V3036S3ST	360	300	21 A @ 4 V	1.60 V @ 6 A	T0-263
FGD3325G2-F085	250	330	41 A @ 5 V	1.25 V @ 6 A	T0-252

^{*} Current sense; max dwell; soft shut-down. ** Current sense.

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High Voltage Power Modules



Features

- Ultra low Rth (<0.34°C/W) via outstanding substrate DBC
- Guaranteed Tj = 175°C
- Outstanding ruggedness via SCWT is over 5 µs @ worst case
- Reduced design cycle & assembly process as IPM fully optimized for stable EMI & thermal performance

- 2 A source / 4 A sink
- fpwm up to 20 kHz
- Protection UVLO, OCP, TSU Fault out
- Thermal Sensing 0°C~150°C via Vts

- Low conduction and switching losses
- Optimized switching dv/dt for motor control
- · Short circuit rated

		BV	Current Rating @ 100°C		R _{th(j-c)} Max		
Device	Series	(V)	(A)	Gate Driver	(°C/W)	Substrate	Package
NFVA25012NP2T*	ASPM34	1200	50	Integrated	0.4	AIN	SPM-34
NFVA23512NP2T*	ASPM34	1200	35	Integrated	0.73	Al^2O^3	SPM-34
NFVA22512NP2T*	ASPM34	1200	25	Integrated	0.81	Al^2O^3	SPM-34
NFVA35065L32	ASPM27	650	50	Integrated	0.34	AIN	SPM-27
NFVA34065L32*	ASPM27	650	40	Integrated	1.19	Al^2O^3	SPM-27
NFVA33065L32*	ASPM27	650	30	Integrated	1.4	Al^2O^3	SPM-27

^{*} Pending 4Q18.





SPM-27

SPM-34

Charge Pumps for Power Supplies

Charge Pump Regulators are flexible devices providing buck, boost or buck/boost conversion. The main advantage of using charge pump architectures is an inductor is not required, reducing application cost and design effort compared to SMPS converters utilizing an inductor. Charge pumps are suitable for applications where am LDO dissipates too much power or boost (or buck/boost) operation is mandatory.

Main Features of Automotive Charge Pumps Small components count and PCB area

- · No inductor needed
- · Works with ceramic capacitors

Variable topology

- · Buck or Pass mode (LDO)
- Boost
- Buck/Boost

Efficiency

Twice as efficient compared to LDO solution

CFLY

C+ CVout
VDD

CHOCK
VOUT

VOUT

CHOCK
VOUT

CH

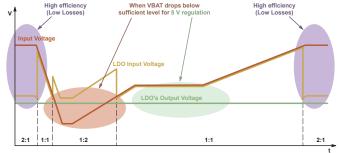


The NCV48xxx charge pump portfolio includes buck, boost, and buck/boost architectures with various output current and features. Compared to charge pumps on market, specific feature of used architectures is access to charge pump output allowing its voltage limitation during battery voltage transients (e.g. Load Dump). This feature enables placing lower voltage rating bulk capacitor at the charge pump output, and reduces overall application cost. Current limitation function inrush current charging reduces the bulk capacitor size as well.

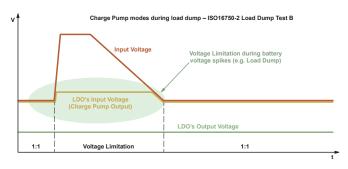
Additional features such as Reset Output (RO) and Charge Pump Active Output (CA, optional feature) are available for communication with MCU.

Comparison of Battery Connected LDO. Charge Pump and SMPS

Converter Type	Efficiency	Output Current	Inductor	Buck (or LDO)	Boost	Buck/ Boost
LD0	Low	Low		✓		
Charge Pump	Middle	Middle		✓	✓	1
SMPS	High	High	✓	✓	1	✓



Buck, Boost and Pass (LDO) Operation Modes



Charge Pump Output Voltage Limitation during Load Dump

Battery Connected Charge Pump

Device	Buck	Boost	Pass Mode LDO	Output Current in Buck Mode	Output Current in Boost Mode	Output Current in Pass Mode	Fsw	Output Voltage	Tolerance	Sleepmode Current (Max)	Quiescent Current (Max) @ Low Load (Load)	Enable	Reset	Charge Pump Active Output	Peak Transient (V)	Package
NCV48220		1	✓		Up to 150 mA	Up to 150 mA	450 kHz	5 V	±2%	1 μΑ	40 μA (100 μA)	√	1		45	SO-8

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Switch Mode Power Supplies (SMPS)

Boost SMPS

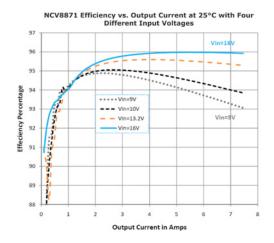
- · Standard Regulators
- Standard Controllers

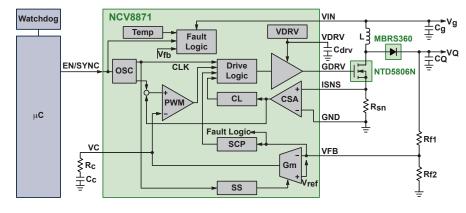
Buck SMPS

- · Standard Regulators
- · Low Iq Regulators
- Multi-Megahertz Regulators
- · Standard Controllers
- Low Iq Controllers

Boost SMPS

The NCV887x and NCV89803x portfolio of adjustable output, non-synchronous boost controllers drive an external N-channel MOSFET. The devices use peak current mode control with internal slope compensation. These boost products incorporate an internal regulator that supplies charge to the gate driver. Designed for powertrain, start-stop, and display applications, the devices can be configured as a SEPIC converter to regulate the car battery voltage, which can vary from 4.5-18 V to a regulated output of 6 V in an engine ECU. Any boost controller can also be configured as a boost converter, to boost the battery voltage from 4.5-18 V to an output voltage of 55-65 V, to power the injectors of direct gasoline injection systems.

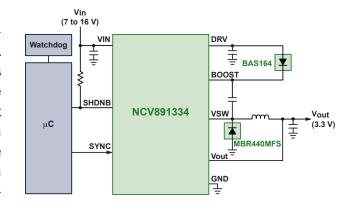




Buck SMPS

ON Semiconductor is developing high efficiency, high frequency switch mode power supplies that can withstand automotive load transients up to 45 V. The high switching frequencies enable the devices to provide the entire buck solution in a very small foot print, by meeting the stringent EMC/EMI performance required in powertrain applications. The SMPS buck regulator portfolio has expanded for 2 MHz operation with high output current capability (up to 3A for regulators and much more for controllers).

The NCV891x34 is a dual mode regulator intended for battery-connected applications that must operate up to a 45 V input supply. Hybrid Low Power Mode allows the NCV891x34 to operate either as a PWM buck converter, or as a low drop-out linear regulator, and the NCV891x34 is suitable for systems with low noise and low quiescent current requirements, often encountered in automotive driver information systems. In addition to synchronization and protection features, the high switching frequency produces low output voltage ripple, even when using small inductor values and an all-ceramic output filter capacitor — forming a space-efficient switching regulator solution.

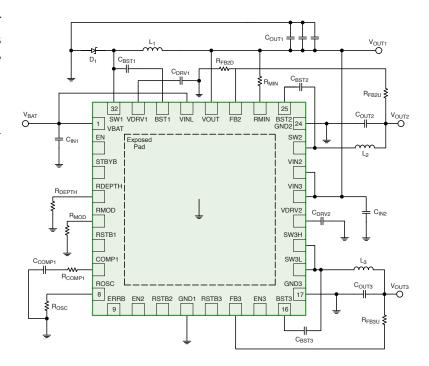


Battery-Connected SMPS Power Management Units (PMUs)

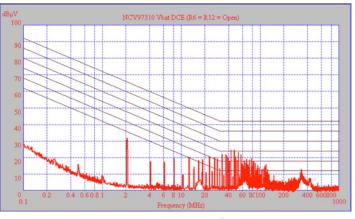
The NCV9731x is a high-frequency multi-output regulator consisting of one battery-connected non-synchronous buck regulator with a user-selected low-lq linear standby mode, and two low-voltage synchronous buck regulators.

Features

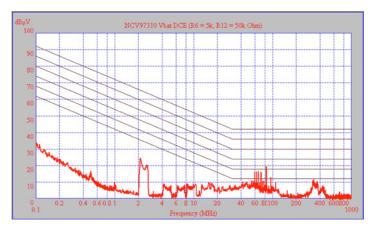
- 2 MHz switching frequency
- Operation down to 4.1 V input
- Withstands 45 V load dump
- Downstream buck regulators adjustable from 1.2 V to 3.3 V
- 3 independent reset pins
- -40 °C to 150°C operation



Device	Туре	I _q Max (V)	Outputs	Primary Output (V)	Spread Spectrum	OVSD Threshold Max (A)	Package(s)
NCV97310	Switching	25	3	3.3 or 5.0	Yes	36	QFN-32 EP
NCV97311	Switching	25	3	3.3 or 5.0	Yes	40	QFN-32 EP







Emissions with Spread Spectrum

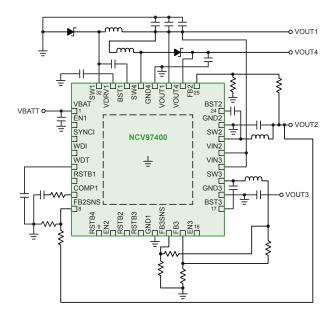
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Battery-Connected SMPS Power Management Units (PMUs)

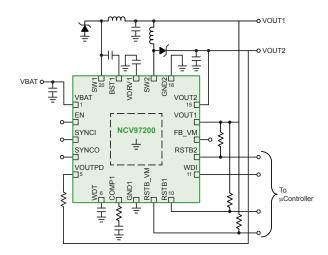
The NCV97400 is a synchronous 4-output monolithic regulator consisting of 3 buck regulators and 1 boost regulator, with supervisory functions including window voltage monitoring on all outputs and a window watchdog. This device is ideal for ADAS (Advanced Driver Assistance Systems) applications, and utilizes an independent voltage reference and an adjustable independent oscillator to realize the supervisory features.

Features

- 4 outputs
 - 3.3 V primary buck which delivers up to 3 A
 - 5 V boost to supply, for example, IVN circuits
 - 2 adjustable secondary bucks (0.8 V .. 3.3 V) which deliver up to 2 A
- 3 Enabled Buck Converters
- · Voltage monitoring
- Wide input of 4.1 to 40 V with Undervoltage Lockout (UVLO)
- 2 MHz operation with spread spectrum capability
- Window Watchdog with independent references
- IS026262 ready



The NCV97200 is a synchronous 2-output monolithic regulator consisting of 1 buck regulator and 1 boost regulator, with supervisory functions including window voltage monitoring on all outputs and a window watchdog. This device is ideal for ADAS (Advanced Driver Assistance Systems) applications and utilizes an independent voltage reference and an adjustable independent oscillator to realize the supervisory features.



Features

- 3.3 V primary buck which delivers up to 3 A
- 5 V boost to supply, for example, IVN circuits
- 1 Boost Converter for IVN supply
- Wide input of 4.1 to 40 V with Undervoltage Lockout (UVLO)
- 2 MHz operation with spread spectrum capability
- Window Watchdog with independent references
- ISO26262 ready

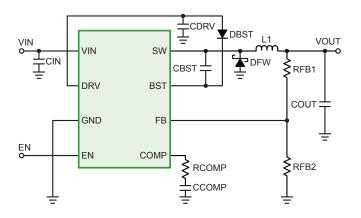
Battery-Connected Buck SMPS for Primary Power Conversion

The 2 MHz NCV890xxx and NCV891xxx portfolio removes the need for EMI countermeasures and reduces the number of required external components in automotive power supplies. The devices achieve output as low as 3.3 V from an 18 V input, without pulse skipping. A wide range of output currents and features is available.

Features

- Maximum DC current from 0.6 A to 3 A
- Load dump capability: 40 V and 45 V versions
- Synchronization input: use an external clock or synchronization output in order to override internal switching frequency
- Synchronization output: allows the synchronization of another power supply or other device
- Power Good: Open drain output; high when output voltage is above power good threshold
- Reset: Open drain output; high when output voltage is above reset threshold, and has a programmable delay
- Spread spectrum: Internally generated spread spectrum, with both the modulation frequency and modulation depth externally programmable
- Low Iq: some versions have low Iq in light load conditions
- Standard features: Under-voltage lock-out, frequency fold back, peak current limit, thermal shut down, and low Iq sleep mode

Device	DC Current Max (A)	Sync	Load Dump (V)	l զ (μΑ)	Package(s)
NCV891330	3.0	Yes	45	30	SOIC-8
NCV890201	2.0	Yes	40	_	DFN-10
NCV890231	2.0	Yes	45	_	DFN-10
NCV890131	1.2	Yes	45	_	DFN-10
NCV890130	1.2	No	45	_	DFN-8
NCV890101	1.2	Yes	40	_	DFN-10
NCV891130	1.2	No	45	30	SOIC-8
NCV890100	1.2	No	40	-	DFN-8, SOIC-8 EP
NCV890430	0.6	Yes	45	-	DFN-8





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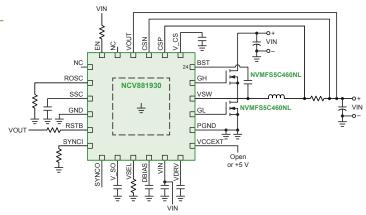
Battery-Connected Low Iq Buck SMPS Controllers

The NCV891930 is a 2 MHz fixed–frequency low quiescent current buck controller with spread spectrum that operates up to 38 V (typical). The NCV891930 is capable of converting from an automotive input voltage range of 3.5 V (4.5 V during startup) to 18 V at a constant base switching frequency, eliminating the need for costly filters and EMI countermeasures. Several protection features such as UVLO, current limit, short circuit protection, and thermal shutdown are provided.

High switching frequency produces low output voltage ripple even when using small inductor values and an all-ceramic output filter capacitor, forming a space-efficient switching solution.

Features

- Fixed output: 3.3, 3.65, 4.0 or 5.0 V
- 30 µA operating current at no load
- 75 mV current limit sensing
- Wide input of 3.5 to 38 V with Over- and Undervoltage Lockout
- Input and output synchronization
- 2 MHz operation with spread spectrum capability
- Adaptive non-overlap circuitry
- Short Circuit Protection; Thermal Shutdown

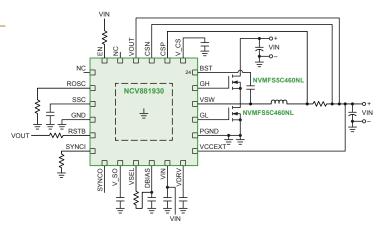


3.3 V Application Schematic Example

The NCV881930 is a 410 kHz fixed-frequency low quiescent current buck controller with spread spectrum that operates up to 38 V (typical). The NCV881930 is capable of converting from an automotive input voltage range of 3.5 V (4.5 V during startup) to 18 V at a constant base switching frequency. Several protection features such as UVLO, current limit, short circuit protection, and thermal shutdown are provided.

Features

- Fixed output: 3.3 or 5.0 V
- 30 µA operating current at no load
- 50 mV current limit sensing
- Wide input of 3.5 to 38 V with Over- and Undervoltage Lockout
- Input and output synchronization
- 410 kHz operation with spread spectrum capability
- Adaptive non-overlap circuitry
- · Short Circuit Protection; Thermal Shutdown



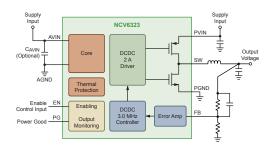
5 V Application Schematic Example

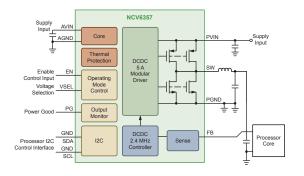
Low Voltage Buck SMPS and PMU for Secondary Power Conversion

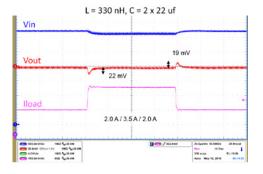
Supplied from a pre-regulated voltage rail, the low voltage buck SMPS and PMU support a wide variety of end applications such as clusters, cameras, radars and other peripherals.

NCV6323, NCV6324 - 2 A PFM/PWM Buck

NCV6323 and NCV6324 are adjustable monolithic synchronous buck converters with integrated power stage. They are able to deliver up to 2 A DC and operate in forced PWM (NCV6323) or in automatic PFM/PWM (NCV6324) for optimized low load efficiency. The devices come in a small DFN package, and the 3 MHz switching frequency allows the use of small size inductors and capacitors. They are therefore ideally suited for space constrained applications.





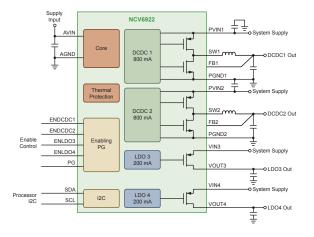


NCV6356, NCV6357 - 5 A AOT Buck

NCV6356 and NCV6357 are programmable monolithic synchronous buck converters with integrated power stage and dynamic voltage scaling support. They are able to deliver up to 3 A DC at 105°C ambient and up to 6 A of peak current. Their adaptive constant-on-time architecture allows for the use of low valued inductors and provides a very fast transient load response (20 mV/1.5 A/500 ns) which makes them ideally suited for high performance applications. The NCV6356 comes with I2C and Interrupt pin; the NCV6357 with I2C and Power Good pin.

NCV6922 - PMU 2 Buck 2 LD0

The NCV6922 is a low voltage PMU including 2 buck converters of 800 mA and 2 low dropout, low noise regulators of 200 mA. The device is fully programmable through I2C and also through factory programming. Virtually any power up sequence and output voltage combination can be created. The NCV6922 is ideally suited for surround and rearview camera designs in conjunction with ON Semiconductor image sensors.



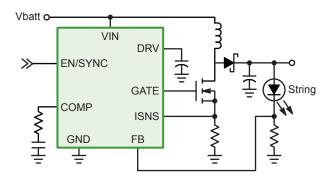
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Boost/Flyback/SEPIC SMPS Controllers

The highly flexible NCV8871, NCV8873, and NCV89803x controllers provide compact, easy to use, cost effective lighting solutions for boost, flyback, and SEPIC topologies. The devices operate over a wide input battery voltage range (3.2 V to 45 V), and feature a low shutdown current of under $10 \, \mu A$.

The NCV8871 and NCV8873 devices have factory programmable switching frequencies from 170 kHz to 1 MHz. The NCV8873 feedback voltage is set to 0.2 V in order to better fit applications where constant current regulation is desired, such as LED drivers. The NCV89803x has a set switching frequency of 2 MHz, which permits the use of smaller filter components for a lower cost system solution.

These devices provide integrated current limit, thermal shutdown, and under-voltage lockout, and are rated from -40°C to 150°C junction temperature.



NCV8871xx Backlighting PWM Deep Dimming Application - Minimal External Components

Additional performance combinations available with rapid prototyping. Factory programmable features:

- Fsw: 170 kHz to 1 MHz for NCV887x;
 170 kHz to 2 MHz for NCV89803x
- Minimum on-time
- Max duty cycle
- Slope compensation
- Current limit
- · Gate drive voltage
- · Gate drive strength

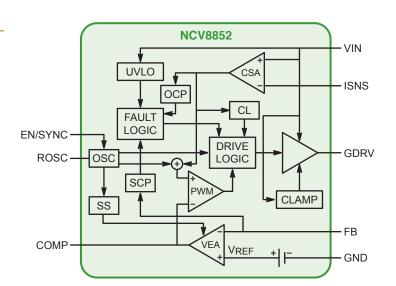


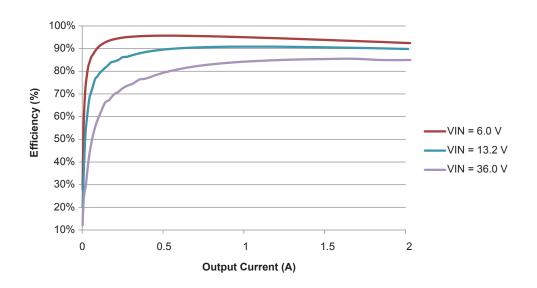
Low Dropout Buck SMPS for System Supply

NCV8852 and NCV8853 adjustable-output non-synchronous buck controllers drive an external P-channel MOSFET. The devices use peak current mode control with internal slope compensation, and incorporate an internal regulator that supplies charge to the gate driver.

Features

- Ultra low Iq sleep mode
- Adjustable output with 800 mV ±2% reference voltage
- Wide input of 3.1 to 44 V
- Internal Soft-Start
- Undervoltage lockout
- External frequency synchronization
- 100% max duty cycle
- Programmable cycle-by-cycle current limit
- Hiccup overcurrent protection
- · Hiccup short circuit protection





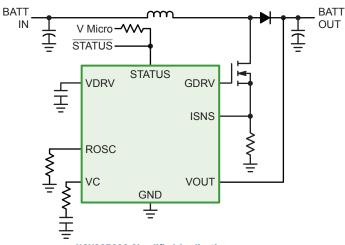
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Pre-Boost Controllers for Low Battery Conditions

The NCV887xxx portfolio comprises a Non-Synchronous Pre-Boost controller family designed to supply a minimum output voltage during Start-Stop vehicle operation and other battery voltage sags. The controllers drive an external N-channel MOSFET.

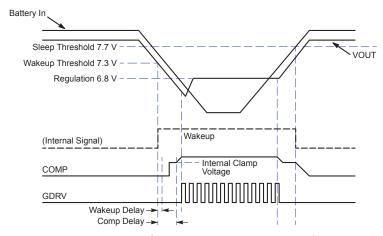
Features

- Wide Input Voltage Range of 2 V to 40 V, 45 V Load Dump
- Automatic Enable Below Wake Up Threshold Voltage (Factory Programmable)
- Factory programmable frequency options or frequency adjust resistor option
- Boost Mode Operation at Regulation Set Point
- 2% Output Accuracy Over Temperature Range
- Peak Current Mode Control with Internal Slope Compensation
- Low Quiescent Current in Sleep Mode (<12 μA Typical)



NCV887600 Simplified Application

Device	V _{out} (V)	Frequency (kHz)	Slope Compensation (mV/μs)	Current Limit (mV)	Osc Frequency Adjust	Status Pin	Disable Pin	Package(s)
NCV887600	6.8	170	34	400	✓	1		SOIC-8
NCV887601	6.8	170	53	200	1	1		SOIC-8
NCV887700	6.8	170	34	400	1		1	SOIC-8
NCV887701	6.8	170	53	200	1		1	SOIC-8
NCV887720	10	170	53	200	✓		1	SOIC-8
NCV887740	12	170	53	200	1		1	SOIC-8
NCV887801	6.8	450	53	200		1	1	SOIC-8



Typical Output Waveforms Through Battery Cranking Profile

Current Sense LDO and High Side Switch Applications

Current sense LDO linear voltage regulators and High Side Switches (HSS) provide precise current limiting, which can be adjusted for particular application requirements. These devices provide diagnostic information to control MCUs, either as analog or digital outputs, enabling the MCU to implement required steps (e.g., switch off the LDO or HSS with overloaded or unloaded output, or short to battery). Both current sense and diagnostic features are particularly useful for off-the-module loads, when it is necessary to know the status of an external load and take appropriate actions. Typical applications are: active antenna, camera module and microphone. Current sense LDOs and HSS also provide reverse battery, reverse bias, short-to-battery, short-to-ground, and thermal shutdown protection features.



The current limit of the device is adjustable by a resistor connected to CSO pin. The current flowing out of CSO pin is proportional to the output current, and its guaranteed ratio and precision is shown in the table Current Sense Regulators/Switches. This information can be processed by ADC converter of MCU. Error Flag is open collector output and it provides digital signal to MCU indicating open load, overcurrent, short to ground or short to battery information, and it can be processed by digital input of MCU.

The NCV47xx0 and NCV47xx1 product families are Current Sense LDOs with analog or analog/digital diagnostics. These are primarily used for supplying active antennae or microphones.

The NCV47xx2 product families are Current Sense HSS parts with analog and digital diagnostics. These are primarily used for supplying out of module loads (e.g. camera module).

The NCV47xx3 product families are Current Sense HSS/Constant Current parts with analog and digital diagnostics. These parts have enhanced

NCV47xy0/47xy1 Active Antenna VBAT LDO EN LDO EN Current Limit & Diagnostics DIAG CTRI Main uC ADC DIAG CTRL NCV47xy2 VBAT1 Module HSS HSS EN HSS EN Main μC DIAG CTRL DIAG_CTRL NCV47xv3 Camera Module or LED VRATI HSS/Constar Current Ī HSS EN HSS_EN DIAG CTRL DIAG CTRI

current limitation features eliminating input inrush current and very low reverse bias currents, and are primarily used for supplying out of module loads (e.g. camera module) or constant current loads (e.g. LEDs). Only RCSO is required for current limitation.

Current Sense Regulators/Switches

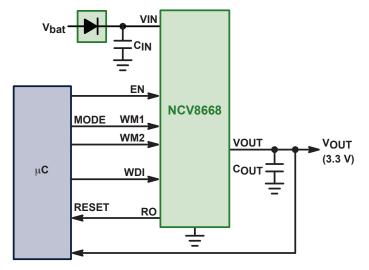
Device	Output Current (mA)	Output Voltage (V)	Dropout Max (mV)	Sleepmode Current Max (µA)	Quiescent Current (Max) @ Low Load (Load)	Current Mirror Precision	Current Mirror Ratio	Error Flag	Package(s)
NCV47551	20	Adj	500	10	380 μΑ (100 μΑ)	±10%	1:1		S0IC-8
NCV47411	2x 100	Dual Adj	550	10	370 μΑ (500 μΑ)	±10%	50:1		TSSOP-14 EP
NCV47721	200	Adj	500	10	1 mA (500 μA)	±5%	100:1	/	TSSOP-14 EP
NCV47821	2x 200	Dual Adj	500	10	1 mA (500 μA)	±5%	100:1	/	TSSOP-14 EP
NCV47722	250	High Side Switch	400	10	1.3 mA (500 μA)	±5%	300:1	1	TSSOP-14 EP
NCV47822	2x 250	Dual High Side Switch	400	10	1.5 mA (500 μA)	±5%	300:1	1	TSSOP-14 EP
NCV47823	2x 250	Dual HSS/Constant Current	400	20	1.5 mA (500 μA)	±5%	300:1	/	TSSOP-14 EP
NCV47700/10/01/11	350	Adj	500	10	230 μA (1 mA)	±10%	100:1		SOIC-8, SOIC-8 EP

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Watchdog and Tracking LDOs for Power Supplies

Watchdog LDOs

Watchdog LDOs from ON Semiconductor deliver 150 to 250 mA load current, and provide supervision of an external single sided or window watchdog, for mircocontroller-based automotive applications. The portfolio provides integrated protection features, such as peak transients, current limit, thermal shutdown, and in most cases allows -40°C to 150°C operating junction temperature.

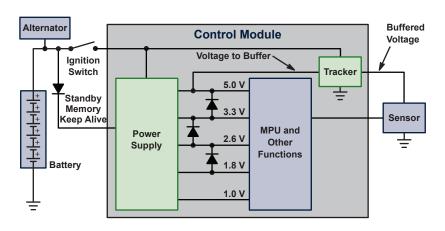


The NCV8518B 250 mA LDO voltage regulator incorporates a watchdog feature which continuously monitors the WDI input from the microprocessor in order to determine the output state.

The NCV8668 and NCV8768 are 150 mA LDO regulators that feature low typical Iq of 38 μ A and 31 μ A respectively during sleep mode, and include window watchdog functionality.

Tracking LDOs

Engine controllers must provide fully regulated, buffered power supply rails to power external sensors. Also known as tracking regulators, these devices must be fully protected from external faults, such as short to GND, short to battery, and reverse battery; and should still provide regulated output with very close tracking of the reference voltage. ON Semiconductor offers a wide range of single and dual tracking regulators — including CS8182, CS8361, NCV8184, and NCV4250-2C — with various output current and package options for automotive engine controller applications.



Buffering Voltage to Send it Outside of a Module to a Sensor

Wide Selection of Automotive Qualified Linear Regulators

Post Regulation Linear Regulators

Device	Output Current	Output Voltage (V)	Dropout Max	Sleepmode Current Max (µA)	Quiescent Current (Max) @ Low Load (Load)	Tolerance (%)	Enable	Package(s)
NCV8715	50 mA	1.2, 1.5, 1.8, 2.5, 3.0, 3.3, 5.0	260 mV	_	4.7 μΑ	±2		XDFN-6
NCV8716	80 mA	1.5, 1.8, 2.5, 3.0, 3.3, 5.0	400 mV	_	4.7 μΑ	±2		WDFN-6
NCV662	100 mA	1.5, 1.8, 2.5, 2.7, 2.8, 3.0, 3.3, 5	300 mV	1	6 μA (1 mA)	±4	~	SC-82
NCV663	100 mA	1.5, 1.8, 2.5, 2.7, 2.8, 3.0, 3.3, 5	300 mV	_	6 μA (1 mA)	±4		SC-82
NCV78LxxA	100 mA	5, 8, 12, 15, 24	1.7 V (Typ)	-	_	±4		S0IC-8, T0-92
NCV551	150 mA	1.4, 1.5, 1.8, 2.5, 2.7, 2.8, 3.0, 3.1, 3.2, 3.3, 5	220 mV	1	8 μA (1 mA)	±3	V	TSOP-5
NCV571	150 mA	0.8, 0.9, 1.0, 1.2	450 mV	1	8 μA (150 mA)	±4	V	TSOP-5, DFN-6
NCV8560	150 mA	Adj., 1.3, 1.5, 1.8, 2.5, 2.8, 3.0, 3.3, 3.5, 5	125 mV	1	180 μA (150 mA)	±2	V	DFN-6, TSOP-5
NCV8152	150 mA	1.8/2.8, 2.8/1.8, 3.0/1.8, 3.3/1.8	140 mV	1	50 μΑ (100 μΑ)	±3	V	XDFN-6
NCV8170	150 mA	1.2, 1.5, 1.8, 2.5, 2.8, 3.0, 3.1, 3.3,	350 mV	1	50 μΑ (90 μΑ)	±2	V	XDFN-4, SOT-563
NCV8702	200 mA	1.8, 2.8, 3.0, 3.3	140 mV	1	60 μA (1 mA)	±2	V	DFN-6, TSOP-5
NCV8570B	200 mA	1.8, 2.5, 2.8, 3.0, 3.3	155 mV	1	75 μA (1 mA)	±2	V	DFN-6, TSOP-5
NCV8752	200 mA	1.8, 2.8, 3.0, 3.3	140 mV	1	12 μΑ	±2	V	XDFN-6, TSOP-6
NCV8160	250 mA	1.8, 2.5, 2.8, 2.9, 3.0, 3.3	90 mV	1	18 μΑ	±2	V	XDFN-4
NCV8163	250 mA	1.2, 1.5, 1.8, 2.1, 2.5, 2.8, 3.0, 3.3	80 mV	1	12 μΑ	±2	~	XDFN-2
NCV8703	300 mA	1.8, 2.8, 3.0, 3.3	180 mV	1	60 μA (1 mA)	±2	V	DFN-6, TSOP-5
NCV8114	300 mA	1.2, 1.5, 1.8, 2.5, 2.8, 3.0, 3.3	135 mV	1	55 µА (95 µА)	±2	V	TSOP-5
NCV8154	300 mA	3.0/3.0, 3.3/1.8, 1.8/2.8, 3.3/3.3	140 mV	1	55 μΑ (100 μΑ)	±3	V	DFN-10
NCV8718	300 mA	Adj.	300 mV	1	4 μΑ	±2	V	WDFN-6
NCV8130	300 mA	0.8, 1.0, 1.1, 1.2, 1.3, 1.5, 1.8	150 mV	1	Αμ 08	±1.5	V	XDFN-6
NCV8720	350 mA	1.0, 1.05, 1.10, 1.15, 1.2, 1.25, 1.3, 1.4, 1.45	110 mV	1	_	±2	V	WDFN-6
NCV8161	450 mA	1.8, 2.5, 2.8, 2.9, 3.0, 3.3	225 mV	1	18 μΑ	±2	V	XDFN-4
NCV78MxxA	500 mA	5	**	-	**	±4		DPAK-3
NCV5501	500 mA	1.5, 3.3, 5	700 mV	-	500 μΑ (100 μΑ)	±4.9		DPAK-3
NCV5500	500 mA	Adj, 1.5, 3.3, 5	700 mV	50	500 μΑ (100 μΑ)	±4.9	V	SOIC-8, DPAK-5
NCV8133	500 mA	0.8, 1.0, 1.1, 1.2, 1.3, 1.5, 1.8	140 mV	1	80 μΑ	±1.5	V	XDFN-6
NCV8535	500 mA	Adj, 1.5, 1.8, 2.5, 2.8, 2.85, 3.0, 3.3, 5	340 mV	1	190 μΑ (100 μΑ)	±1.5	~	DFN-10
NCV8537	500 mA	Adj, 1.8, 2.5, 3.3, 5.0	340 mV	1	190 μΑ (100 μΑ)	±1.5	~	DFN-10
NCV8177	500 mA	0.75, 1.2, 1.5, 1.8, 2.5, 3.3,	200 mV	_	60 μΑ (90 μΑ)	±2	~	XDFN-4
NCV33269	800 mA	Adj, 3.3, 5, 12	1.35 V	-	-	±2		DPAK-3
NCV78xxA	1 A	5, 12	**	-	-	±4		D2PAK-3, T0-220
NCV8186	1 A	1.2, 1.75, 1.8, 1.85, 2.5, 2.8, 3.3, 3.5, 3.9	100 mV	-	90 μΑ (140 μΑ)	±1	V	XDFN-8
NCV1117	1 A	Adj, 1.5, 1.8, 2, 2.5, 3.3, 5, 12	1.2 V	-	_	±2		DPAK-3, SOT-223
NCV5661	1 A	Adj, 1.2, 1.5, 1.8, 2.5, 2.8, 3.0, 3.3	1.3 V	300	-	±2	V	DPAK-5, DFN-6
NCV59152	1.5 A	Adj, 1.8, 2.5, 2.8, 3.0, 3.3, 5.0	500 mV	5	-	±1.5	~	DFN-8, D2PAK-3, D2PAK-5
NCV59748	1.5 A	Adj.	60 mV	-	-	±2	~	DFN-10
NCV5662	2 A	Adj, 1.5	1.3 V	300	-	±2	~	D2PAK-5
NCV59744	3 A	Adj.	115 mV	-	-	±2	~	QFN20
NCV59302	3 A	Adj, 1.8, 2.5, 2.8, 3.0, 3.3, 5.0	500 mV	5	-	±2	~	D2PAK-5
NCV5663	3 A	Adj, 1.5	1.3 V	300	_	±2	V	D2PAK-5

^{**} See data sheet for details.

Tracking Regulators

Device	Output Voltage (V)	Tolerance	Output Current (mA)	Dropout Max (V)	Sleepmode Current Max (µA)	Quiescent Current (Max) @ Low Load (Load)	Enable	Reset	Dropout (Max)	Package(s)
NCV4250-2C	Tracking	±5 mV	50	0.3	20	150 μA (1 mA)	~		45	TSOP-5
NCV8184	Tracking	±3 mV	70	0.6	20	70 μΑ (100 μΑ)	~		45	SOIC-8, SOIC-8 EP, DPAK-5
CS8182	Tracking	±10 mV	200	0.6	55	150 μΑ (100 μΑ)	~		45	DPAK-5, D2PAK-5, SOIC-8
CS8361	Tracking 5	±25 mV ±2%	250 100	0.7 0.6	200	200 μΑ (300 μΑ)	~	V	60	D2PAK-7, SOIC-16W

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Wide Selection of Automotive Qualified Linear Regulators

Device	Output Current	Output Voltage (V)	Dropout Max (V)	Sleepmode Current Max (µA)	Quiescent Current (Max) @ Low Load (Load)	Tolerance (%)	Enable	Package(s)
NCV4294C	30 mA	3.3, 5	0.25	_	170 μΑ (100 μΑ)	±4		TSOP-5
NCV4295C	30 mA	3.3, 5	0.25	_	170 μΑ (100 μΑ)	±4		TSOP-5
NCV4296-2C	30 mA	3.3, 5	0.25	1	170 μΑ (100 μΑ)	±4	V	TSOP-5
NCV4949C	100 mA	5	0.5	-	260 μΑ (300 μΑ)	±2		SOIC-8, SOIC-8 EP
NCV2951A	100 mA	Adj, 3.3, 5	0.45	_	120 μΑ (100 μΑ)	±1.5	~	SOIC-8
NCV317L	100 mA	Adj	1.9 (Typ)	_	_	±4		SOIC-8, TO-92
NCV4299C	150 mA	3.3, 5	0.5	1	95 μΑ (100 μΑ)	±2	~	SOIC-8, SOIC-14
NCV4279C	150 mA	5	0.5	-	250 μA (1 mA)	±2		S0IC-14
NCV4269C	150 mA	5	0.5	_	250 μA (1 mA)	±2		SOIC-8, SOIC-8 EP, SOIC-14,TSSOP-14 EP
NCV4266-2C	150 mA	3.3, 5	0.5	1	70 μΑ (100 μΑ)	±2	~	S0T-223
NCV4264-2C	150 mA	3.3, 5	0.5	_	70 μΑ (100 μΑ)	±2		S0T-223
NCV8669	150 mA	5	0.6	-	50 μA (150 mA)	±2		S0IC-14
NCV8668	150 mA	3.3, 5	0.6	1	44 μΑ (100 μΑ)	±2	~	SOIC-8, SOIC-8 EP, SOIC-14
NCV8664C	150 mA	3.3, 5	0.6	-	30 μΑ (100 μΑ)	±2		SOT-223, DPAK-3
NCV8660B	150 mA	3.3, 5	0.6	_	40 μA (150 mA)	±2		DPAK-5, SOIC-8
NCV8502	150 mA	Adj, 2.5, 3.3, 5, 8, 10	0.6	_	75 μΑ (100 μΑ)	±2		SOIC-8, SOIC-16 EP
NCV8501	150 mA	Adj, 2.5, 3.3, 5, 8, 10	0.6	30	75 μΑ (100 μΑ)	±2	~	SOIC-8, SOIC-16 EP
NCV8508B	250 mA	3.3, 5	0.9	_	150 μA (150 mA)	±3		SOIC-8 EP, D2PAK-7
NCV8518B	250 mA	5	0.75	1	150 μA (150 mA)	±2	~	SOIC-8 EP, SOIC-16 EP
NCV8674	350 mA	5	0.6	_	38 μΑ (100 μΑ)	±2		D2PAK-3
NCV8675	350 mA	3.3, 5	0.6	_	50 μΑ (100 μΑ)	±2, ±2.5		DPAK-5, D2PAK-5
NCV8772	350 mA	3.3, 5	0.875	1	30 μA (350 mA)	±1.5	~	D2PAK-7, D2PAK-5, DPAK-5
NCV4274C	400 mA	3.3, 5	0.5	_	250 μA (1 mA)	±2		SOT-223, DPAK-3, D2PAK-3
NCV4276C	400 mA	Adj, 3.3, 5	0.5	10	220 μA (1 mA)	±2	~	DPAK-4, D2PAK-5
NCV8506	400 mA	Adj, 2.5, 3.3, 5	0.6	_	150 μΑ (100 μΑ)	±2		D2PAK-7
NCV8505	400 mA	Adj, 2.5, 3.3, 5	0.6	1	350 μΑ (100 μΑ)	±2	~	D2PAK-7
NCV8504	400 mA	Adj, 2.5, 3.3, 5	0.6	_	150 μΑ (100 μΑ)	±2		SOIC-16 EP
NCV8503	400 mA	Adj, 2.5, 3.3, 5	0.6	1	350 μΑ (100 μΑ)	±2	~	SOIC-16 EP
NCV4275C	450 mA	3.3, 5	0.5	_	200 μA (1 mA)	±2		DPAK-5, D2PAK-5
NCV8141	500 mA	5	1.5	50	**	±3	~	D2PAK-7
NCV317M	500 mA	Adj	2.2 (Typ)	_	_	±4		DPAK-3
NCV33269	800 mA	Adj, 3.3, 5, 12	1.35	-	_	±2		DPAK-3
NCV317	1.5 A	Adj	2.25 (Typ)	_	_	±4	~	D2PAK-3, T0-220

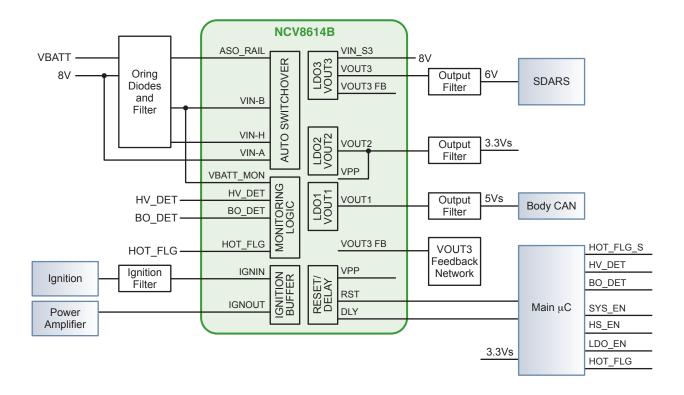
^{**} See data sheet for details.

Chipsets for Audio Power Management

The NCV8614B power management unit is optimized for power supplies - integrating LDOs, SMPSs, high side switches, buffers, and I/Os - delivering solution cost and size reductions.

The NCV8614B multiple output linear regulator with Automatic Switchover (ASO) input voltage selector is specifically designed to address automotive radio systems power supply requirements. The NCV8614B supplies power to various "always on" loads such as the CAN transceivers and microcontrollers (core, memory and I/O). The ASO circuit selects between three different input voltage sources to reduce power dissipation.

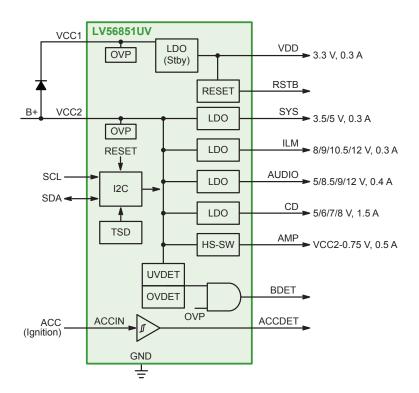
There are possible different output voltages, currents and feature configurations customized for particular applications.



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Multiple Voltage Regulators for Audio Subsystems

The LV56851UV multiple power supply for audio systems incorporates five LDOs and one high-side switch. Integrated accessory detector, battery voltage detector, and reset function reduce system parts count.



LV56851UV Features

- 5 Regulators, 1 VCC high-side switches
- Maximum surge peak voltage 50 V
- Low consumption current
- Battery voltage detector
- · Accessory voltage detector
- · Reset function
- Thermal warning
- Over-current, over-voltage, and overheat protection
- I2C-bus communication interface
 - Output enable/disable
 - · Detector voltage setting
 - Read back
- Low thermal resistance HZIP-15 $(\theta_{ic} = 2.5 \, ^{\circ} \text{C/W})$

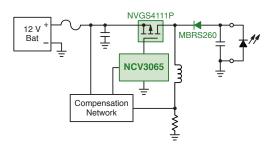
Multiple Output Power Supplies

	Operating Voltage	I _{stby} Max								High Side								
Device	(V)	(μA)	Vstby	REG1	REG2	REG3	REG4	REG5	REG6	(mA)	Package(s)							
LV5680NPVC			5.0 V, 200 mA	8 V, 1.3 A														
LV5681P		800	5.7 V, 200 mA	7 V, 1.3 A	8-9 V (Adj), 300 mA	8-12 V (Adj), 300 mA	_	_	_	350, 300	HZIP-15J							
LV56801P			3.3 V, 200 mA	8 V, 1.3 A														
LV5683P			2.2/F.0.V. 200 mA	5/8 V, 1.1 A	0 F.V. 400 A	-	3.3 V, 500 mA											
LV56831P			3.3/5.0 V, 300 mA	_	8.5 V, 400 mA	12 V, 500 mA	3.3/5 V, 500 mA	_	_	_								
LV5684NPVD			2 2 V 250 mA	5/8 V, 1.3 A	5-12 V (Adj), 250 mA	E 10 V (Adi) 200 mA	3.3 V, 450 mA			350, 300								
LV56841PVD			3.3 V, 350 mA	6 V, 1.5 A	5-12 V (Adj), 300 mA	5-12 V (Adj), 300 mA	3.3 V, 350 mA	_	_	500, 300								
LV5685PV			3.3 V, 350 mA	5/6/7/8 V, 1.3 A	5/8.5/9/11.5 V, 250 mA	5/8/10.5/12 V, 300 mA	3.3/5 V, 450 mA	-	-	350, 300	HZIP-15							
LV56851UV	10 - 16								3.3 V, 300 mA	5/6/7/8 V, 1.5 A	5/8.5/9/12 V, 400 mA	8/9/10.5/12 V, 300 mA	3.3/5 V, 300 mA	_	-	500		
LV5686PVC			100 -	100 -	100	100	100	100	100	100 -	100	5.0 V, 300 mA	-	9.0 V, 500 mA	9.85 V, 300 mA	-	-	-
LV5692P			3.3 V, 300 mA	0 1 1 2 1	0.41/ 500 4	0.41/ 500	2 2 1/ 200 1		Fut FFT Duiver	F00								
LV5693P			5.7 V, 300 mA	8 V, 1.3 A	8.4 V, 500 mA	8.4 V, 500 mA	3.3 V, 300 mA	_	Ext FET Driver	500								
LV5694P			2.2/E.0.V.200 mA	7.6/8.1 V, 2.0 A	0 4E V 900 mA	9.0 V, 500 mA				E00 3E0	HZIP-15J							
LV5695P			3.3/5.0 V, 300 mA	8 V, 2.0 A	8.45 V, 800 mA	8.5 V, 500 mA	_	5 V, 500 mA	_	500, 350								
LV5696P			3.3/5.0 V, 200 mA	8 V, 1.0 A	8.5 V, 300 mA	3-8 V (Adj), 200 mA	3.3 V, 800 mA			200								

Switching Regulators and Controllers

Features

- >2 MHz Switching Frequency
- External Synchronization
- PowerGood & ENABLE
- Wide input voltage range
- Low quiescent current



Switching Regulators

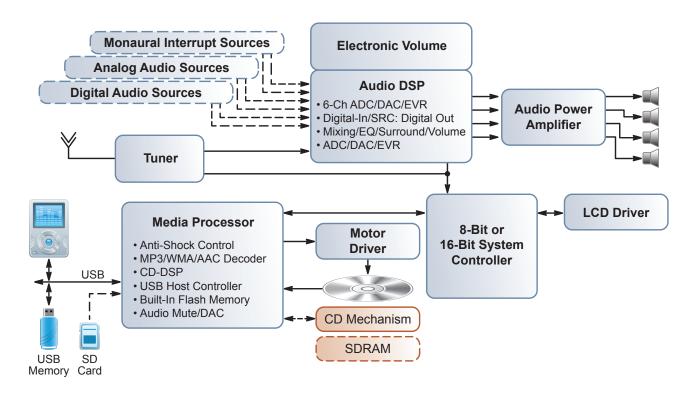
Device	lout (A)	fsw (kHz)	V _{in} Min (V)	V _{in} Max (V)	Comments	Package
NCV2574	0.5	52	4.75	40	Internal compensation	SOIC-16W
NCV2575	1.0	52	4.75	40	Internal compensation	D2PAK
NCV890100	1.2	2000	4.5	40	_	DFN-8
NCV890101	1.2	2000	4.5	40	-	DFN-10
NCV8843	1.5	Up to 700	4	40	V ²	SOIC-8, SOIC-16W, DFN-18
NCV3063	1.5	Up to 250	3	40	High fsw for optimized size & efficiency	DFN-8, SOIC-8, PDIP-8
NCV3064	1.5	Up to 250	3	40	High f _{SW} for optimized size & efficiency; Enable	DFN-8, SOIC-8, PDIP-8
NCV3065	1.5	Up to 250	3	40	LED driver	DFN-8, SOIC-8, PDIP-8
NCV3066	1.5	Up to 250	3	40	LED driver with ENABLE	DFN-8, SOIC-8, PDIP-8
NCV33063	1.5	100	3	40	Buck, Boost SEPIC	SOIC-8
NCV51411	1.5	260	4.5	40	V ² , SYNC	DFN-18, SOIC-16W, SOIC-8
NCV5171	1.5	260	2.7	30	Boost, Flyback, SEPIC	SOIC-8
NCV5173	1.5	560	2.7	30	Boost, Flyback, SEPIC	SOIC-8
NCV3163	3.4	Up to 300	2.5	40	High f _{SW} for optimized size & efficiency	DFN-18, SOIC-16W
NCV33163	3.4	Up to 150	2.5	60	High input voltage	SOIC-16W, PDIP-16

Switching Controllers

Device	V_{OUT} Min (V)	fsw (kHz)	V _{in} Min (V)	V _{in} Max (V)	Comments	Package
NCV494	Down to 5.0	Up to 200	7	40	Single-ended or push-pull	S0IC-16
NCV8851B	Down to 0.8	275	4.5	40	<1 µA quiescent current	SOIC-16W
NCV8852	Down to 0.8	170 to 455	3.1	44	For external P-channel MOSFET	SOIC-8
NCV8853	Down to 0.8	340	3.1	44	For external P-channel MOSFET	SOIC-8
NCV881930	3.3, 5.5	410	3.5	45	Low Iq; low frequency	QFN-24
NCV891930	3.3, 3.65, 4.0, 5.0	2000	3.5	45	Low Iq; high frequency	QFN-24
NCV1034	1.25	Up to 500	10	100	Synchronous Buck	SOIC-16

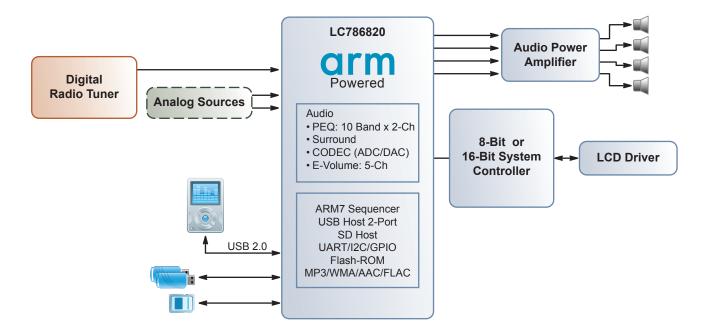
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Audio System Solution





Digital Media Receiver (Mechaless) Audio System Solution





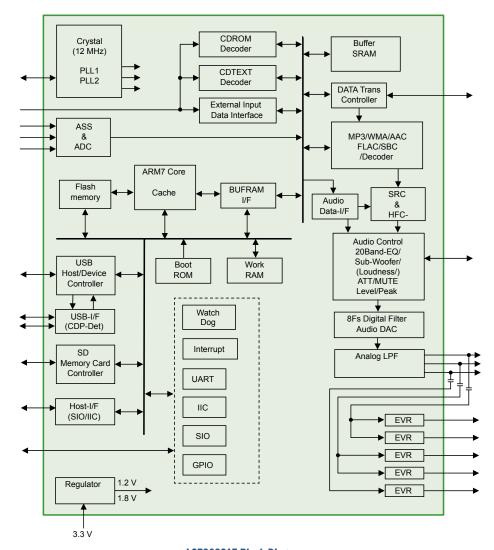
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Digital Media Processor (Mechaless)

Compressed Audio Signal Processor with USB Host Controller and Bluetooth

LC786821E Features

- USB host/device function (Full speed: 12 Mbps), SD memory card host function
- MP3, WMA, AAC, FLAC, SBC decoder processing function
- Audio input: analog stereo 3-channel / digital 3-channel (sampling rate convertible)
- Audio processing: 20 band equalizer (stereo 1-channel), subwoofer processing, high-frequency range extendable filter
- Audio output: electronic volume output 5-channel (for LF, LR, RF, RR, SW), or DAC output 3-channel (Lch, Rch, SW)
- ARM7TDMI-S™ internal CPU core; flash memory for program and data storage
- Bluetooth audio processing/hands-free function

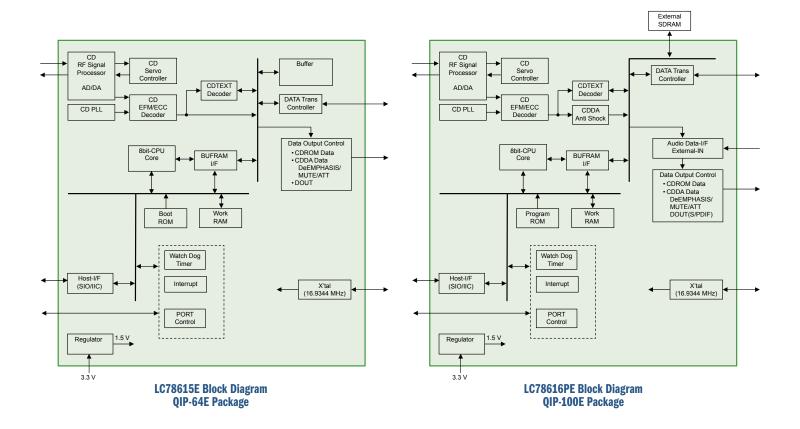


LC786821E Block Diagram

Compact Disc Controllers

LC78615E, LC78616PE Features

- RF signal processing for CD-DA/R/RW, servo control, EFM signal processing
- Outputs CDDA, CDROM data
- CD playback system realized with simple macro commands by external controller, due to internal sequencer (built in 8-bit CPU)
- Reduce audio-DAC, digital filter for reduction system cost
- LC78616PE includes shock protection with external DRAM



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Decoder of DARC Standard for Car Navigation System

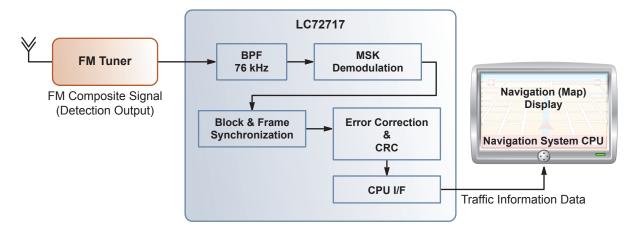
The LC72717 is a data demodulator and decoder for receiving FM multiplex broadcasts for mobile reception in the DARC format. LC72717 includes an on-chip band pass filter for extracting the DARC signal from the FM composite signal. The device also supports ITU-R recommended FM multiplex frame structures (methods A, A', B, and C) and enables design of a compact, multifunction DARC reception system.

LC72717 Features

- Integrates all DARC relevant functions
- · Fully adjustable

Applications

- RTIC in China, Thailand and South East Asia
- DARC in Europe



LC72717 Block Diagram

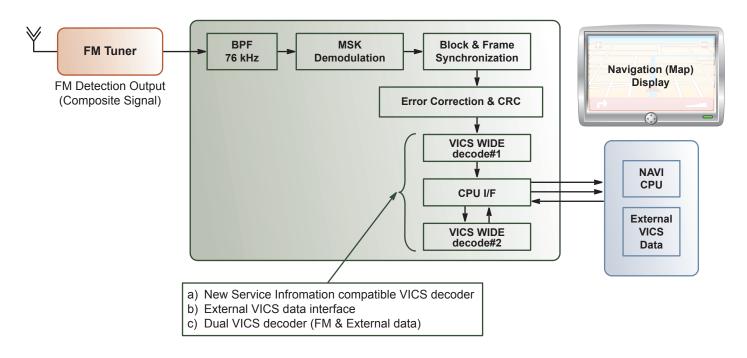
Device	Function	Application	V _{DD} (V)	Packages
LC72717	DARC Decoder	RTIC (China)	2.7 to 3.6	SQFP-64

Data Demodulation for Navigation Systems

The LC727103UJ* is a data demodulation device for receiving FM multiplex broadcasts for mobile reception in the DARC format. LC727103UJ includes VICS WIDE decoders** for new SI and a VICS data input-output interface for external VICS data. The device also includes an on-chip band-pass filter for extracting the DARC signal from the FM baseband signal, and can implement a compact, multifunction VICS reception system.

LC727103UJ Features

- DARC signal reception
- Error correction function based on 2T delay in MSK detection stage
- On-chip 76 KHz band-pass filter
- MSK demodulation
- Block and Frame synchronization
- Error correction using (272,190) product code
- On-chip Frame memory and memory control circuit for vertical error correction of product code



LC727103UJ Block Diagram

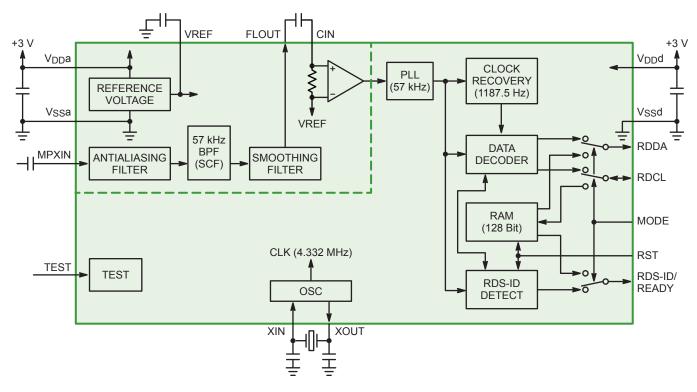
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^{*} Pending 4Q18. ** VICS Center License required.

Demodulator for RDS and RBDS Standards

LC72725 Features

- RDS demodulation, 57 kHz carrier and data clock regeneration, bi-phase decode, differential decode
- RDS-ID detect signal with reset
- · Switched capacitor bandpass filter
- 128-bit on-chip data buffer
- Standby control



LC72725 Block Diagram

Protection for USB 2.0

One High Speed Pair, V_{CC}, Low Capacitance ESD, Short-to-Battery (STB) and Short-to-Ground (STG) Protection

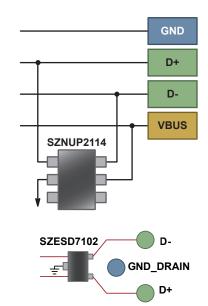
Key Requirement

• Capacitance < 1.5 pF for data lines

Features

- Capacitance 0.4 1.0 pF for data lines
- 4 low speed + 1 VBUS integrated can protect up to 2 USB ports
- Industry leading low capacitance and clamping voltage with STB capability
- LVDS compatible

Device	V _{BR} Min (V)	Lines	Capacitance (pF)	Protection Scheme	Package
SZESDM3551	5.6	1	21	VBUS ESD + Surge	X2DFN-2 (SOD-882)
SZESD7205	5.2	2	0.55 0.85	ESD	S0T-723, SC-70 (S0T-323)
SZESD7102	16.5	2	0.40	ESD + STB Standoff	SC-75
NIV1161	16.5	2	0.65	ESD + STB Limiting	WDFN-6
NIV2161	16.5	2	0.65	ESD + STB & STG Limiting	WDFN-10
SZNUP2114	5.5	3	1.00	ESD	TSOP-6, SOT-553



One High Speed Pair, V_{CC}, Common Mode Filter + ESD Protection

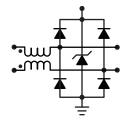
Key Requirement

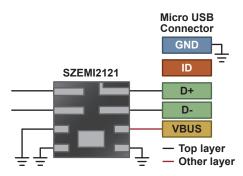
- Capacitance < 1.5 pF for data lines
- Common Mode Filtering

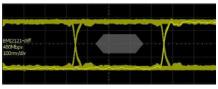
Features

- Capacitance 0.9 pF for data lines
- Integrated EMI suppression with ESD protection
- Industry leading low clamping voltage

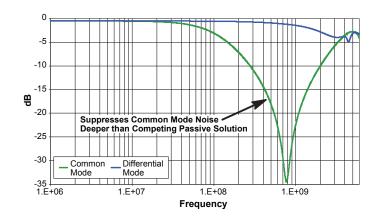
Device			CM Attenuation @ 750 MHz (-dB)		
SZEMI2121	1	0.9	-35	2.5	WDFN-8







USB 2.0 @ 480 Mb/s



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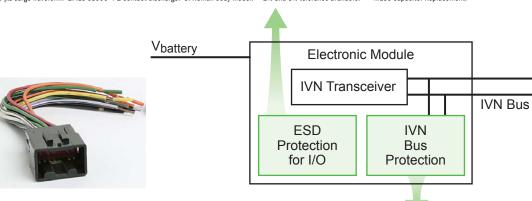
Enhance Reliability of Electronic Modules with ESD Protection Devices

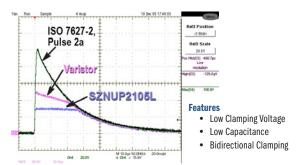
I/O & Sensor Protection

Device	Diode Configuration	VBR Range	Ppk ¹	ESD Rating	Cj	Package
SZMM5Z Series	Single Unidirectional	4.0 to 15 V	175 W	>30 kV ²	<150 pF	SOD-523
SZMM3Z Series	Single Unidirectional	2.4 to 75 V	_	>16 kV ³	<300 pF	SOD-323
SZMMSZ Series	Single Unidirectional	1.8 to 110V	_	>16 kV ³	<300 pF	SOD-123
SZMMSZ E Series	Energy Rated Single	1.8 to 110V	225 W	>16 kV ³	<300 pF	SOD-123
SZMMBZ Series	Single Unidirectional	2.4 to 91 V	_	>16 kV ³	<300 pF	S0T-23
SZMMBZ E Series	Energy Rated Single	2.4V to 91 V	225 W	>16 kV ³	<300 pF	S0T-23
SZMMBZ A Series	Dual Common Anode	5.6 to 33 V	_	>16 kV ³	<300 pF	S0T-23
SZBZX84 Series*	Single Unidirectional	2.4 to 75 V	_	>16 kV ³	<450 pF	S0T-23
SZBZX84 E Series	Energy Rated Single	2.4 to 75 V	225 W	>16 kV ³	<450pF	S0T-23
SZNZ8F Series*	Single Unidirectional	2.4 to 47 V	_	>16 kV ³	<210 pF	X2DFNW2 (SOD-882)
SZNZ9F Series*	Single Unidirectional	2.4 to 24 V	_	>16 kV ³	<210 pF	SOD-923
SZESD7272**	Unidirectional	27 V	_	>15 kV ²	<1 pF	S0T-23



1. 8/20 µs surge waveform. 2. IEC 61000-4-2 contact discharge. 3. Human body model. *2% and 5% tolerance available. ** MLCC Capacitor Replacement.

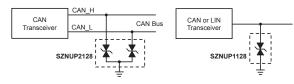




In-Vehicle Networking Protection

Device	Network	Diode Configuration	V _{BR} Min (V)	V _{clamp} Max (V)	І рр (А)	Capacitance Max (pF)	Package
SZNUP2115	FlexRay	Dual Bi-Directional	26.2	50	3	10	S0T-23
SZNUP2105	CAN	Dual Bi-Directional	26.2	44	8	30	S0T-23
SZNUP3105	CAN	Dual Bi-Directional	35.6	66	8	30	S0T-23
SZNUP3125	CAN	Dual Bi-Directional	35.6	65	3	10	SC-70 (SOT-323)
SESDONCAN1	CAN-FD	Dual Bi-Directional	26.2	50	3	10	S0T-23
SZNUP2125	CAN-FD	Dual Bi-Directional	26.2	50	3	10	SC-70 (SOT-323)
SZNUP2128	CAN	Dual Bi-Directional	28.0	70	3	15	SC-70 (SOT-323)
SZNUP1128*	LIN	Single Bi-Directional	28.0	70	3	15	S0D-323
SZESD1L001	Ethernet	Quad Uni-Directional	16.5	_	_	1	SC-88 (SOT-363)
SZESD7205	Ethernet	Dual Uni-Directional	5.2	_	_	0.55 0.85	S0T-723 SC-70 (S0T-323)

^{*} Pending 4Q18.

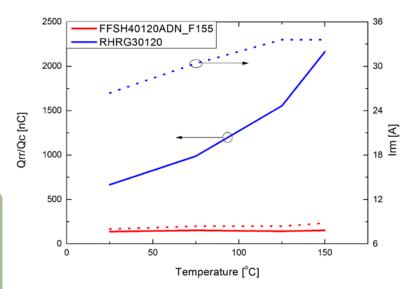


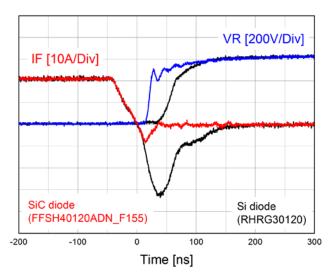
CAN and LIN protection devices improve the noise immunity and reliability of vehicular networks by suppressing overvoltage transients from conducted and radiated EMI and ESD.

Silicon Carbide Diodes

Features

- · High power density, efficiency, and reliability
- High surge and avalanche capability
- Low system losses via no reverse Q_{rr} recovery, no forward recovery, and low V_F
- Minimized reverse recovery charge (Qrr) reduces switching losses & enables high speed switching
- Stable temperature characteristics enable high-temperature operation without increasing switching losses
- High temperature operation and life time for automotive applications





Reverse Recovery & Leakage vs Temperature

Reverse Recovery @ 20 A, 500 A/µs, 125°C

	V _{RRM}	V _F Max	Continuous Forward Current	
Device	(V)	(V)	(A)	Package
FFSB1065B-F085*	650	1.7	10	D2PAK
FFSD1065B-F085	650	1.7	10	DPAK-3
FFSH2065BDN-F085	650	1.7	20	T0-247-3L
FFSH3065B-F085	650	1.7	30	T0-247-2L
FFSB3065B-F085	650	1.7	30	D2PAK
FFSB10120A-F085*	1200	1.74	10	D2PAK
FFSH10120A-F085	1200	1.74	10	T0-247-2L
FFSH20120ADN-F085	1200	1.74	20	T0-247-3L
FFSB20120A-F085*	1200	1.74	20	D2PAK
FFSH20120A-F085	1200	1.74	20	T0-247-2L
FFSH40120ADN-F085	1200	1.74	40	T0-247-3L

^{*} Pending 4Q18.

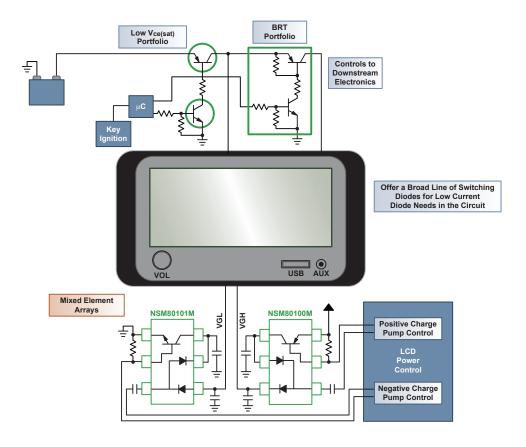
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Wide Selection of Automotive Grade Small Signal Discretes

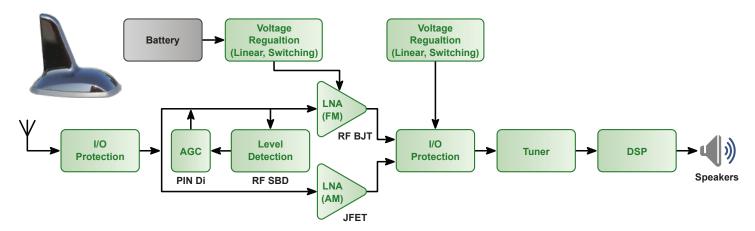
ON Semiconductor offers a wide range of devices that support infotainment systems, including diodes, JFETs, bipolar transistors, digital transistors (BRTs), and application specification discrete integration. Within these different technologies, the company offers a range of large to small packaging, meeting the smaller board space requirements of space constrained environments.

Device	Voltage Range	Current Range	Key Features	Functions	Package(s)	
Schottky Diodes	7 – 70 V	20 mA - 1 A	Low Vf, Low Leakage, Duals	DC-DC converters, high-speed switching, Oring/rectifying	SOD-123, SOD-323, SOT-23, SC-70, SC-75, SOD-523, SOD-723	
Switching Diodes	35 - 350 V	-	Switching speed, Low leakage	Broad range of applications	SC-59, SOT-23, SC-70, SC-88 6, SC-88A-5, SOT-563, SC-75, SOD-123, SOD-323, SOD-523	
Low V _{CE(sat)} Transistors	12 - 100 V	700 mA - 6 A	Ultra-low Vce (sat) Broad portfolio	Battery charging circuit, switching, fan control	DPAK, SOT-223, TSOP-6, ChipFET, SOT-23, SOIC-8, WDFN*	
JFETs	25 - 30 V	20 - 150 mA	Interchangeable Drain and Source, high input resistance	Ideal for applications senstive to noise	S0T-23	
Darlington Transistors	30 - 350 V	300 mA - 10 A	High HFE	_	D2PAK, DPAK, S0T-23	
Audio Transistors	50 - 350 V	2 - 8 A	Linear gain Excellent SOA	High power audio amplifiers	DPAK	
Bipolar Power Transistors	45 - 450 V	500 mA - 60 A	Low leakage Low saturation	Lamp ballast	SC-89, SOT-223, DPAK, D2PAK, SOT-23, SOT-723, WDFN, SOT-563	
General Purpose Transistors	7 - 300 V	50 mA - 10 A	Broad product range	Broad range of applications	Multiple surface mount packages available	
Digital Transistors (BRTs)	15 - 50 V	100 mA - 3 A	Broad Portfolio of R1 and R2 combinations	Power switching	SC-59, SOT-23, SC-70, SC-88-5, SC-88A-6, SOT-563	

^{*} With wettable flanks.



Discrete Components for Antennas



JFET Features

- Large forward transfer admittance and low noise figure enhance receiver sensitivity
- · High ESD immunity
- High VGDS for robust circuit design
- · Low capacitance improves receiver sensitivity
- · High power density

JFETs

Device	Configuration	VGDS (V)	IDSS (mA)	IVGSoff (V)	gm (mS)	Ciss (pF)	Package(s)
NSVJ2394SA3	Single	15	10-32	-1.5 to -0.3	38	10	SC-59
NSVJ3557SA3	Single	15	10-32	-1.5 to -0.3	35	10	SC-59
NSVJ3910SB3	Single	25	20-40	-1.8 to -0.6	40	6	SOT-346 (CPH-3)
NSVJ5908DSG5	Dual	15	10-32	-1.5 to -0.3	35	10	MCPH-5
NSVJ6904DSB6	Dual	25	20-40	-1.8 to -0.6	40	6	SOT-26 (CPH-6)

RF Transistors

	Max Ratings			
Device	VCE (V)	lc (mA)	f _T Typ (GHz)	Package(s)
NSVF6003SB6	12	150	7 @ VCE = 5 V, IC = 50 mA	SOT-26 (CPH-6)
NSVF6001SB6*	12	100	6.7 @ VCE = 5 V, IC = 30 mA	SOT-26 (CPH-6)
NSVF4015SG4	12	100	10 @ VCE = 3 V, IC = 30 mA	SOT-343 (MCPH-4)
NSVF4017SG4	12	100	10 @ VCE = 3 V, IC = 30 mA	SOT-343 (MCPH-4)
NSVF3007SG3	12	30	8 @ VCE = 5 V, IC = 10 mA	SOT-323 (MCPH-3)
NSVF5501SK	10	70	5.5 @ VCE = 5 V, IC = 20 mA	SC-81 (SSFP)
NSVF4020SG4	8	150	16.5 @ VCE = 5 V, IC = 50 mA	SOT-343 (MCPH-4)
NSVF4009SG4	3.5	40	25 @ VCE = 3 V, IC = 20 mA	SOT-343 (MCPH-4)

^{*} Pending 4Q18.

Pin Diode Features

- Series connection of two elements in small package
- Low inter-terminal capacitance

PIN Diodes

Device	V _R (V)	IF (mA)	C Typ ¹ (pF)	$r_{\rm S}$ Typ ² (Ω)	Package(s)
NSVP249SDSF3	50	50	0.23	4.5	SOT-323 (MCP)
NSVP264SDSA3*	50	50	0.23	2.5	SOT-323 (MCP)

^{*} Pending 4Q18. 1. C Typ @ $V_R = 50 V$, f = 1 MHz. 2. r_S Typ @ $I_F = 10 mA$, f = 100 MHz.

RF Transistor Features

- · High gain and low noise for receiver sensitivity
- Low distortion input
- High power capability for use in high temperature applications

RF Schottky Barrier Diode Features

- Low forward voltage
- Low inter-terminal capacitance

Schottky Barrier Diodes

Device	V _R (V)	V_F¹ (mV)	C Typ² (pF)	Package(s)
NSVR201MX	2	320	0.15	X2DFN-2
NSVR351SDSA3	5	230	0.69	SOT-346 (CP)

1. VF @ I_F = 1 mA. 2. C Typ @ V_R = 50 V, f = 1 MHz.

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Wide Selection of Automotive Grade Power MOSFETs

ON Semiconductor offers an expansive portfolio of Power MOSFETs, utilizing advanced Trench and SuperFET® Technology. Devices enable increased system level efficiency through low switching losses and low conduction losses, and are available in a range of standard and innovative packages.



Low to Medium Voltage

- 20 V to 200 V, Standard Gate & Logic Level
- N & P Channel, Singles & Duals
- Wide RDS(on) range from 0.5 m Ω for 40 V in 5 x 6 mm package, to 7.5 Ω general purpose switches
- Planar & multiple Trench technologies
- Package types including:
 - Small footprint SOT-23, SC-70/75/88, SSOT-3/6, TSSOP-6, SO-8
 - Traditional DPAK, D2PAK, T0-220, S0T-223
 - Surface Mount µ8FL, SO-8 FL, Power88, TO-Leadless
 - With Dual Cool, & DFN being introduced

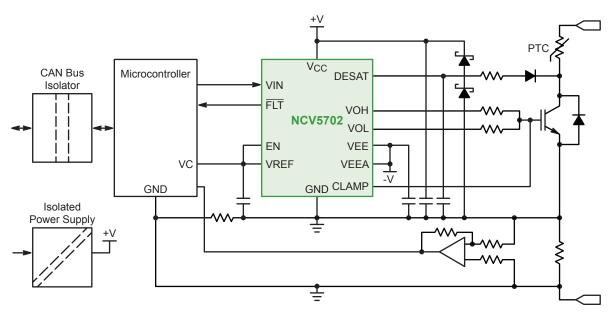
High Voltage Fast Switching

- 600 V to 650 V, N Channel, Standard Gate Level
- 650 V SuperFET II Typical RDS(on) of 41 190 m Ω
- 650 V MOSFET KGD Dies SuperFET I and II –Typical RDS(on) of 41, 77, and 190 $m\Omega$
- New SuperFET III technology in development with typical RDS(on) of 23 70 m Ω
- Lowest RDS(on) for the Automotive Qualified Super junction HV MOSFET's in different threw hole packages – TO-247-3L and TO-220
- MOSFET Modules in development
 - High thermal performance
 - Enhanced EMI, isolation, and current capabilities
 - · System level cost reduction
 - Enable compact system solution with proven reliability
- One of best-in-class Figure of Merit (Qg* RDS(on)) for automotive qualified MOSFETs

IGBT Gate Drivers for High Voltage and High Power Applications

Features

- High current output (+4 A/-6 A) at Miller Plateau for higher system efficiency
- Short propagation delays with accurate matching for improved system reliability
- UVLO, DESAT, Miller Clamp, Negative VEE for system protection
- 5 V reference for external logic
- AEC-Q100 Qualified



PTC Heater Application Schematic

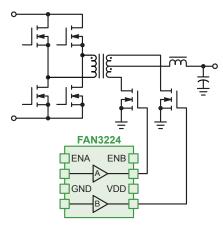
Device	Features + Options	Inverted Output	Fault Output	V _{IN} Max (V)	VCC Max (V)	Drive Source/Sink Typ (A)	Rise/Fall Time (ns)	t_{pd} Max (ns)	Package
NCV5700	DESAT + CLAMP + VEE + VOH/VOL	Yes	Active Low	5.5	35	4/6	30/30	75	SOIC-16
NCV5701A	DESAT + CLAMP	Yes	Active Low	5.5	35	4/6	30/30	75	SOIC-8
NCV5701B	DESAT + VEE	Yes	Active Low	5.5	35	4/6	30/30	75	SOIC-8
NCV5701C	DESAT + VOH/VOL	Yes	Active Low	5.5	35	4/6	30/30	75	SOIC-8
NCV5702	DESAT + CLAMP + VEE + VOH/VOL	No	Open Drain	5.5	35	4/6	30/30	75	SOIC-16
NCV5703A	DESAT + CLAMP	No	Open Drain	5.5	35	4/6	30/30	75	SOIC-8
NCV5703B	DESAT + VEE	No	Open Drain	5.5	35	4/6	30/30	75	S0IC-8
NCV5703C	DESAT + VOH/VOL	No	Open Drain	5.5	35	4/6	30/30	75	S0IC-8

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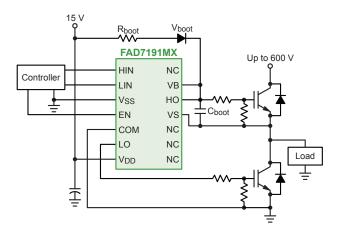
MOSFET & IGBT Gate Drivers for ICE, EV/HEV, and 48 V

Features

- Large sink and source current capability
- Fast drivers with short propagation delay
- SOIC-14 and SOIC-16 packages for applications with HV clearance requirements
- Separate power and signal ground for higher immunity against high dl/dt
- Various protection features such as UVLO and shoot-through prevention
- Custom options



Synchronous Rectification Application



Motor Drive Application

		Sink/Source Output	Undervoltage	Peak Transient	Shoot Through	Enable/ Shut Down		Inverted	
Device	Description	Current	Lockout	(V)	Prevention	Pin	Input level	Output	Package(s)
FAN3229 (F085)	Dual Low Side Gate Driver	1.6/2.4 A	~	20			CMOS/TTL**		SOIC-8
FAN3121 (F085)	Single Low Side Gate Driver	7.1/9.7 A	~	20		~	CMOS/TTL	V	SOIC-8
FAN3122 (F085)	Single Low Side Gate Driver	7.1/9.7 A	~	20		~	CMOS/TTL		SOIC-8
FAN3213 (F085)	Dual Low Side Gate Driver	2.8/4.3 A	~	20			TTL	~	SOIC-8
FAN3214 (F085)	Dual Low Side Gate Driver	2.8/4.3 A	~	20			TTL		SOIC-8
FAN3216 (F085)	Dual Low Side Gate Driver	1.6/2.4 A	V	20			TTL	~	SOIC-8
FAN3217 (F085)	Dual Low Side Gate Driver	1.6/2.4 A	~	20			TTL		SOIC-8
FAN3223 (F085)	Dual Low Side Gate Driver	2.8/4.3 A	~	20		V	CMOS/TTL	V	SOIC-8
FAN3224 (F085)	Dual Low Side Gate Driver	2.8/4.3 A	~	20		V	CMOS/TTL		SOIC-8
FAN3225 (F085)	Dual Low Side Gate Driver	2.8/4.3 A	V	20			CMOS/TTL**		SOIC-8
FAN3226 (F085)	Dual Low Side Gate Driver	1.6/2.4 A	~	20		V	CMOS/TTL	~	SOIC-8
FAN3227 (F085)	Dual Low Side Gate Driver	1.6/2.4 A	V	20		~	CMOS/TTL		SOIC-8
FAN3228 (F085)	Dual Low Side Gate Driver	1.6/2.4 A	~	20			CMOS/TTL**		SOIC-8
FAN1100 (F085)	Ignition IGBT Driver	-		28			1.2 V VINL / 2 V VINH		SOIC-8
NCV51705*	Low side SiC Driver	6/6 A	Adjustable	28	~	~	TTL	~	QFN-24
NCV51511	High Frequency, High Side and Low Side Gate Driver with Bootstrap Diode	3/6 A		100			TTL		SOIC-8 EP
FAN7085 (F085)	High Side Gate Driver with Cboot Recharge Path	450/450 mA	V	300		~	CMOS		SOIC-8
NCV5183	High and Low Side Gate Driver	4.3/4.3 A	V	600			3.3 & 5 V Logic Compatible		SOIC-8
NCV5106A	High and Low Side Gate Driver	250/500 mA	~	600			3.3 & 5 V Logic Compatible		SOIC-8
FAN7080 (F085)	Half Bridge Gate Driver	300/600 mA	~	600	~	V	3.3 / 5 V logic compatible		SOIC-8
FAN7081 (F085)	High Side Gate Driver	250/500 mA	V	600			CMOS		SOIC-8
FAN7083 (F085)	High Side Gate Driver	200/400 mA	V	600		~	CMOS		SOIC-8
NCV5104	Single Input High and Low Side Gate Driver	250/500 mA	~	600	~	~	3.3 & 5 V Logic Compatible		SOIC-8
FAN7171 (F085)	High Side Gate Driver	4/4 A	~	600			3.3 / 5 V logic compatible		SOIC-8
FAN7191 (F085)	High Side and Low Side High Gate Driver	4.5/4.5 A	~	600			3.3 / 5 V logic compatible		SOIC-8
FAD7191M1X	High Side and Low Side Gate Driver with Separate Grounds	4.5/4.5 A	~	600		V	3.3 / 5 V logic compatible		S0IC-14
FAD8253MX*	Half Bridge Gate Driver with Separate Grounds	2/2.5 A	V	1200	~	~	3.3 / 5 V logic compatible		SOIC-14

^{*} Pending 4Q18. ** Differential input.

Smart Drivers & Bridges

In automotive systems, there are many different kind of actuators, including relays, bulbs, LEDs, motors, and other resistive and inductive loads. The variety of motor applications in modern vehicles is huge and is growing dramatically due to the increased demand for more efficiency. Comfort electronics – such as electrical window lifts, central door locks, and climate control systems – continue to increase automotive electronic content. The easiest to implement, DC brush motors are the most common electric motors used today. To reduce noise and to increase reliability, stepper motors are becoming more popular in position control applications, e.g. HVAC flaps.

ON Semiconductor provides drivers with integrated power stages; in addition, the company offers pre-drivers that control external MOSFETs in applications where the high load current makes MOSFET integration impractical.

Product types in portfolio:

- Pre-Driver
 - · Multi-channel pre-driver
 - Motor control pre-driver
- · Multi-channel integrated driver
 - Multiple single-ended high-side and low-side driver
- Configurable high-side and low-side driver
- · Half-bridge driver
- · High current integrated H-bridge driver
- Stepper motor driver

Pre-Drivers

							Diagnostics		
Device	Description	SPI	Direct Control	Load Current	3.3 V / 5 V	V _s Max	OL/UL	sc	Package
NCV7513B	Hex LS Pre-Driver	16-bit	V	external MOSFET	V	40 V (drain)	✓	V	LQFP-32
NCV7517B	Hex LS Pre-Driver	16-bit	~	external MOSFET	✓	40 V (drain)	V	V	LQFP-32
NCV7518	Hex Low-Side	16-bit	~	external MOSFET	~	48 V (load)	~	~	QFN32
NCV7519	Hex Low-Side	16-bit	~	external MOSFET	~	48 V (load)	~	~	QFN32
NCV7520MW	Hex Low-Side	16-bit	~	external MOSFET	~	48 V (load)	~	~	QFN32
NCV7520MW	Hex Low-Side	16-bit	~	external MOSFET	~	48 V (load)	~	~	TQFP-32 EP
NCV33152	High Speed Dual PreDrvier	_	~	external MOSFET		20 V (V _{DD})			SOIC-8
NCV7535	H-Bridge	24-bit	✓	external MOSFET	5 V	40 V		✓	TSSOP-20

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Smart Drivers & Bridges

Drivers

Drivers	Device	Description	SPI	Direct Control	Load Current	I _{lim} Min	Vs Op	V _S Max	Rdson Max @ 25°C (HS/LS)	Package
	NCV7702B	Configurable Dual H-Bridge	_	V	-	1 A	7 - 16 V	60 V	_	S0IC-24
Full Bridge	NCV7710	H-Bridge	24-Bit		3 A	6 A	5.5 - 28 V	40 V	Typ 150 m Ω , Max 180 m Ω	SSOP-36 EP
	NCV7708E	Hex HS/LS Driver	SPI: 16-bit		1 A	1 A	5.5 - 40 V	40 V	0.8 Ω	SOIC-28W
	NCV7708F	Hex HS/LS Driver	SPI: 16-bit		1 A	1 A	5.5 - 40 V	41 V	0.8 Ω	SSOP-24 EP
	NCV7608	Configurable HS/LS Driver	SPI: 16-bit	~	0.35 mA	0.8 A	3 - 28 V	40 V	1.2 Ω	SOIC-28W
	NCV7240B	8x LS Driver	SPI: 16-Bit	Limp Home Feature	_	0.6 A	5.5 V (V _{DD} /V _{DDA})	5.5 V (V _{DD} /V _{DDA})	1.5 Ω	SS0P-24
Multi- Channel	NCV7754	8x LS Driver	SPI: 16-Bit	Limp Home Feature	-	0.5 A	5.5 V (VDD/VDDA)	5.5 V (VDD/VDDA)	0.8 Ω	SS0P-24
LS	NCV7751	12x LS Driver	SPI: 16/24/32- Bit			0.6 A	5.5 V (V _{DD} /V _{DDA})	5.5 V (V _{DD} /V _{DDA})	1.2 Ω	SSOP-24 EP
	NCV7748	8x LS Driver	LIN		0.3 A/0.4 A	0.6 A/0.75 A	6 - 18 V	40 V	$0.8~\Omega/1.5~\Omega$	S0IC-14
	NCV7707	Front Door-Module Driver (3x Full-Bridge, 5x HS, 1x LS)	SPI: 24-bit		_	HB: 0.75 A/3 A/6 A HS: 0.3 A/2.5 A/6 A LS: 0.75 A	5.5 - 28 V	40 V	HB: $1.6~\Omega/300~m\Omega/150~m\Omega$ HS: $1.4~\Omega/300~m\Omega/600$ $m\Omega/300~m\Omega/100~m\Omega$ LS: $1.6~\Omega$	SSOP-36 EP
Half- Bridge HB, HS, LS	NCV7705	Mirror Driver (4x Half-Bridge, 4x HS, 1x LS)	SPI: 24-bit		-		5.5 - 28 V	40 V	HB: $1.6~\Omega/300~\text{m}\Omega$ HS: $1.4~\Omega/300~\text{m}\Omega/600$ $\text{m}\Omega/300~\text{m}\Omega/100~\text{m}\Omega$ LS: $1.6~\Omega$	SSOP-36 EP
, ,	NCV7714	Mirror Driver (3x Half-Bridge, 4x HS, 1x LS)	SPI: 24-bit		_		5.5 - 28 V	40 V	HB: 1.6 Ω HS: 1.4 Ω /300 m Ω LS: 1.6 Ω	SSOP-36 EP
	NCV7704	Mirror Driver (3x Half-Bridge, 4x HS)	SPI: 24-bit		_		5.5 - 28 V	40 V	HB: 1.6 Ω HS: 1.4 $\Omega/300~\text{m}\Omega$	SSOP-36 EP
	NCV7721	Single H-Bridge Driver	_	~	1 A					SSOP-36 EP
	NCV7703C	Triple HS/LS Half-Bridge	SPI: 16-bit		1 A	1 A	5.5 - 40 V	40 V	0.8 Ω	SOIC-14
Half-	NCV7718B	Hex Half-Bridge	SPI: 16-bit		1 A	1 A	4.5 - 40 V	40 V	1.1 Ω	S0IC-14
Bridge	NCV7719	Octal Half-Bridge	SPI: 16-bit		0.5 A	0.8 A	4.5 - 40 V	40 V	1.1 Ω	SSOP-24 EP
	NCV7720	10x Half-Bridge	SPI: 16-bit		0.5 A	0.8 A	4.5 - 40 V	40 V	1.1 Ω	SSOP-24 EP
	NCV7726	12x Half-Bridge	SPI: 16-bit		0.5 A	0.8 A	4.5 - 40 V	40 V	1.1 Ω	SSOP-24 EP

Wide Selection of Automotive Grade Operational Amplifiers and Comparators

Comparators

		Vs Min	Vs Max	Iq/Channel	tresp (H-L)	Vos Max	lout			
Device	Channels	(V)	(V)	(µA)	(µs)	(mV)	(mA)	Output Type	Features	Package(s)
NCV2393	2	2.7	16	9	0.8	5	20	Open Drain	Vs Range, Ultra-Low Iq	SOIC-8
NCV2200	1	0.85	6	10	0.7	5	70	Complementary	Low IQ, Fast tRESP	S0T-23-5
NCV331	1	2.7	5	40	0.5	9	84	Open Drain	Ultra-Low IQ	TSOP-5
NCV2903	2	2	36	200	1.5	15	16	Open Collector	Low Cost	SOIC-8, MICRO8
NCV2901	4	3	36	250	1.3	7	16	Open Collector	Low Cost	SOIC-14, TSSOP-14, Bare Die
NCV391	1	2	36	500	0.35	9	16	Open Collector	Small Package, Fast tRESP	S0T-23-5

Operational Amplifiers

	Ė	V _S Min	Vs Max	lo/Channel	GBW	Vos Max	Vos Drift	IB	CMRR	en	Rail to		
Device	Channels	(V)	(V)	(mA)	(MHz)	(mV)	(μV/°C)	(nA)	(dB)	(nV/√Hz)	Rail	Features	Package(s)
NCV33172	2, 4	3	44	0.18	1.8	6.5	10	20	90	32	_	Up to 44 V supply	SOIC-8, TSSOP-14
NCV2003/32/34	1, 2, 4	1.7	5.5	0.27	7	5	2	0.001	80	20	Output	8 V/µus Slew Rate	SOT-23-5, SOT-553, Micro8, SOIC-8, TSSOP-8, SOIC-14
NCV20071/2/4	1, 2, 4	2.7	36	0.4	3	4	2	0.005	110	30	Output	Up to 36 V supply & RRO	SOT-553, TSOP-5, Micro8, SOIC-8, TSSOP-8, TSSOP-14, SOIC-14
NCV2002	1	0.9	7	0.48	0.9	6	8	0.01	82	100	1/0	Shutdown, supply down to 0.9 V	TSOP-6
NCV2904	2	3	32	0.75	1	7	7	45	70	-	-	Low cost	SOIC-8, Micro8
NCV33202/4	2, 4	1.8	12	0.9	2.2	6	2	80	90	20	1/0	High output current & drive	SOIC-8, Micro8, SOIC-14, TSSOP-14
NCV952	2	2.7	12	0.9	3	8	2	35	80	25	1/0	26 V rail-to-rail I/O	TSSOP-8
NCV7101	1	1.8	10	1.0	1	9	8	0.001	60	140	1/0	Ultra-low IB	S0T-23-5
NCV2902	4	3	32	1.2	1	7	7	90	70	-	-	Low cost	SOIC-14, TSSOP-14
NCV33072/4	2, 4	3	44	1.6	4.5	3	10	100	97	32	_	44 V supply & fast Slew Rate	SOIC-8, TSSOP-14
NCV833	2	10	36	2	15	5	2	300	100	4.5	-	VS Range, low eN	SOIC-8
NCV33078	2, 4	5	18	2.1	16	2	2	300	100	4.5	_	Wide GBW, low VOS & eN	SOIC-8, SOIC-14
NCV33079	2, 4	5	18	2.1	16	2	2	300	100	4.5	-	Wide GBW, low VOS & eN	SOIC-8, SOIC-14
NCV33272/4A	2, 4	3	36	2.2	24	1	2	300	100	18	_	Wide GBW, VS range	SOIC-8, SOIC-14, TSSOP-14
NCV20062	2	1.8	5.5	0.14	3	4	1	0.001	80	20	1/0	Low power & RRIO	Micro8, TSSOP-8, SOIC-8
NCV20082	2	1.8	5.5	0.05	1.2	4	1	0.001	80	30	1/0	Low power & RRIO	Micro8, TSSOP-8, SOIC-8
NCV20092	2	1.8	5.5	0.02	0.35	4	1	0.001	80	40	1/0	Low power & RRIO	Micro8, TSSOP-8, SOIC-8

Power Operational Amplifiers ($I_{OUT} \ge 250 \text{ mA}$)

Device	Channels	lout (A)	Vs Min	Vs Max	lq/Channel (mA)	GBW (MHz)	Vos Max (mV)	Vos Drift (μV/°C)	IB (nA)	Slew Rate	Features -	Package (s)
NCV5652	2	0.5	3.3	13.2	4	0.35	-	2	200	1	Thermal flag & shutdown, excellent Vol	DFN-12
NCV0372	2	1	5	40	2.5	1.4	20	20	100	1.4	Thermal shutdown	PDIP-8, PDIP-16, SOIC-16W, SOEIAJ-16

Zero Drift Precision/Current Sense Operational Amplifiers

Device	Channels	V _S Min	V _S Max (V)	Input CM Range (V)	lq/Channel (μΑ)	GBW (MHz)	V_{OS} Max (μV)	V_{OS} Drift (μV/°C)	Gain Error (%)	CMRR (dB)	e _N (nV/√Hz)	Features	Package(s)
NCV21x*	1	2.7	26	2.7 to 26	65	14	35	0.5	1	140	_	Up to 26 V CMVIR	SC-70
NCV333/2333/4333	1, 2, 4	1.8	5.5	V _{SS} -0.1 to V _{DD} +0.1	21	350	10	0.03	_	120	1	Low VOS	SOT-23-5, SC-70-5, DFN-8, Micro8, SOIC-8, SOIC-14

^{*} Fixed Gain options = 50, 75, 100, 200, 500, 1000.

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EEPROMs for Personalization of Comfort and Entertainment Features

Grade 0 EEPROMs

Device	Density	Vcc Min (V)	Vcc Max (V)	Temperature Range (°C)	Package(s)
NV25010	1 kb	1.7 / 2.5	5.5	-40 to +150	SOIC-8, TSSOP-8
NV25020	2 kb	1.7 / 2.5	5.5	-40 to +150	SOIC-8, TSSOP-8
NV25040	4 kb	1.7 / 2.5	5.5	-40 to +150	SOIC-8, TSSOP-8
NV25080	8 kb	1.7 / 2.5	5.5	-40 to +150	SOIC-8, TSSOP-8
NV25160	16 kb	1.7 / 2.5	5.5	-40 to +150	SOIC-8, TSSOP-8
NV25320	32 kb	1.7 / 2.5	5.5	-40 to +150	SOIC-8, TSSOP-8
NV25640	64 kb	1.7 / 2.5	5.5	-40 to +150	SOIC-8, TSSOP-8

Grade 1 Features

- -40°C to +125°C
- 1 kb to 1 Mb density range available
- 1 million cycle program/erase

Grade 0 Features

- -40 to +150°C
- SPI interface protocol
- Voltage supply range: 1.7 5.5 V up to +125°C; 2.5 - 5.5 V up to +150°C

EasyPRO™ is a user-friendly, portable programming tool for ON Semiconductor serial EEPROMs (I2C, **SPI**, Microwire)



Grade 1 EEPROMs

Interface Protocol	Device	Density	Organization	Vcc Min (V)	Vcc Max (V)	f _{clk} Max (MHz)	Package(s)
	CAV24M01	1 Mb	128k x 8	2.5	5.5	1	SOIC-8, TSSOP-8
	CAV24C512	512 kb	64k x 8	2.5	5.5	1	SOIC-8, TSSOP-8
	CAV24C256	256 kb	32k x 8	2.5	5.5	1	SOIC-8, TSSOP-8
	CAV24C128	128 kb	16k x 8	2.5	5.5	1	SOIC-8, TSSOP-8
12C	CAV24C64	64 kb	8k x 8	2.5	5.5	0.4	SOIC-8, TSSOP-8
120	CAV24C32	32 kb	4k x 8	2.5	5.5	0.4	SOIC-8, TSSOP-8
	CAV24C16	16 kb	2k x 8	2.5	5.5	0.4	SOIC-8, TSSOP-8
	CAV24C08	8 kb	1k x 8	2.5	5.5	0.4	SOIC-8, TSSOP-8
	CAV24C04	4 kb	512 x 8	2.5	5.5	0.4	SOIC-8, TSSOP-8
	CAV24C02	2 kb	256 x 8	2.5	5.5	0.4	SOIC-8, TSSOP-8
	CAV25M01	1 Mb	128k x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV25512	512 kb	64k x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV25256	256 kb	32k x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV25128	128 kb	16k x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV25640	64 kb	8k x 8	2.5	5.5	10	SOIC-8, TSSOP-8, TDFN-8
SPI	CAV25320	32 kb	4k x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV25160	16 kb	2k x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV25080	8 kb	1k x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV25040	4 kb	512 x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV25020	2 kb	256 x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV25010	1 kb	128 x 8	2.5	5.5	10	SOIC-8, TSSOP-8
	CAV93C86	16 kb	2k x 8 / 1k x 16	2.5	5.5	2	SOIC-8, TSSOP-8
	CAV93C76	8 kb	1k x 8 / 512 x 16	2.5	5.5	2	SOIC-8, TSSOP-8
Microwire	CAV93C66	4 kb	512 x 8 / 256 x 16	2.5	5.5	2	SOIC-8, TSSOP-8
	CAV93C56	2 kb	256 x 8 / 128 x 16	2.5	5.5	2	SOIC-8, TSSOP-8
	CAV93C46	1 kb	128 x 8 / 64 x 16	2.5	5.5	2	SOIC-8, TSSOP-8

Micro-Stepping Motor Drivers for Enhanced Positioning Resolution

Features

- Micro-stepping technology
- Embedded sensorless step-loss and stall detection
- Configurable for different motor types
- On-chip positioner AMIS-30623

Stepping Motor Drivers

Device	Interface	Integrated Linear Regulator	Sensorless Stall Detection		Peak Current (mA)	Package
AMIS-30621	LIN	~		40	800	SOIC-20, NQFP-32
AMIS-30622	I ² C	~		40	800	S0IC-20
AMIS-30623	LIN	V	V	40	800	SOIC-20, NQFP-32

Integrated, Reliable Drive Circuits for Motors and Electro-Mechanical Relays

Most relays mounted to a PCB require a relay driver circuit!



Features

- Integrates diodes, resistors and capacitors into one circuit
- Delivers additional current to the relay coil and protects against ESD
- Meets IEC61000-4-4 Electrical Fast Transient (EFT) test standards

Relay Drivers

Device	Configuration	Circuit Type *	Voltage (V)	Current (mA)	Package(s)
SZNUD3124	Single	MOSFET	24	150	S0T-23
SZNUD3124D	Dual	MOSFET	24	150	SC-74
SZNUD3160	Single	MOSFET	60	150	S0T-23
SZNUD3160D	Dual	MOSFET	60	150	SC-74

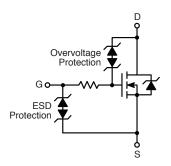
^{*} MOSFET: the driver circuit consists of a MOSFET combined with resistors and diodes.

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Integrated Circuit Elements with Self-Protected MOSFET Solutions

ON Semiconductor supplies self-protected MOSFETs that may include current limiting, temperature limiting, ESD protection, or a current mirror. The portfolio of smart MOSFETs integrates analog circuit elements for protection and diagnostics within power MOSFETs.





Clamping MOSFET

Overvoltage Protection GOVERNOLT CUrrent Current Sense S

Low-Side Protected MOSFET

EN Control Logic Protection Load Diagnostics Status Corrent Sense

High-Side Protected MOSFET

Clamp FET Features (E-FET)

- Gate-to-Source protection
- Over-voltage protection
- Internal series Gate resistance
- Clamp voltage range 40-50 V

Protected Low-Side Switch

- Short circuit protection
- Current limit
- Thermal shut-down with restart
- ESD protection
- Overvoltage clamped protection

Protected High-Side Switch

- Charge pump
- Short circuit protection
- Current limit
- Temperature limit and shut-down
- ESD protection
- Overvoltage clamped protection
- Diagnostic output
- Loss of ground detection
- Open and underload detection
- Over and undervoltage detection

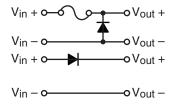
Self-Protected MOSFETs

Device	Description	Channels	Package(s)
LOW SIDE			
NCV8401A	Low Side Protected MOSFET, 23 m Ω	1	DPAK
NCV8402A	Low Side Protected MOSFET, 165 m Ω	1	S0T-223
NCV8402AD	Dual Low Side Protected MOSFET, 165 m Ω	2	S0IC-8
NCV8403A	Low Side Protected MOSFET, 60 m Ω	1	SOT-223, DPAK
NCV8405A	Low Side Protected MOSFET, 100 m Ω	1	SOT-223, DPAK
NCV8406A	Low Side Protected MOSFET, 210 m Ω	1	SOT-223, DPAK
NCV8408	Low Side Protected MOSFET, 65 m Ω	1	S0T-223
NCV8440A	Clamped MOSFET, 95 m Ω	1	S0T-223
HIGH SIDE			
NCV8450A	High Side Protected MOSFET, 1 Ω	1	S0T-223
NCV8452	High Side Protected MOSFET, 200 m Ω	1	S0T-223
NCV8460A	High Side Protected MOSFET w\Digital Diagnostics, 60 m Ω	1	S0IC-8
NCV8461	High Side Protected MOSFET w\Digital Diagnostics, 350 m Ω	1	S0IC-8

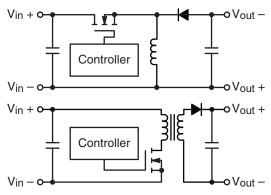
New Rectifier Packaging Solutions for Automotive

Features

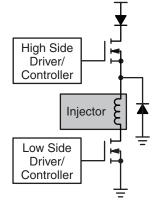
- Low forward voltage drop for improved efficiency
- · High forward surge current capabilities
- Fast switching Schottky rectifiers can operate at high frequencies
- Small SOD-123FL, SMA, SMB, SMC and DPAK options to reduce board area
- Capable of use as freewheeling diodes, output rectifiers, energy recirculation diodes, and for polarity protection



Polarity Protection



Freewheeling and Output Rectification



Engine Control and Energy Recirculation Diodes

Polarity Protection Rectifiers

Device	V _{RRM}	10 (rec) (A)	Package
NRVBS360	60	3	SMC
SBRD8360	60	3	DPAK
NRVBD660CT	60	6	DPAK
SBRD81045	45	10	DPAK
SBRB1045	45	10	D2PAK
NRVBB1645	45	16	D2PAK
NRVBB2060CT	60	20	D2PAK
SBRB2545CT	45	30	D2PAK
NRVBB30H60CT	60	30	D2PAK
NTSB30100CT	100	30	D2PAK
NTSB30U100CT	100	30	D2PAK
NRVBB4030	30	40	D2PAK
NTSB40120CT	120	40	D2PAK
NTSB60100CT	100	60	D2PAK

Freewheeling and Output Rectification Rectifiers

Device	V _{RRM} (V)	(A)	Package
NRVB140SF	40	1	SOD-123FL
NRVB140ESF	40	1	SOD-123FL
NRVBA140	40	1	SMA
SBRS8140	40	1	SMB
NRVB1H60SF	60	1	SOD-123FL
NRVBA160	60	1	SMA
MBRAF1100	100	1	SMA Flat
SURHS8160	600	1	SMB
NRVBAF1540	40	1.5	SMA Flat
NRVBS2040L	40	2	SMB
NRVBS240L	40	2	SMB
NRVTSM260	60	2	Powermite
NRVB2H60SF	60	2	SOD-123FL
NRVBAF260	60	2	SMA Flat
NRVBS260	60	2	SMB
MBRAF2H100	100	2	SMA Flat
NRVBA340	40	3	SMA
SBRS8340	40	3	SMC
SBRD8340	40	3	DPAK
NRVBAF360	60	3	SMA Flat
NRVBAF3200	200	3	SMA Flat
MBRAF440	40	4	SMA Flat
NRVBS540	40	5	SMC
SURHD8560	600	5	DPAK
NRVBD640CT	40	6	DPAK
SBRB1545CT	45	15	D2PAK
NRVBB3030CTL	30	30	D2PAK

SO-8 Flat Lead Rectifiers

30-0 Flat Leau Rectillers						
Device	V _{RRM} (V)	10 (rec) (A)	Package			
NRVB440MFS	40	4	SO-8FL			
NRVB460MFS	60	4	SO-8FL			
NRVB540MFS	40	5	SO-8FL			
NRVB560MFS	60	5	SO-8FL			
NRVB5100MFS	100	5	SO-8FL			
NRVB5H100MFS	100	5	SO-8FL			
NRVB860MFS	60	8	SO-8FL			
NRVB8H100MFS	100	8	SO-8FL			
NRVB1045MFS	45	10	SO-8FL			
NRVB10100MFS	100	10	SO-8FL			
NRVTS10100EMFS	100	10	SO-8FL			
NRVTS10120EMFS	120	10	SO-8FL			
NRVB1240MFS	40	12	SO-8FL			
NTS12100EMFS	100	12	SO-8FL			
NRVTS12120EMFS	120	12	SO-8FL			
NRVB2045MFS	45	20	SO-8FL			
NRVB2045EMFS	45	20	SO-8FL			
NRVB30H100MFS	100	30	SO-8FL			
MBR5H100MFS	100	5	SO-8FL			

Energy Recirculation Rectifiers

Energy Recir	culation	ı kecili	iers
Device	VRRM (V)	10 (rec) (A)	Package
NRVB1H100SF	100	1	SOD-123FL
NRVBA1H100	100	1	SMA
SBRS81100	100	1	SMB
SURA8110	100	1	SMA
SURS8110	100	1	SMB
SURA8120	200	1	SMA
SURS8120	200	1	SMB
NRVB2H100SF	100	2	S0D-123FL
NRVBA2H100	100	2	SMA
NBRS2H100	100	2	SMB
SURA8210	100	2	SMA
SURS8210	100	2	SMB
NRVHPM220	200	2	Powermite
NRVHP220SF	200	2	SOD-123FL
SURA8220	200	2	SMA
SURS8220	200	2	SMB
NRVBS3100	100	3	SMC
NRVBS3200	200	3	SMB
NRVBS3201	200	3	SMC
SURS8320	200	3	SMC
NRVBS4201	200	4	SMC
NBRD5H100	100	5	DPAK

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Robust Standard Logic Families

Standard CMOS

Metal Gate*

- 3.0 to 18.0 V
- 3 mA Drive
- Typical Propagation Delay 35 ns
- -55 to +125°C

High Speed*

- 2.0 to 6.0 V
- 4 mA Drive
- Typical Propagation Delay 25 ns
- -55 to +125°C

FACT

- 3.0 to 5.0 V
- 24 mA Drive
- Typical Propagation Delay 10 ns
- -40 to +85°C

Low Voltage CMOS

VHC*

- 2.0 to 5.5 V
- 8 mA Drive
- Typical Propagation Delay 8 ns
- -55 to +125°C

LCX*

- 1.65 to 5.5 V
- 24 mA Drive
- Typical Propagation Delay 5 ns
- -40 to +85°C

LVX*

- 2.0 to 3.6 V
- 6 mA Drive
- Typical Propagation Delay 20 ns
- -40 to +85°C

MiniGate™*

- 0.9 to 5.5 V
- 2 to 24 mA Drive**
- Typical Propagation Delay 2 to 7 ns**
- -55 to +125°C

Standard Logic Nomenclature

	Family	Nomenclature
þ	Metal Gate	MC14xxx
Standard	High Speed	MC74HCxxx, 74HCxxx
S	FACT	MC74AC/Txxx
age	VHC	MC74VHC/Txxx
Low Voltage	LCX	MC74LCXxxx
Low	LVX	MC74LVXxxx
_	High Speed	MC74HC1Gxxx
ate"	VHC	MC74VHC/T1Gxxx
MiniGate™	LCX	NL17SZxxx, NL27WZxxx, NL37WZxxx
=	NLU	NLUnGxxx

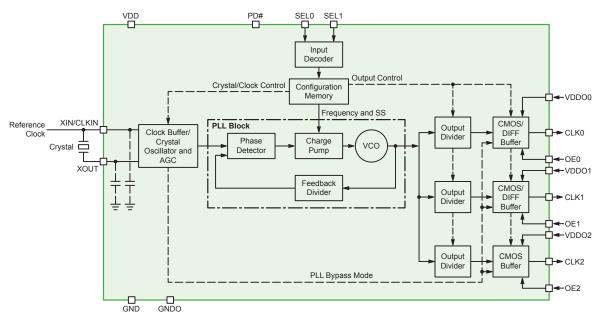


^{*} Automotive grade available. **Specifications dependent on device type.

OmniClock Programmable Clock Synthesizers

Key Features

- Single PLL
- Input Frequency Range:
 - Crystal: 3 50 MHz (low cost ESR crystal compatible)
 - Clock: 3 200 MHz (single-ended only)
- Up to 3 single-ended (LVCMOS/LVTTL) outputs, or up to 1 differential (LVPECL, LVDS, HCSL or CML) output + 1 single-ended (LVCMOS/LVTTL) output
- Output Frequency Range: 8 kHz (Min), 200 MHz (Max)
- Programmable Spread Spectrum Capabilities for EMI Suppression
 - Center Spread (0.125% steps): ± 0.125% to ± 3%
 - Down Spread (0.25% steps): -0.25% to -4%
 - Modulation Rate: 30 kHz 130 kHz
- PLL Bypass mode
- Individual Output Enable pin for each output and Power Down Capability
- Individual Output Voltage pins per output, allowing setting of output voltage (1.8 V, 2.5 V or 3.3 V; equal to or less than VDD)
- Automatic Gain Control (Crystal Power Limiting)
- Programmable internal input crystal load capacitors
- Programmable Output Drive current
- Up to 4 independent configurations using SELx pins
- Supply Voltage: 3.3 V ±10%; 2.5 V ± 10%; 1.8 V ± 0.1 V
- Temperature Range: -40°C to +85°C
- Available in QFN-16 (3 mm x 3 mm) and WDFN-8 (2 mm x 2 mm) packages



Block Diagram

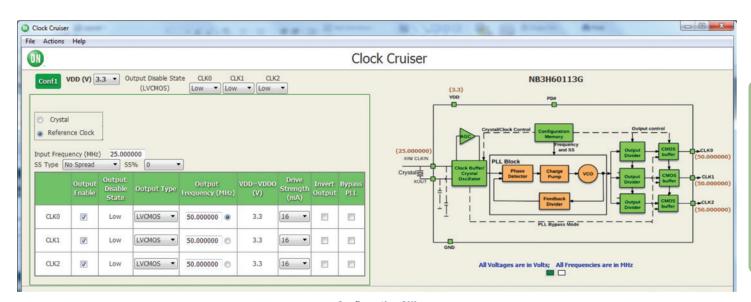
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OmniClock Programmable Clock Synthesizers

Using OmniClock in Your System

Customer orders blank OmniClock devices Customer uses free GUI and supplied evaluation board to configure the blank device to the desired parameters: frequency, drive strength, spread spectrum, etc.

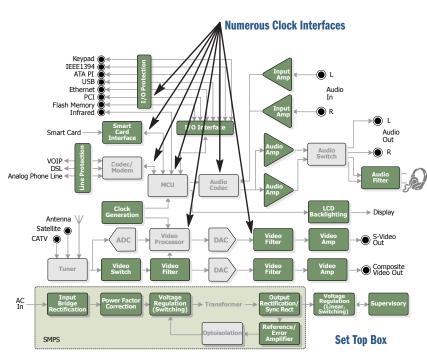
Customer provides configuration file to ON Semiconductor sales channel ON Semiconductor programs device in factory with desired customer configuration, and creates customer-specific part number



Configuration GUI

Device	Individual OE	Individual V _{ddo}	Supply Voltage (V)	Number of Configurations	Number of Outputs	Package
NB3H63143G	Yes	Yes	2.5 / 3.3	4	3	QFN-16
NB3H60113G	No	No	2.5 / 3.3	1	3	DFN-8
NB3V63143G	Yes	Yes	1.8	4	3	QFN-16
NB3V60113G	No	No	1.8	1	3	DFN-8

Clock Generation and Distribution



Programmable PLL Clocks can satisfy all clock tree requirements in a single device

- Replace all clock interfaces with one Multi-PLL Programmable Clock
- Maintain clock architecture flexibility by being able to program new clock configurations through software
- · Key devices

Clock Multiplier: NB3N3020Single PLL I2C: FS7140, FS7145

• Three PLL I2C EEPROM: FS6370, FS6377

Clock Buffers

Device	VCC (V)	Output Freq (MHz)	Outputs	Туре	Package
NB3N551	3.3, 5.0	180	4	Fanout Buffer	SOIC-8, DFN-8
NB3L553	2.5, 3.3, 5.0	200	4	Fanout Buffer	SOIC-8, DFN-8
NB3N2304NZ	3.3	140	4	Low Skew Fanout Buffer	TSSOP-8, DFN-8
PCS2I2309NZ	3.3	133	9	Clock Fanout Buffer	SOIC-16
NB2305A	3.3	15-133	5	Zero Delay Buffer	TSSOP-8, SOIC-8
NB2309A	3.3	15-133	9	Zero Delay Buffer	TSSOP-16, SOIC-16
NB2304A	3.3	15-133	4	Zero Delay Buffer	SOIC-8
NB3N200S	3.3	100	1	M-LVDS Driver/ Receiver	SOIC-8
NB3N201S	3.3	100	1	M-LVDS Driver/ Receiver	SOIC-8
NB3N206S	3.3	100	1	M-LVDS Driver/ Receiver	SOIC-8

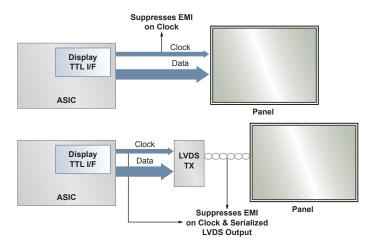
3.3 V Clock Generators with Fixed Frequency Outputs

Device	Output Frequency (MHz)	Application	Package
NB3N3002	25, 125, 200	PCI-e, Gigabit Ethernet	TSSOP-16
NB3N511	14-200 with selectable multiplier ratios	USB, PCI, PCI-e, SDRAM, Ethernet, Gigabit Ethernet, CPU	SOIC-8
NB3N502	14-120	CPU, USB, PCI, Network, Ethernet	SOIC-8
NB3N5573	25, 100, 125, 200	PCI-e, DIMM, CPU	TSSOP-16

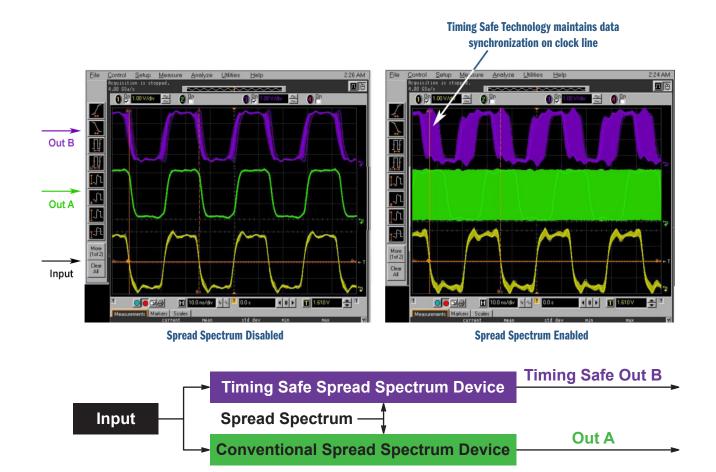
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Active EMI Solutions for Display Interfaces

The display interface in infotainment applications is usually routed using flex-PCB cables, which may cause EMI problems. Timing-Safe™ technology from ON Semiconductor allows active EMI reduction in interfaces where the data and clock are synchronized, and still maintain the synchronization of data and clock after SSC is applied to the clock. The active EMI portfolio supports different frequency ranges, supply voltages, spread settings, output drives, and packages.



Device	VCC (V)	Frequency Range (MHz)	Temperature Range (°C)	Features	Package(s)
P3PS850BH	2.3 - 3.6	18 - 72	-20 to +85	Power down pin; analog SS % control; in-out delay control	WDFN-8

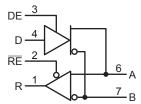


Multipoint M-LVDS Drivers/Receivers

Low voltage (3.3 V) differential 30-55 ohm line drivers and receivers, for signaling rates up to 200 Mbps.

Features

- Threshold to Detect Open-Circuit and Idle-Bus conditions
- Controlled driver output voltage transition times for improved signal quality
- \bullet -1 V to 3.4 V common-mode voltage range allows data transfer up to 2 V of ground noise
- Supports Simplex and Half Duplex bus configuration
- Temperature range -40°C to 125°C



		D 0 %		Device-to-Device Skew Max		
Device	Receiver	Bus Configurations	(ps)	(ps)	(ps)	Package
NBA3N200S	Type 1	Simplex	150	0.9	150	SOIC-8
NBA3N201S	Type 1	Simplex	150	1	100	SOIC-8
NBA3N206S	Type 2	Simplex; Half-Duplex	130	1	100	SOIC-8

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